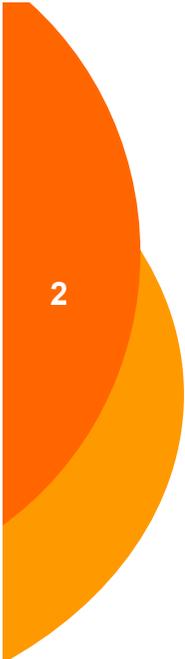


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# RIVELATORI A CONTEGGIO DI SINGOLO FOTONE E LORO APPLICAZIONI

Valeria Rosso

Universita' di Pisa, Dipartimento di Fisica "E. Fermi", INFN Sezione di Pisa



## RIVELATORI A CONTEGGIO DI SINGOLO FOTONE E LORO APPLICAZIONI

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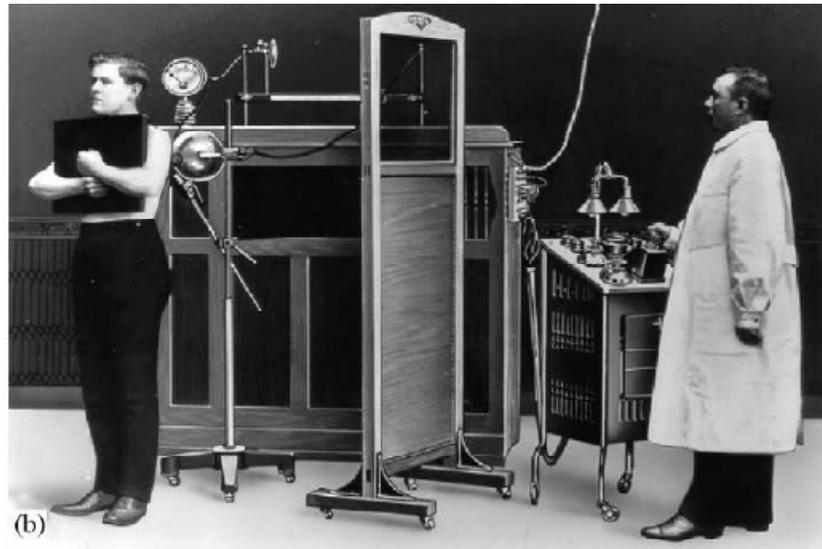
- Introduzione alla Radiografia Digitale
- Un sistema di rivelazione a conteggio di singolo fotone
  - Mammografia Digitale
  - Altre applicazioni
- Il progetto MATISSE

## The beginning

3

- 1895 Prof. Wilhelm Conrad Roentgen discovers X-rays
- Phosphor screens introduced early 20th century
- In the '70 years routine use of fluoroscopy with image intensifiers coupled to TV cameras
- In the '80 years 'the radiography becomes digital (imaging plates, CCDs, flat-panels, semiconductor detectors both amorphous and crystalline)

M. Hoheisel, NIM A563 (2006) 215–224



3

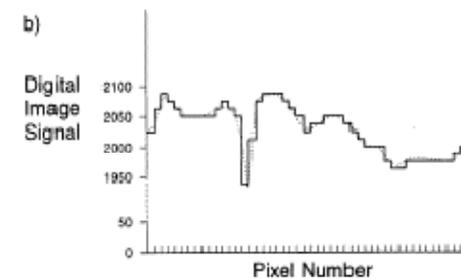
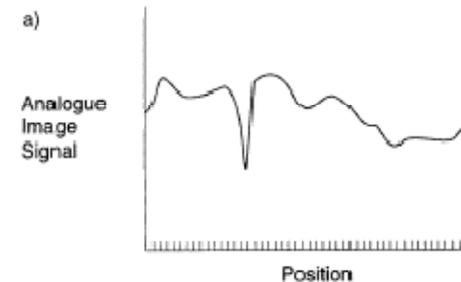
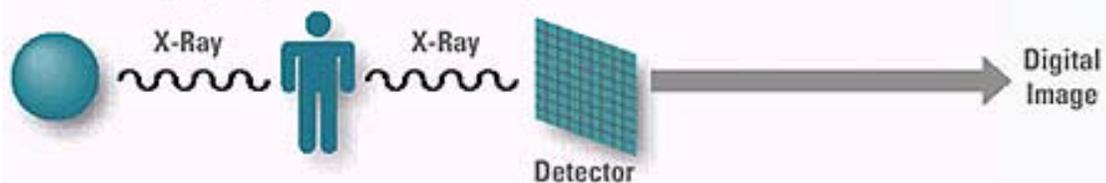
# Digital Radiographic Imaging

- Film-screen systems:
  - detection and display on the same medium
- Digital radiography features:
  - transmitted intensity pattern sampling
  - spatial sampling

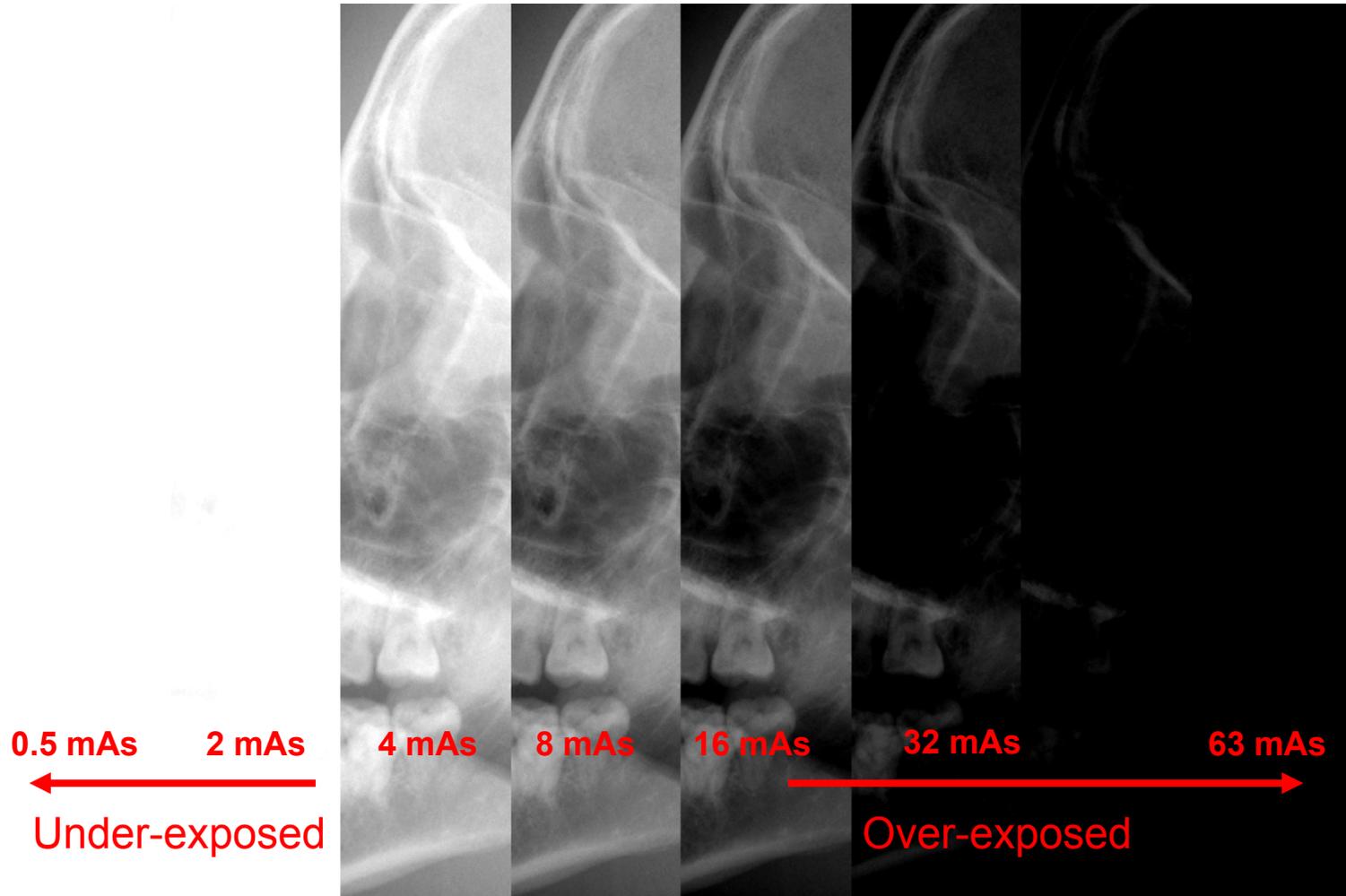
## Mammography – Today



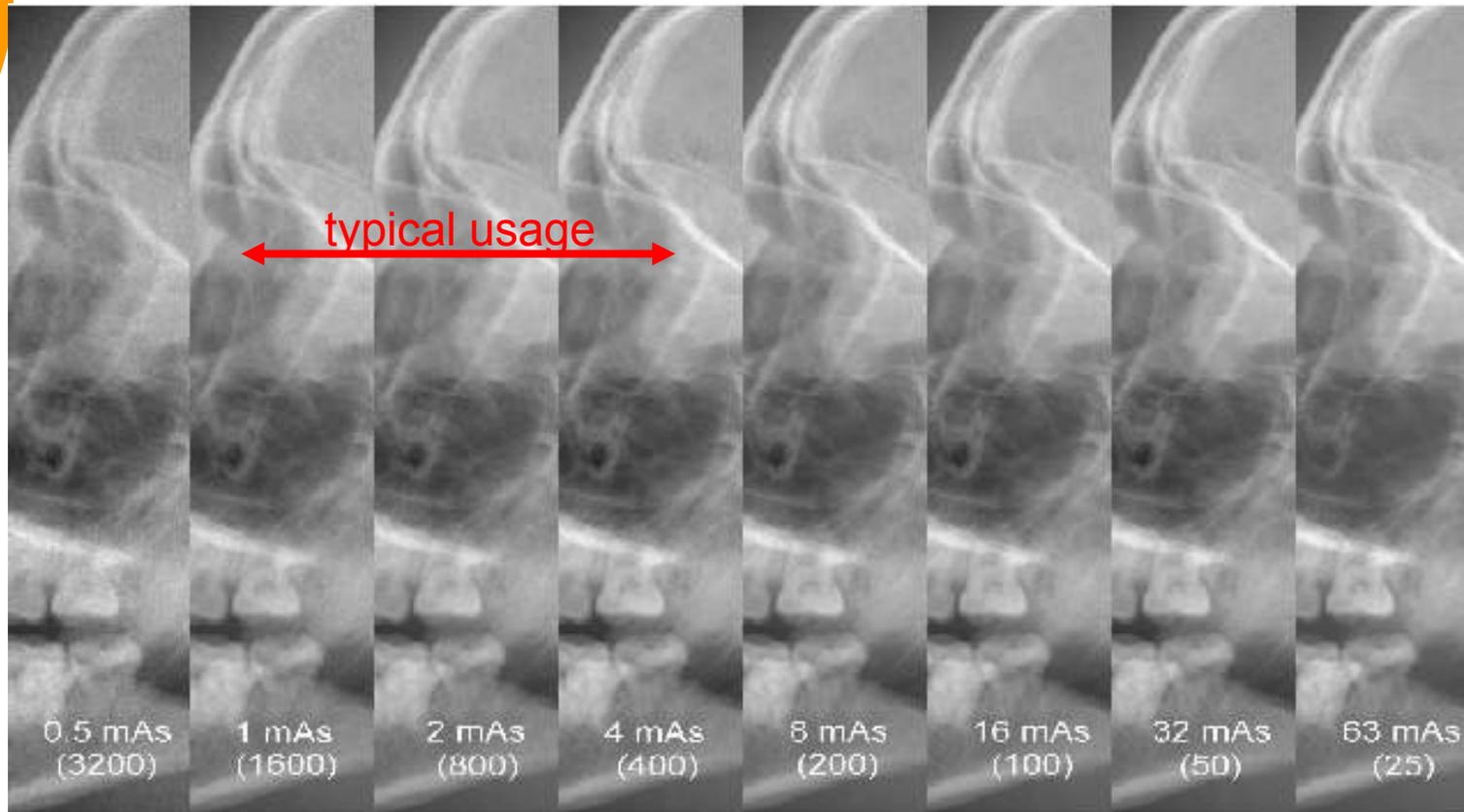
## Mammography – Full Field Digital Detector

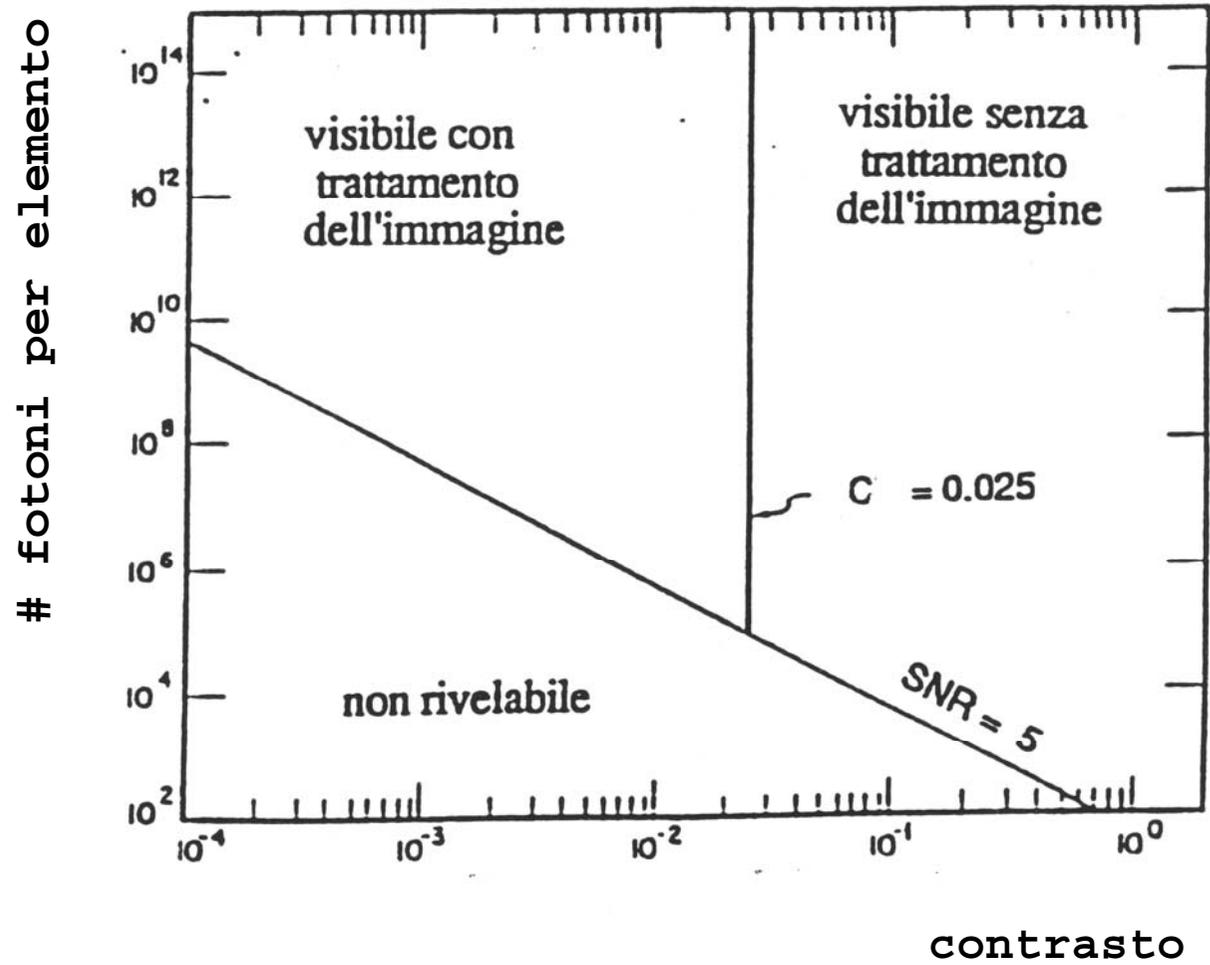


# X-ray film: dynamic range

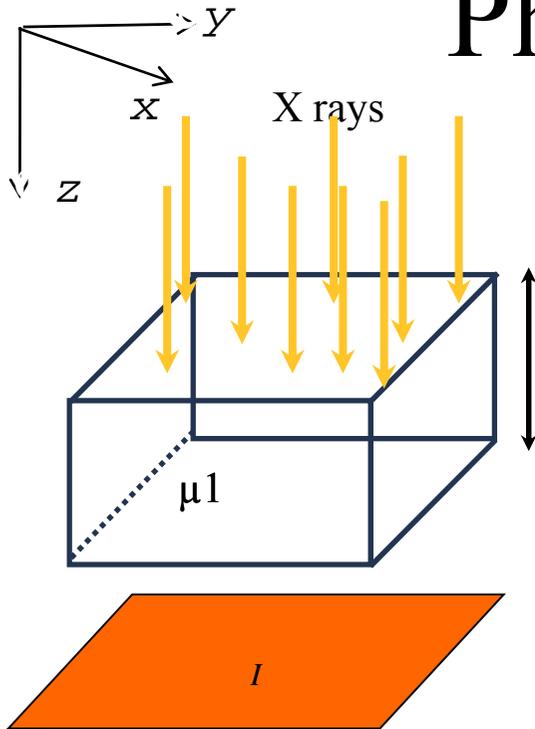


# Flat panel detector: dynamic range





# Physical Parameters



$N$  incident photons per unit area

$I(x, y)$  dxdy energy absorbed in dxdy of detector

$I(x, y) = \text{primary} + \text{secondary}$

$$I(x, y) = N\varepsilon(E, 0)Ee^{-\int \mu(x, y, z) dz} + \int \varepsilon(E_s, \theta)E_s S(x, y, E_s, \Omega) d\Omega dE_s$$

$S$  is slowly varying function: the integral can be substituted with the value at the centre of the image

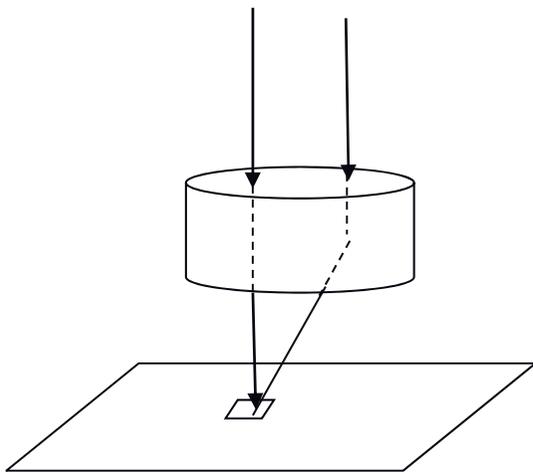
$$\bar{S} = \int S(0, 0, E_s, \Omega) d\Omega dE_s$$

$$\bar{\varepsilon}(E)E = \int \varepsilon(E_s, \theta)E_s S(0, 0, E_s, \Omega) d\Omega dE_s / \bar{S}$$

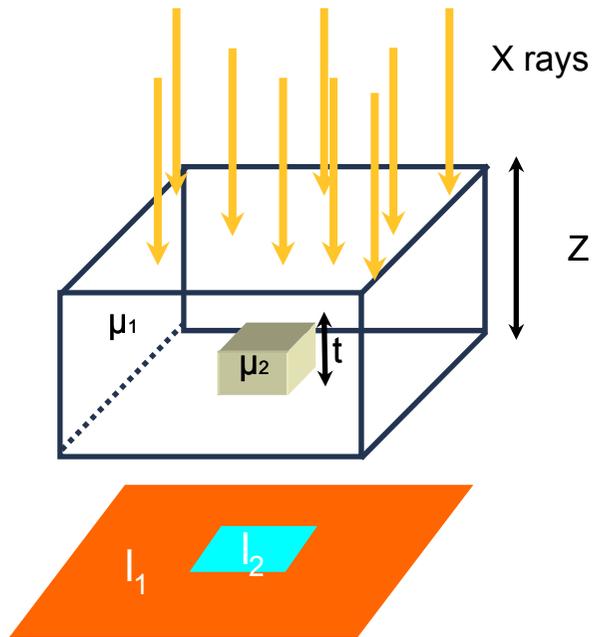
$$I(x, y) = N\varepsilon(E, 0)Ee^{-\int \mu(x, y, z) dz} + \bar{S}\bar{\varepsilon}(E)E$$

$R = \text{scattered/primary}$

$$I(x, y) = N\varepsilon(E, 0)Ee^{-\int \mu(x, y, z) dz} (1 + R)$$



# Physical Parameters



$$I_1 = N\varepsilon(E,0)Ee^{-\mu_1 z} + \overline{S\varepsilon(E)}E$$

$$I_2 = N\varepsilon(E,0)Ee^{-\mu_1(z-t)-\mu_2 t} + \overline{S\varepsilon(E)}E$$

## CONTRAST

$$C = \frac{I_1 - I_2}{I_1} \qquad C = \frac{1 - e^{-(\mu_2 - \mu_1)t}}{1 + R}$$

## SIGNAL

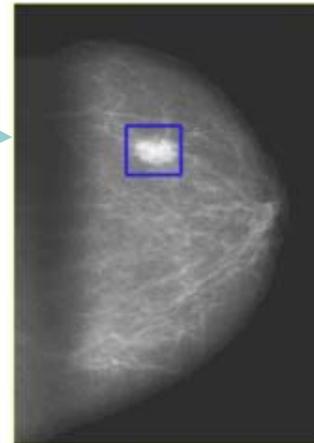
$$\text{signal} = (I_1 - I_2)A = ICA = CAN\varepsilon Ee^{-\mu_1 z} (1 + R)$$

# Digital Mammography

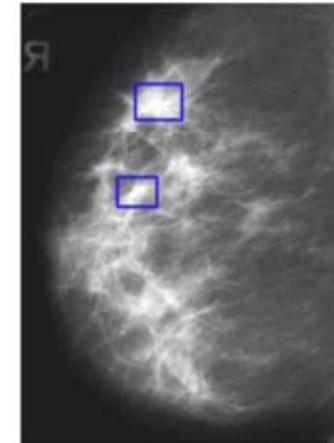
Principal Mammography task:

✓ Detection of the tumor masses  
(objects with contrast  $< 1\%$  and  
diameter  $\approx 1-5$  mm)

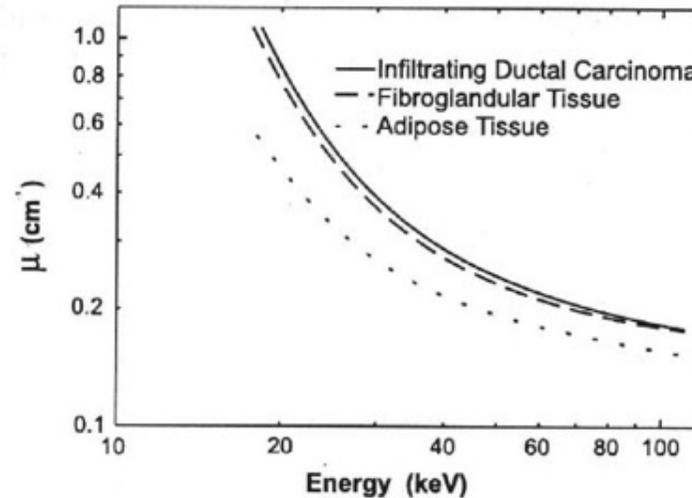
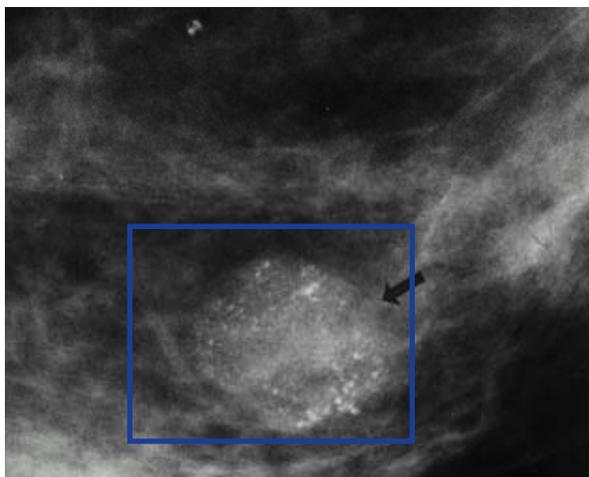
✓ Detection of the  
microcalcifications  
(objects with high contrast and  
small dimensions  $\approx 100 \mu\text{m}$ )

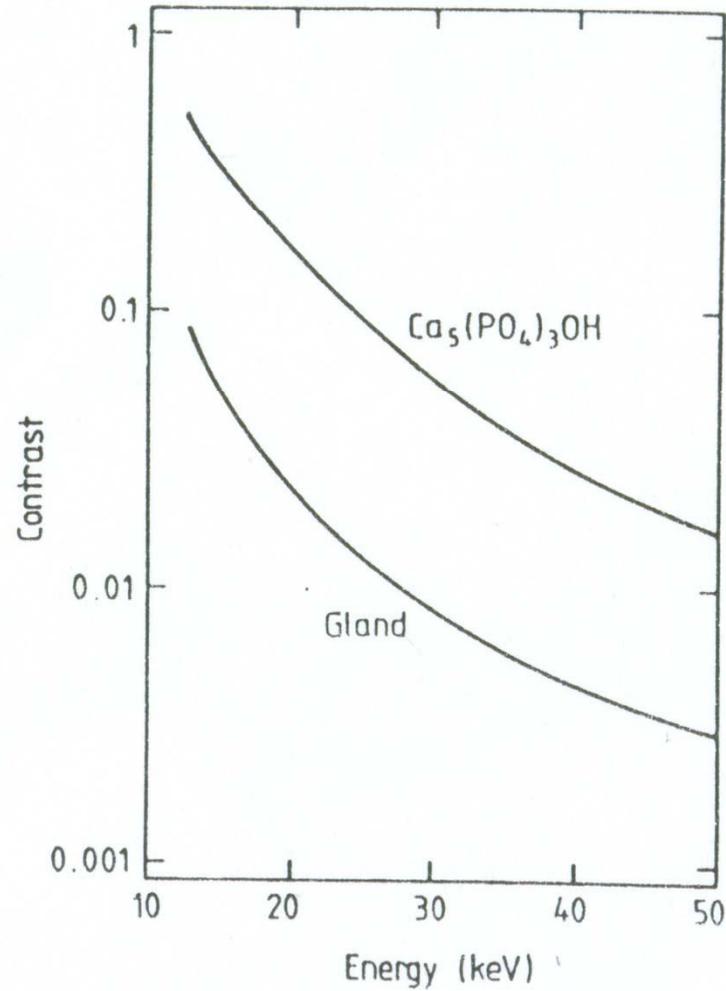
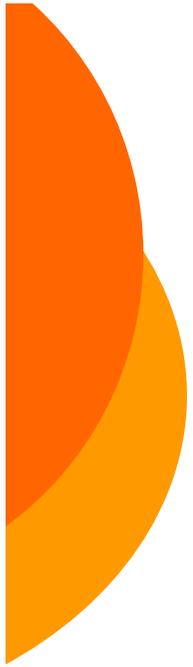


a) Breast carcinoma surrounded by adipose tissue

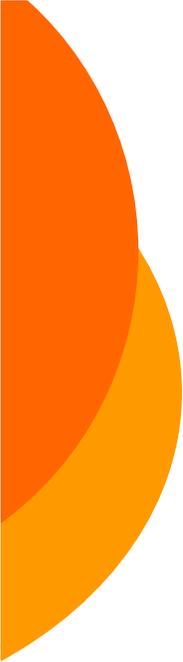


b) Breast carcinoma surrounded by fibroglandular tissue





*Dettagli immersi in tessuto mammario sano  
100um di calcio  
1mm tessuto ghiandolare*



# Requisiti per un sistema per la MD

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Dobbiamo rivelare dettagli a basso contrasto

$C \sim$  alcuni %

flusso:  $10^5$ - $10^6$   $\gamma/(\text{s mm}^{-2})$

Scelta del rivelatore:

geometria di lettura

materiale

Scelta dell'elettronica di read-out

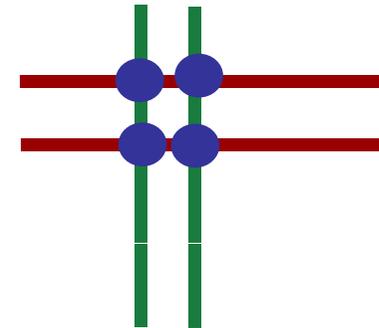
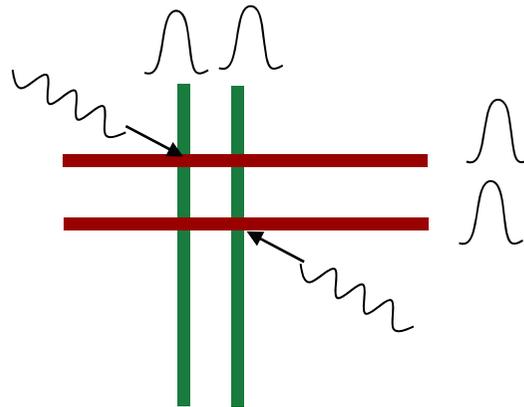
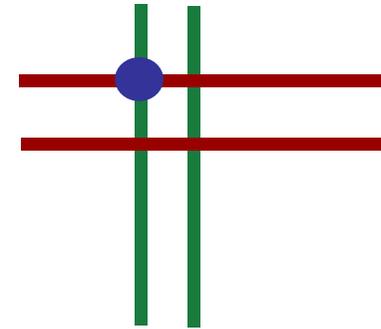
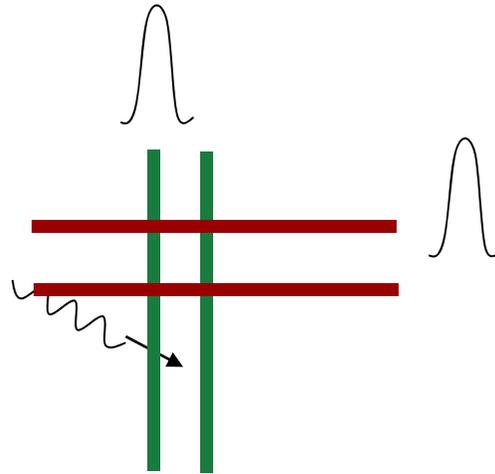
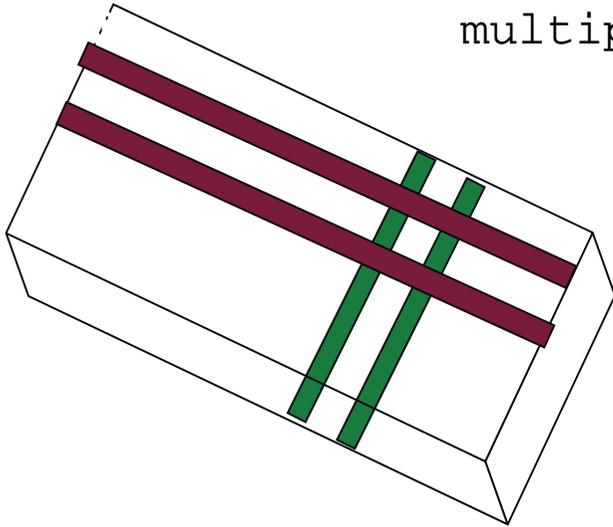
Realizzare il sistema di rivelazione

Test del sistema di rivelazione

# STRIP DETECTORS

n+n electronic channels

multiple hits problem



La probabilita' di avere  $r$  eventi in un intervallo  $T$  se gli eventi sono indipendenti e hanno un rate costante  $\nu$  con  $\tau=1/\nu$ , e' calcolabile facendo uso della distribuzione di Poisson

$$P(r) = \frac{\mu^r e^{-\mu}}{r!} \quad \mu = \frac{T}{\tau}$$

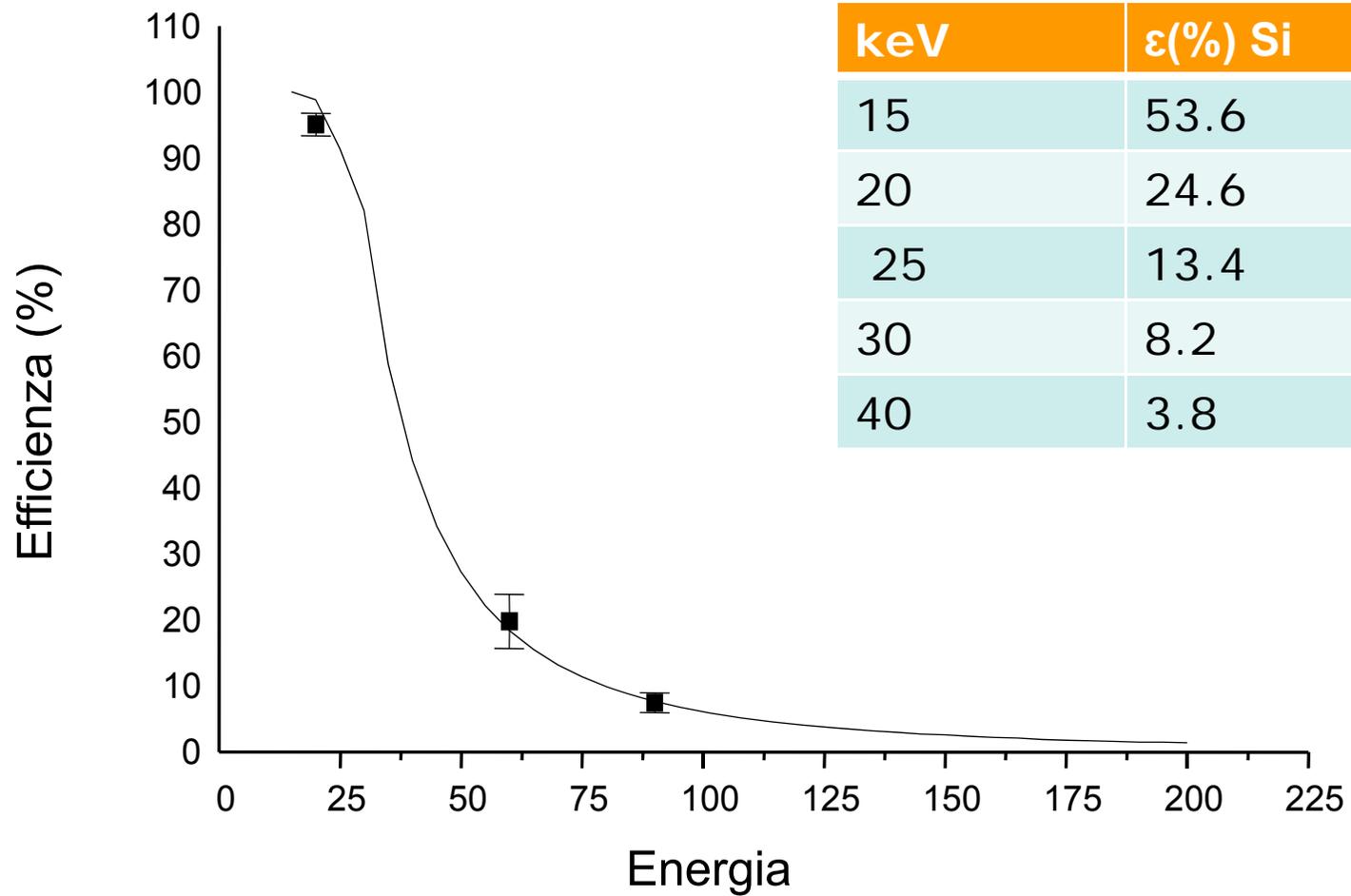
Considerando:

una superficie di  $1.4 \times 1.4 \text{ cm}^2$ , un tempo di campionamento  $T=25\text{ns}$  e un flusso di  $5 \cdot 10^4 \text{ } \gamma / (\text{s mm}^2)$

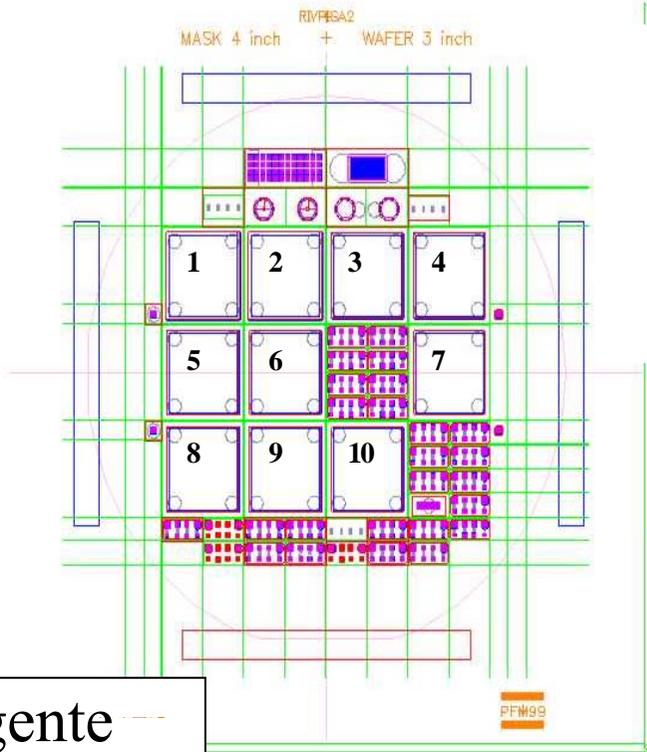
$$P(0)=78\% \quad P(1)=19\% \quad P(2)=2,4\%$$

E' necessaria una geometria di elettrodi di lettura a pixels  
Numero di canali di lettura  $n^2$  contro i  $2n$  di un rivelatore doppia faccia

# Efficienze: GaAs 200 $\mu$ m Si 300 $\mu$ m

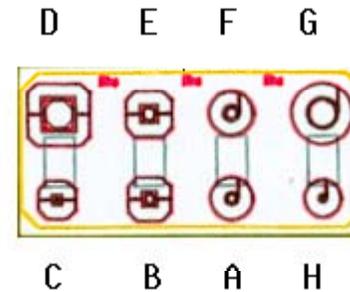


# GaAs : layout del wafer pisa2 e mappa delle matrici 64x64

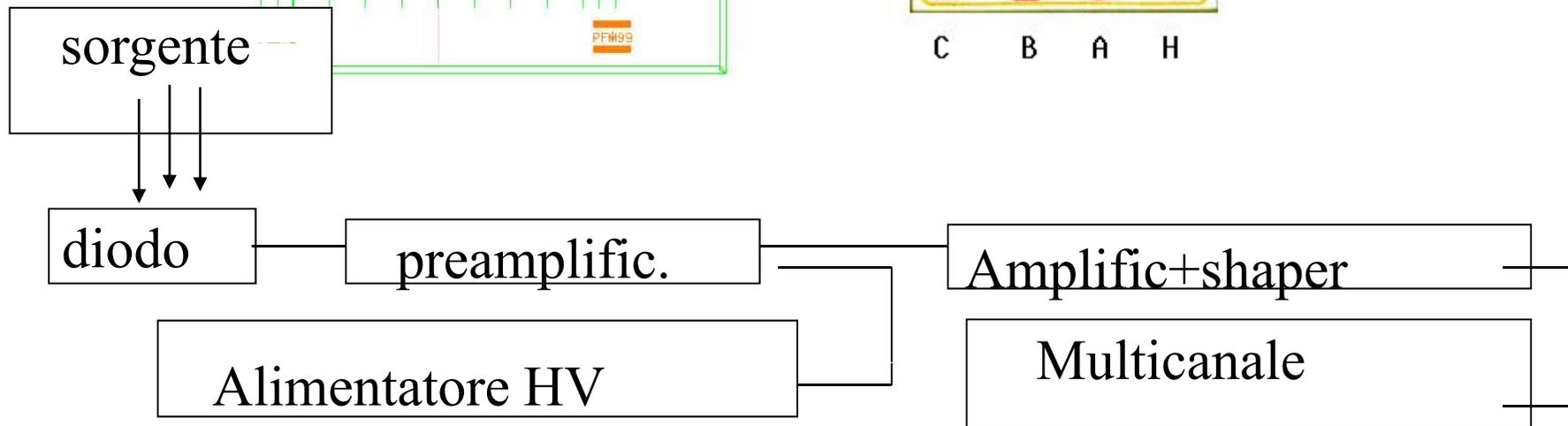


Commercial LEC grown GaAs  
Carbon density: studied

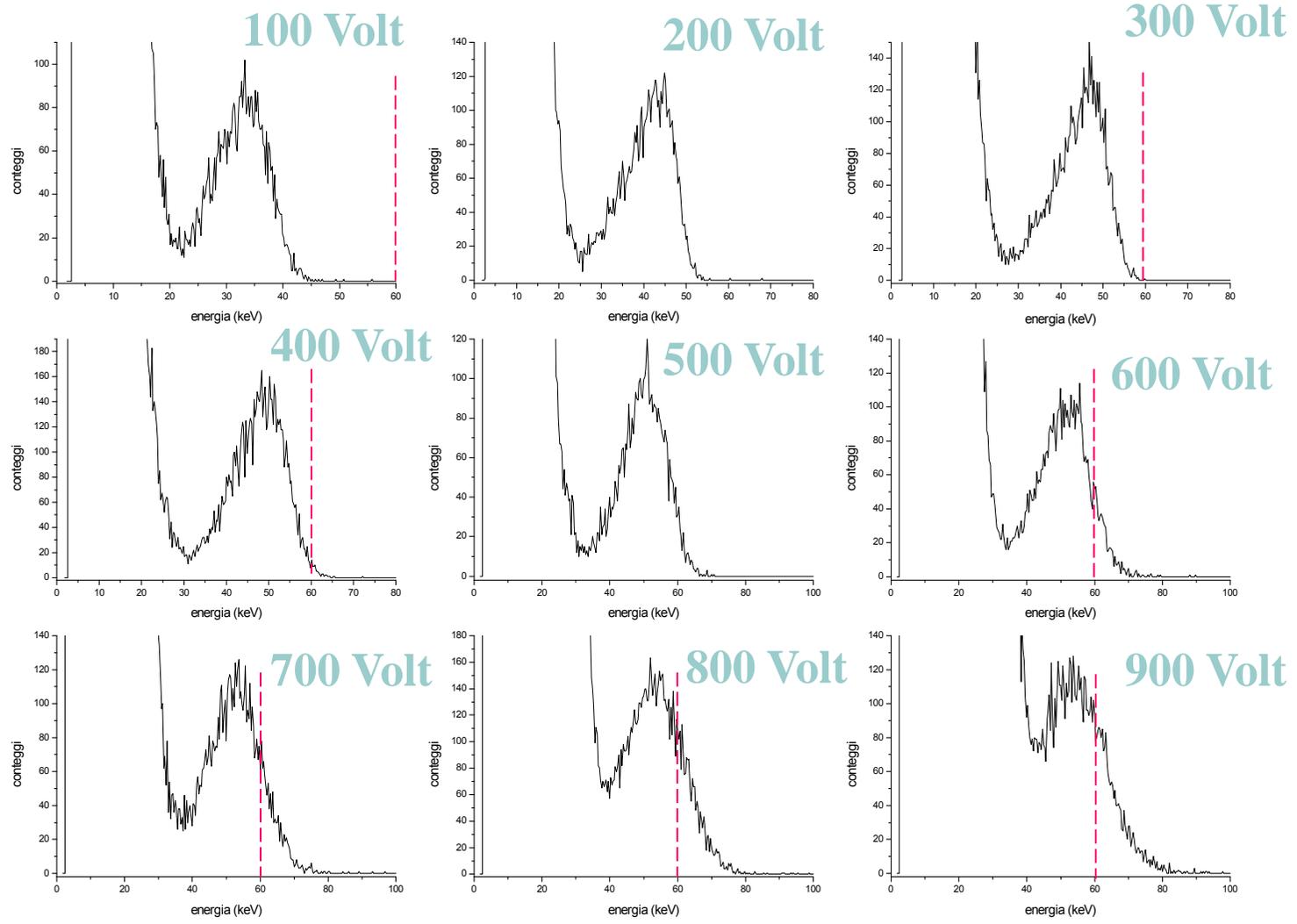
Double Schottky barrier developed  
by AMS



Struttura test



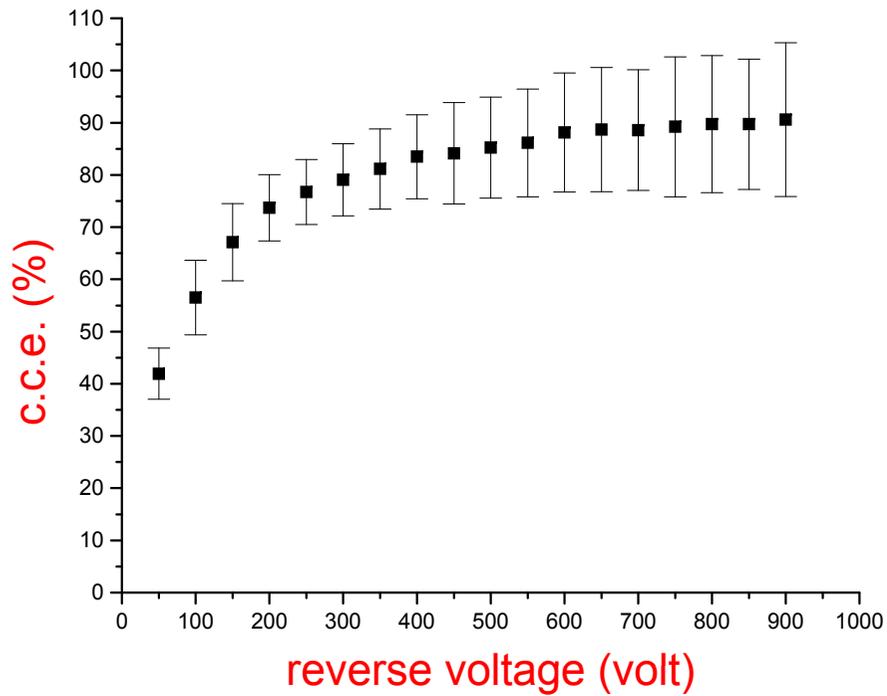
# Pad di diametro 2 mm e spessore 200 um ( $ACR\ 68\ [C] = 1.3 \cdot 10^{15}\ cm^{-3}$ ) sorgente $^{241}Am$ studio CCE



20      60      keV

**ACR 68**  $[C] = 1.3 \cdot 10^{15} \text{ cm}^{-3}$

sorgente  $^{241}\text{Am}$

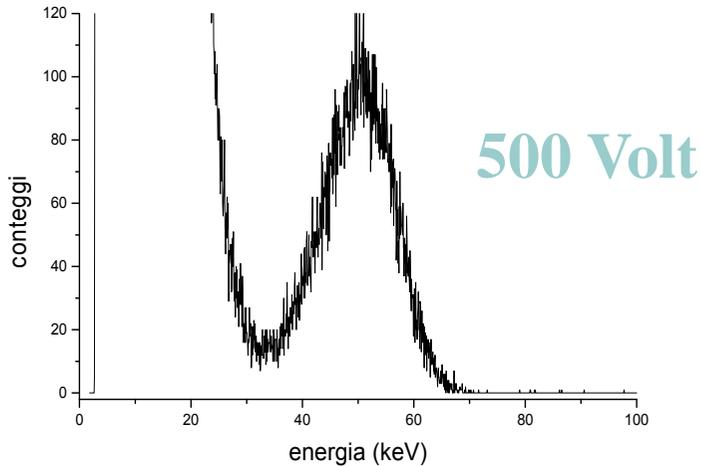


$V_{\text{bias}}$	c.c.e.(%)
100	$56.5 \pm 7.2$
200	$73.7 \pm 6.3$
300	$79.1 \pm 6.9$
400	$83.5 \pm 8.0$
500	$85.2 \pm 9.7$
600	$88.1 \pm 11.4$
700	$88.6 \pm 11.6$
800	$89.7 \pm 13.1$
900	$90.6 \pm 14.7$

# Spectroscopic Characterization

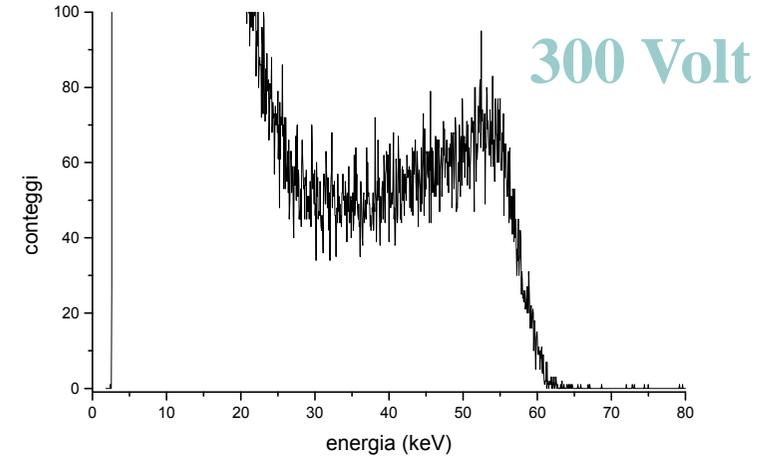
**ACR 068**

$$[C] = 1.3 \cdot 10^{15} \text{ cm}^{-3}$$



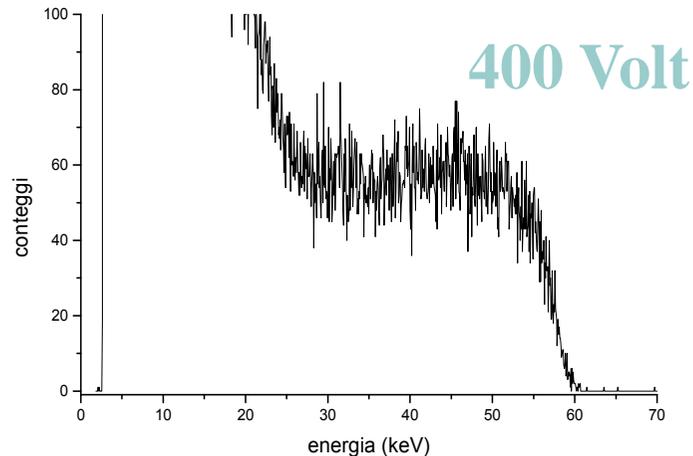
**ACR 013**

$$[C] = 5 \cdot 10^{15} \text{ cm}^{-3}$$



**ACR 079**

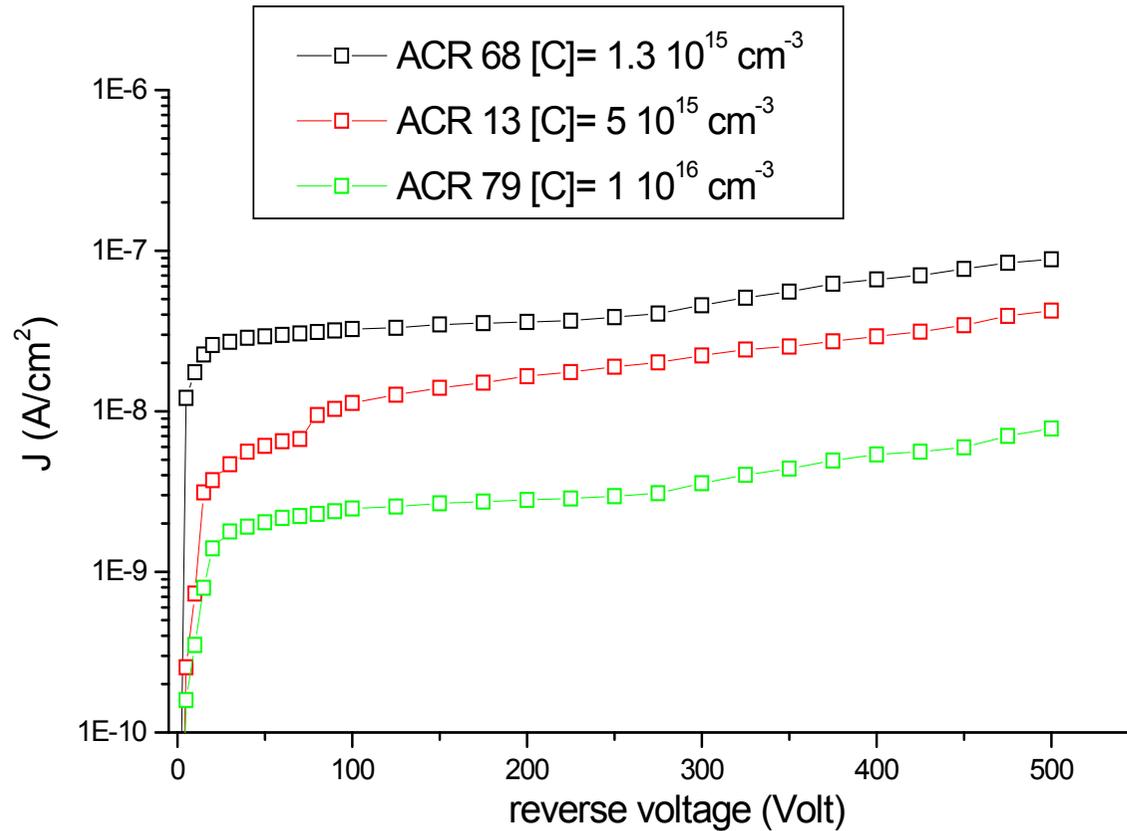
$$[C] = 1 \cdot 10^{16} \text{ cm}^{-3}$$



Irradiation with  $^{231}\text{Am}$  Source (59,54 KeV)

Comparison of spectra acquired using diodes with the different Carbon concentrations

# Electrical Characterization



Current density decreases when Carbon concentration become higher.

# GaAs pixel detectors

It's important to define the optimal reverse voltage for the detector because :

Operating bias ( $V_{\text{bias}}$ ) influences image quality

Increasing  $V_{\text{bias}}$  increase leakage current and noise  
breakdown limit

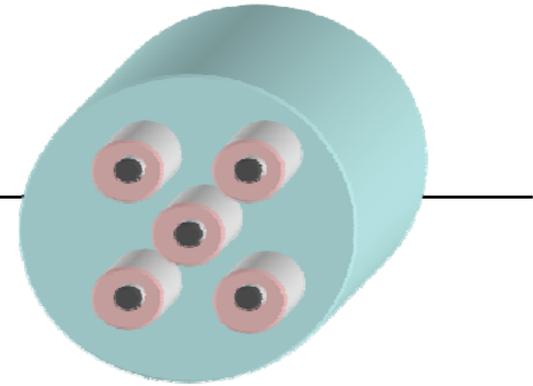
in order to have response uniformity the detector must be overdepleted

## Characteristics:

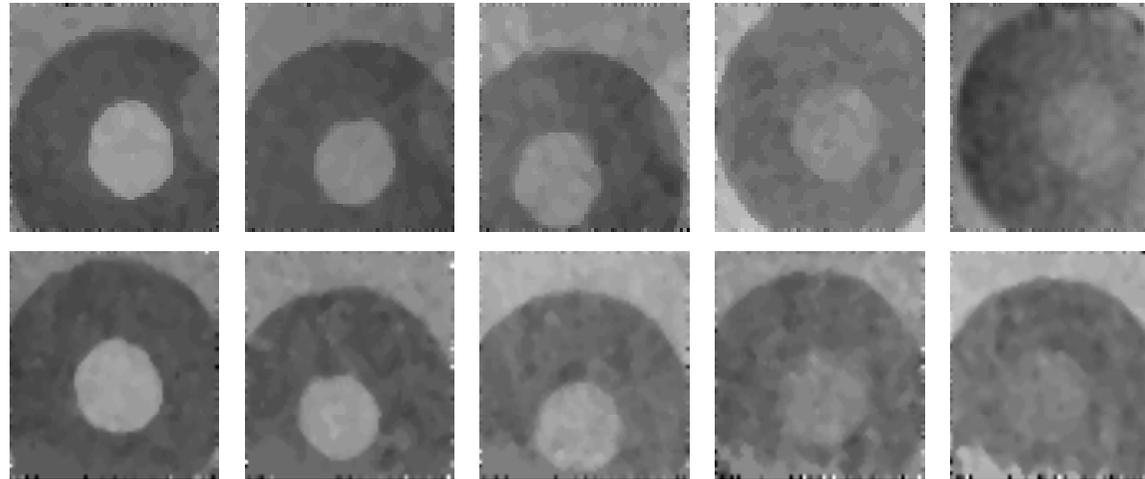
- ❖ Carbon density of  $1.0-1.3 \times 10^{15} \text{cm}^{-3}$
- ❖ Breakdown voltage  $> 500$  Volt
- ❖ Current Density  $< 50 \text{ nA/mm}^2$  (@ 300 Volt)
- ❖ Charge Collection Efficiency  $> 75 \%$  (@ 300 Volt)

We have observed that it's important to have a well defined concentration of Carbon in the bulk of GaAs so we have studied the behaviour of single diodes

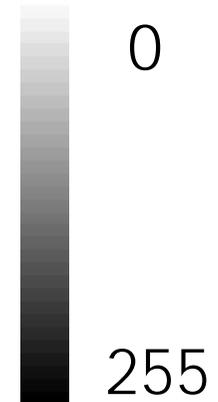
# Confronto Immagini



Si  
300 μm

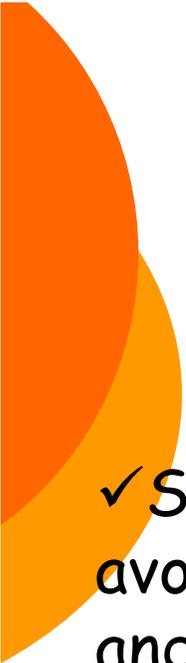


GaAs  
200 μm



10.9 mm

Esposizione = 32 mAs  
Tempo esposizione ~ 1 s  
Dose = 6 mGy

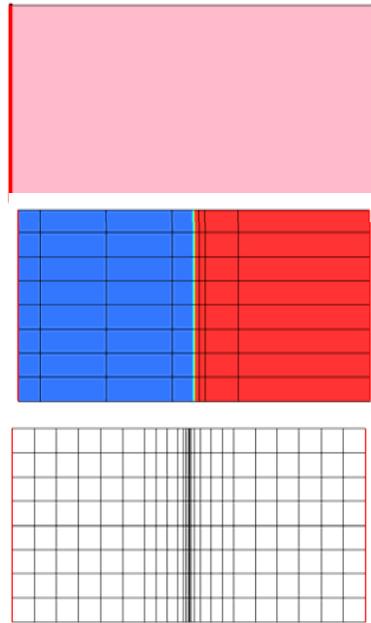
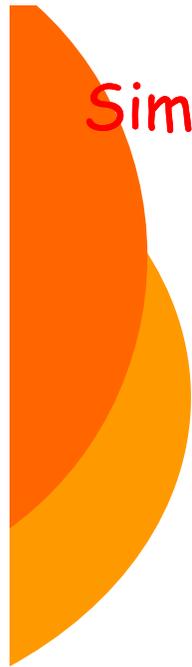


# Silicon detectors

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- ✓ Simulation of Silicon detectors to choose a structure to avoid the risk of electrical discharge between detector and electronic chip
- ✓ Wafer production and electric tests

# Simulation of Silicon detectors: ISE-TCAD



Creation of a geometry



Creation of dopant distribution



Creation of elementary domain



Iterative Calculus

## Physical Equation

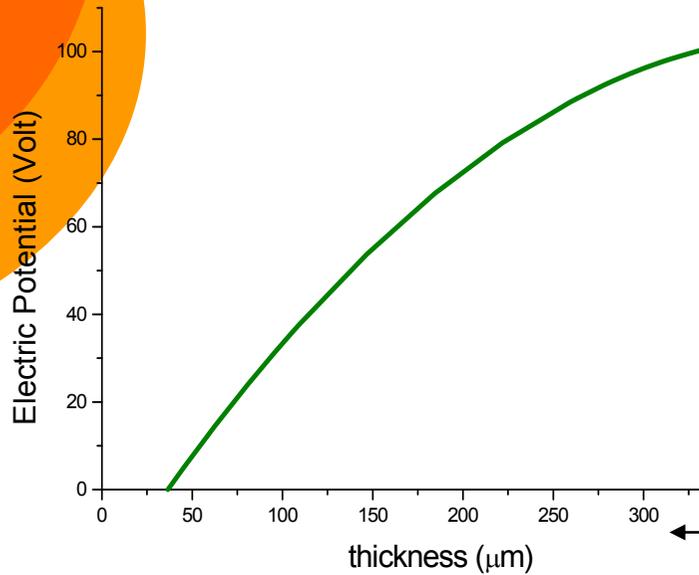
$$\nabla \epsilon \nabla \psi = -q(p - n + N_D - N_A) \text{ Poisson Equation}$$

$$\nabla J_{n/p} = \pm qR \pm q \frac{\partial(n/p)}{\partial t} \text{ Continuity Equation}$$

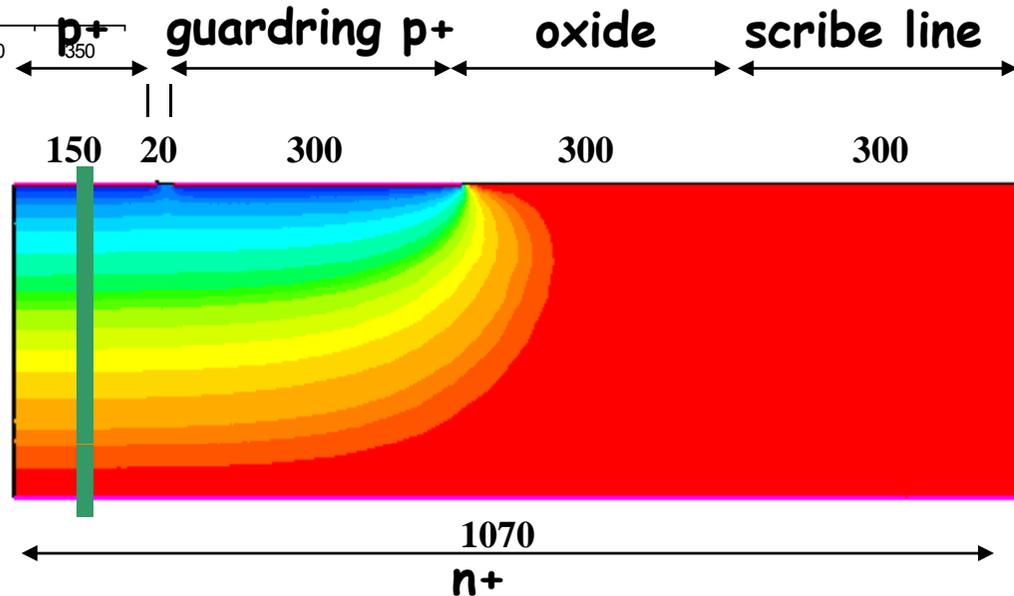
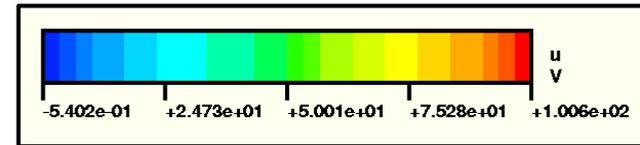
$$J_n = -nq\mu_n \nabla \Phi_n, J_p = -pq\mu_p \nabla \Phi_p$$

- $\psi$  electrostatic potential
- $\epsilon$  electric permittivity
- $q$  elementary charge
- $n, p$  electron and hole densities
- $N_D, N_A$  donors and acceptors
- $J_n, J_p$  current densities
- $R$  recombination rate
- $\mu$  mobility
- $\Phi$  quasi-Fermi potential<sup>24</sup>

# Electric Potential at the cutting edge



p+ contact	$N_B \sim 2 \cdot 10^{19} \text{ cm}^{-3}$
n+ contact	$N_p \sim 1 \cdot 10^{20} \text{ cm}^{-3}$
Bulk	$N_p \sim 5 \cdot 10^{11} \text{ cm}^{-3}$
Scribe Line	$N_p \sim 1 \cdot 10^{17} \text{ cm}^{-3}$
Oxide	free charge $\sim 4 \cdot 10^{11} \text{ e}^-$



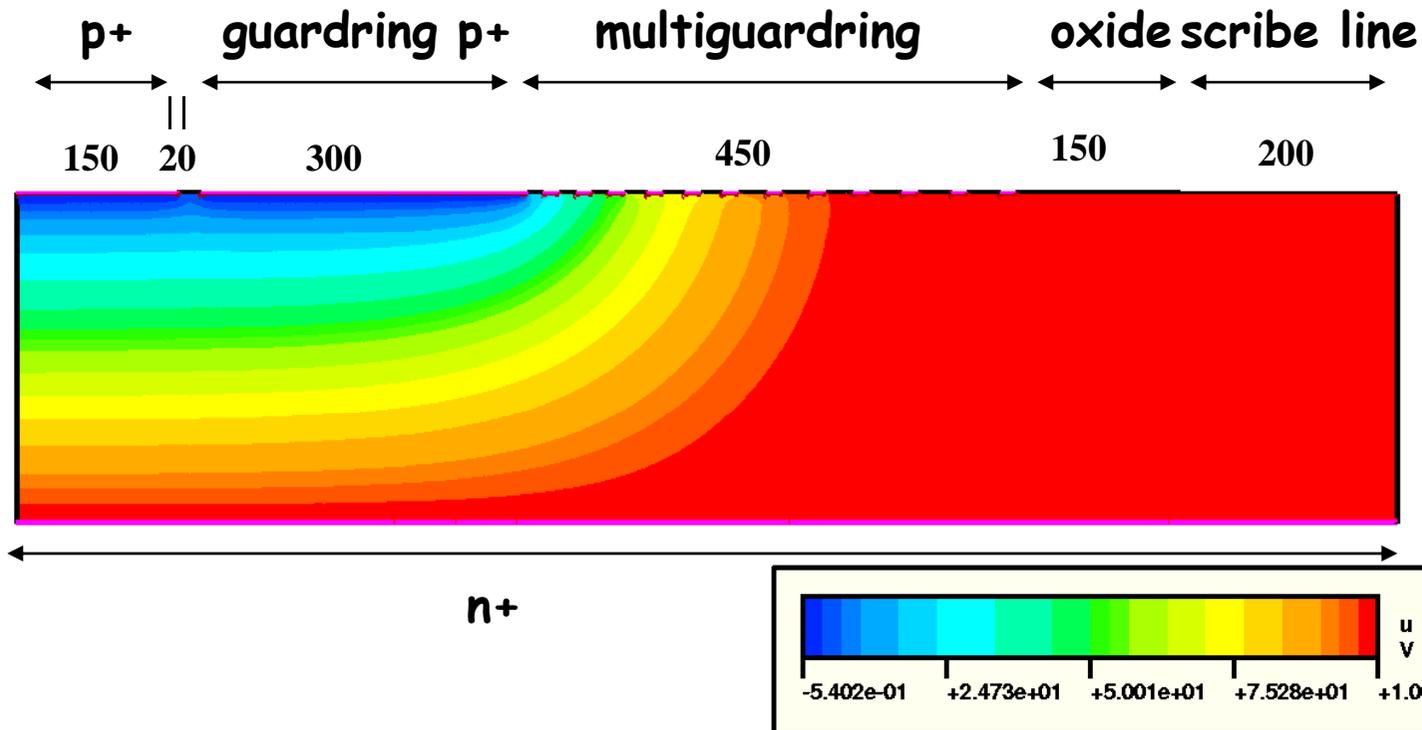
p+ Contact at ground  
 Guardring at ground  
 n+ Contact at 100 Volt

# New structure: Electric Potential

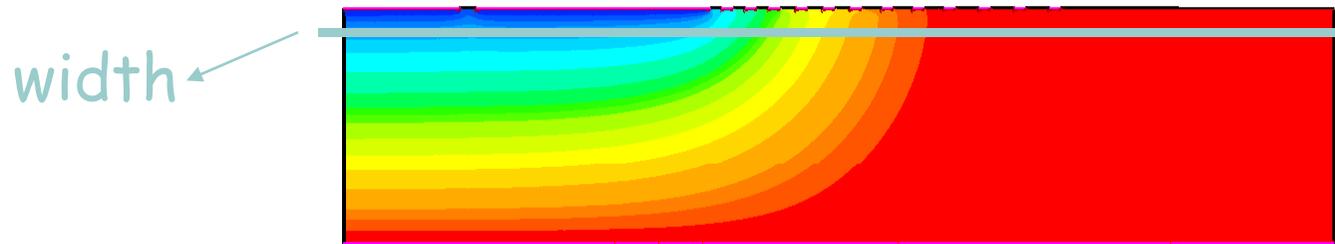
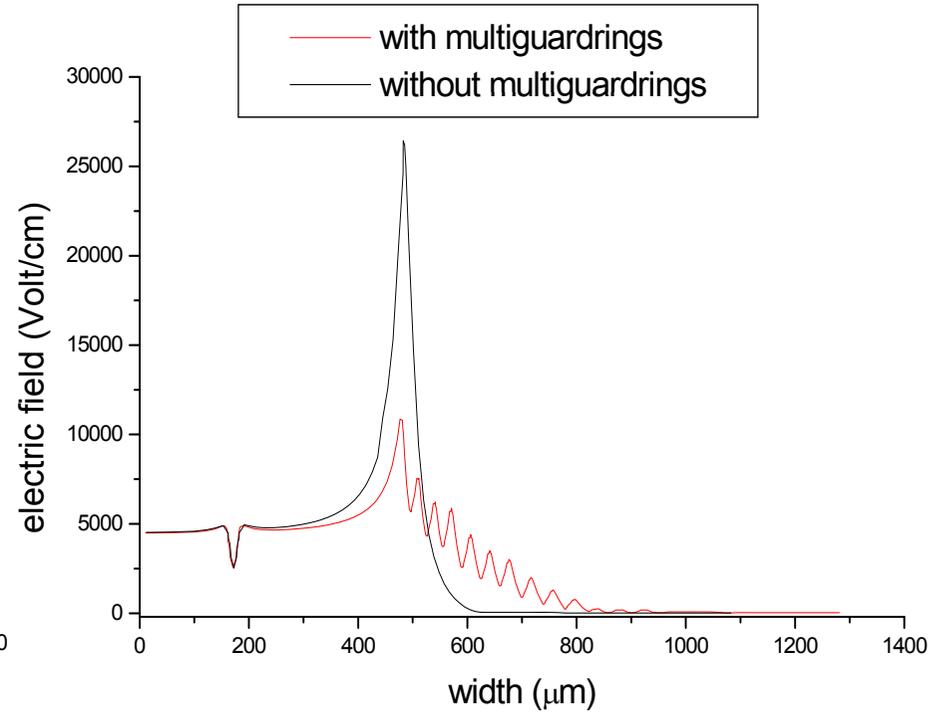
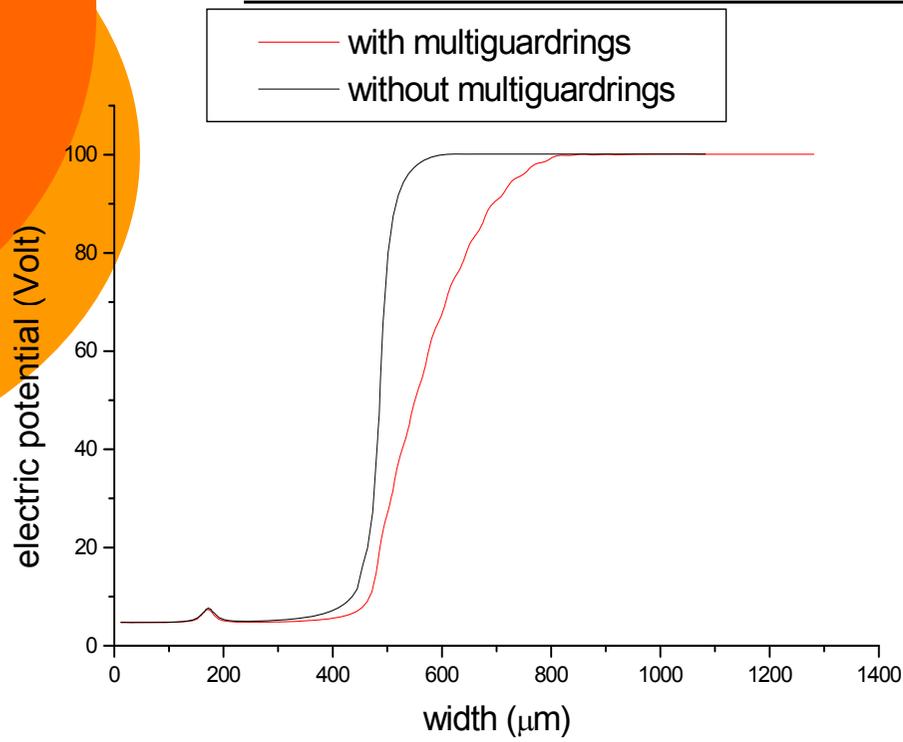
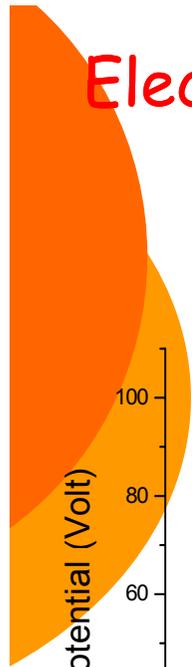
## Multiguardring (450 $\mu\text{m}$ )

- 3 x (oxide 15  $\mu\text{m}$  + p<sup>+</sup> 15  $\mu\text{m}$ )
- 3 x (oxide 20  $\mu\text{m}$  + p<sup>+</sup> 15  $\mu\text{m}$ )
- 3 x (oxide 25  $\mu\text{m}$  + p<sup>+</sup> 15  $\mu\text{m}$ )
- 3 x (oxide 30  $\mu\text{m}$  + p<sup>+</sup> 15  $\mu\text{m}$ )

p+ contact	$N_B \sim 2 \cdot 10^{19} \text{ cm}^{-3}$
n+ contact	$N_p \sim 1 \cdot 10^{20} \text{ cm}^{-3}$
Bulk	$N_p \sim 5 \cdot 10^{11} \text{ cm}^{-3}$
p-stop	$N_B \sim 5 \cdot 10^{17} \text{ cm}^{-3}$
scribe Line	$N_p \sim 1 \cdot 10^{17} \text{ cm}^{-3}$
Oxide	free charge $\sim 4 \cdot 10^{11} \text{ e}^-$



# Electric Field and Potential

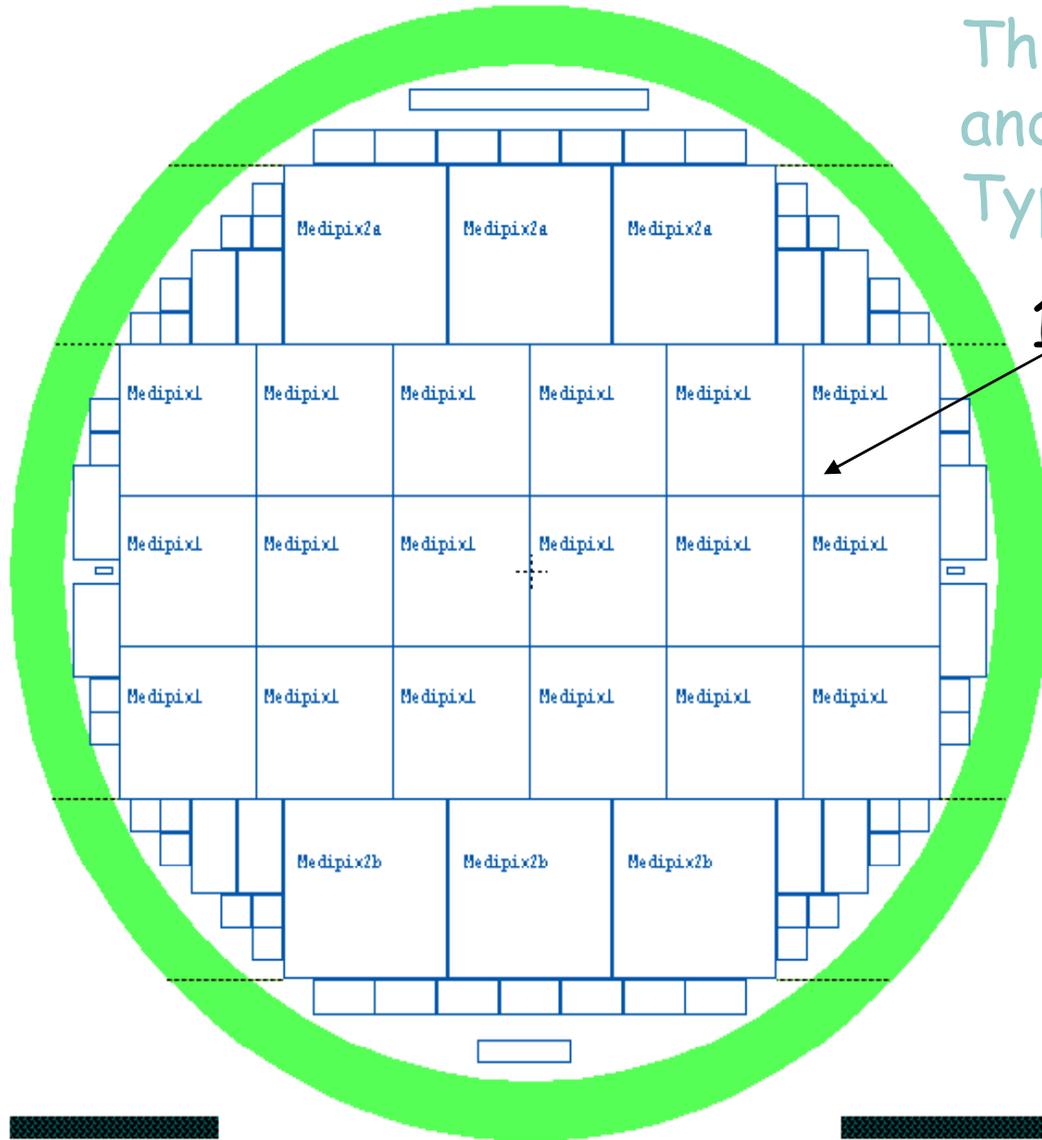


# Wafer layout at ITC-IRST

12 wafers 4 inches in diameter

Thickness 300  $\mu\text{m}$ , 525  $\mu\text{m}$  and 800  $\mu\text{m}$

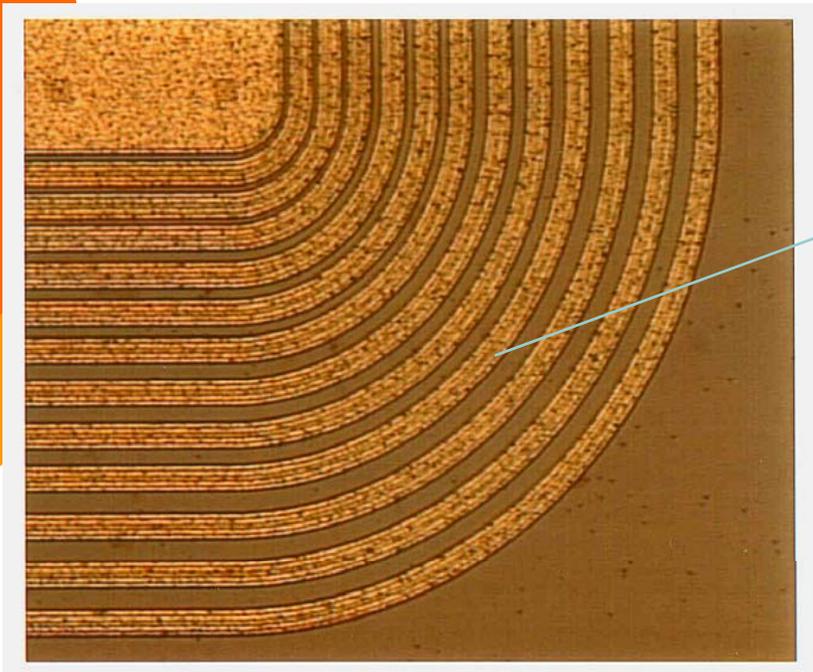
Type of production : p+/n



18 detectors for Medipix 1

Several test structures

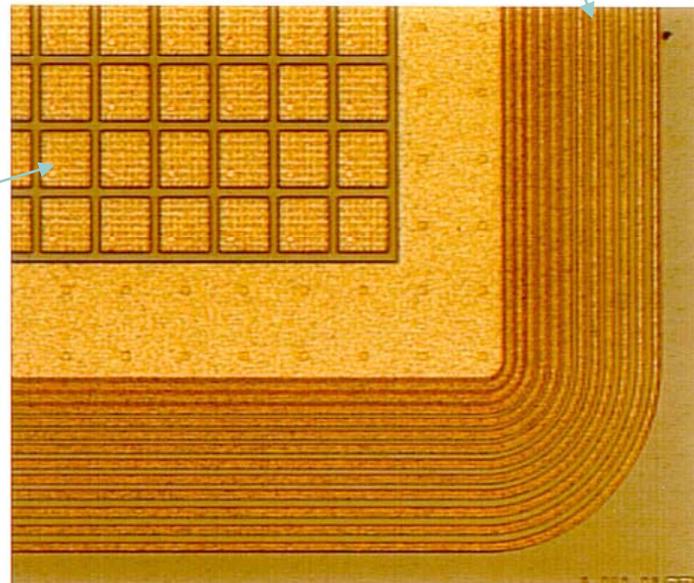
# Photos of some details



multiguadrings

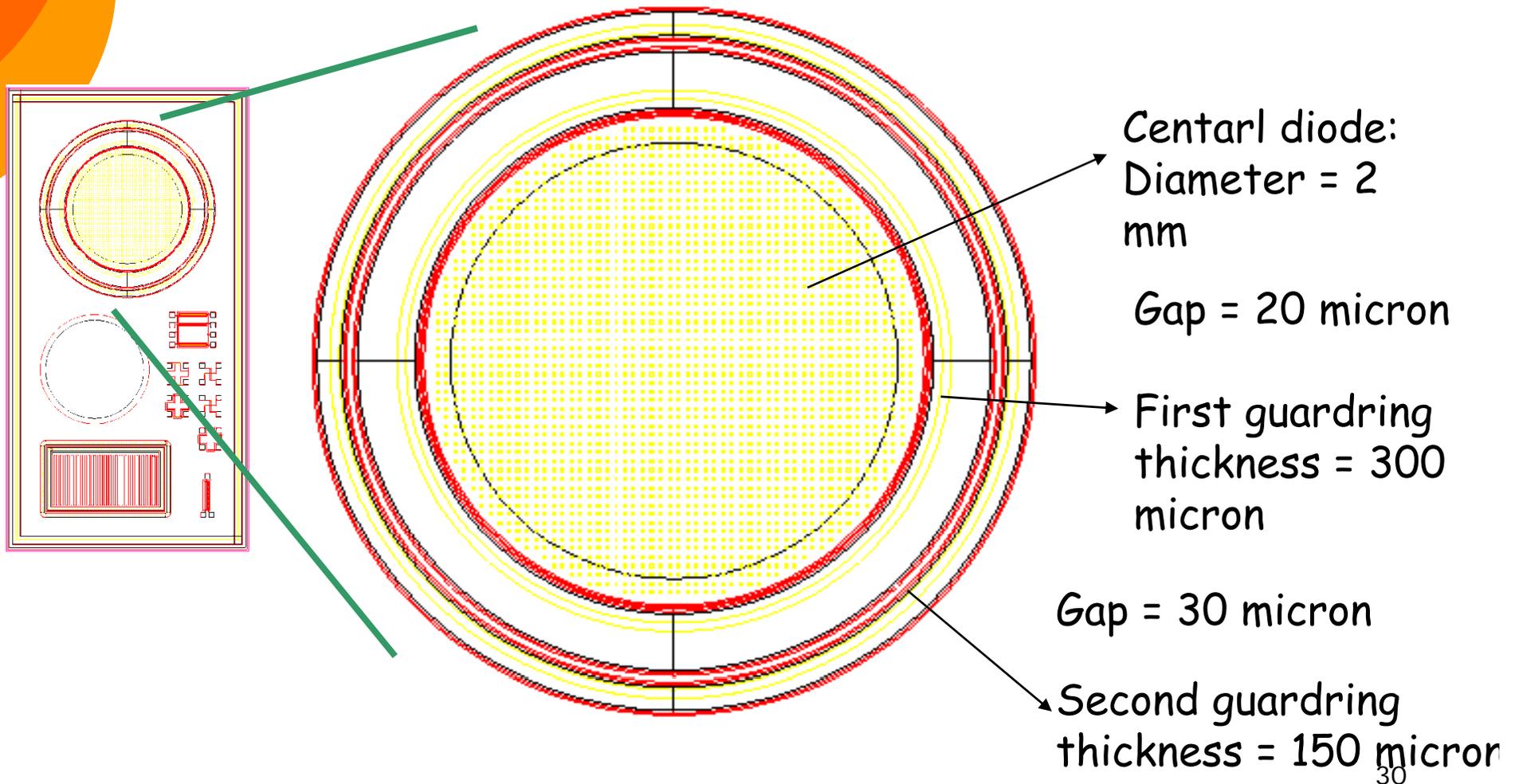
multiguadrings

Pixel  $150\ \mu\text{m} \times 150\ \mu\text{m}$



## Test structure in the wafer

To check the properties of the wafers we have tested the electrical characteristic of some single diodes  
(3 diode for each wafer always in the same position)

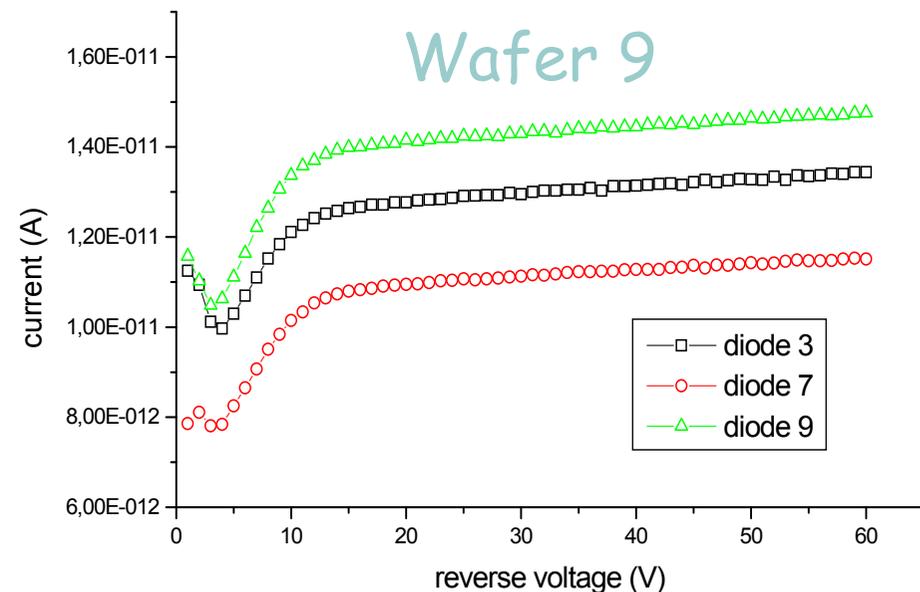
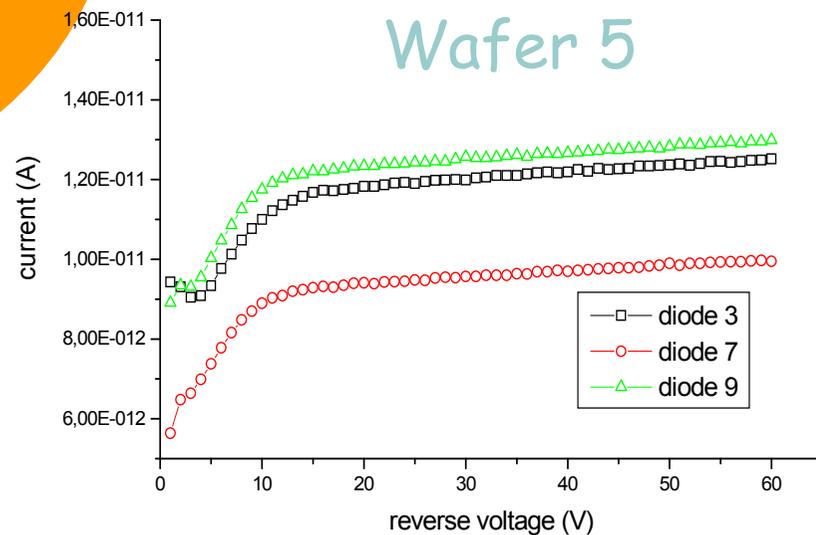


# Electrical Characterization

T= 21.5 °C U=65 %

Thickness 300  $\mu\text{m}$

Current in the central diode with guardring at ground



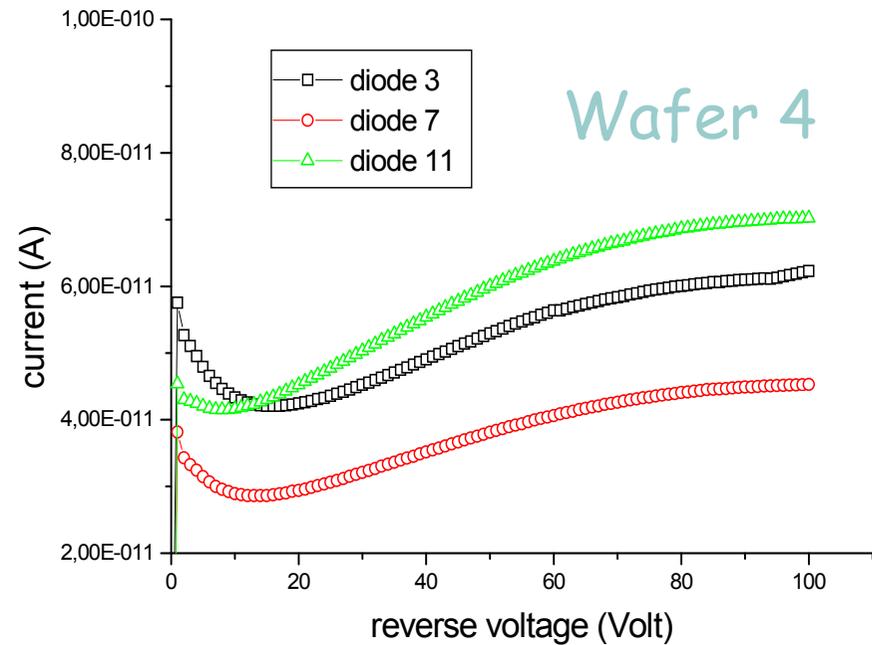
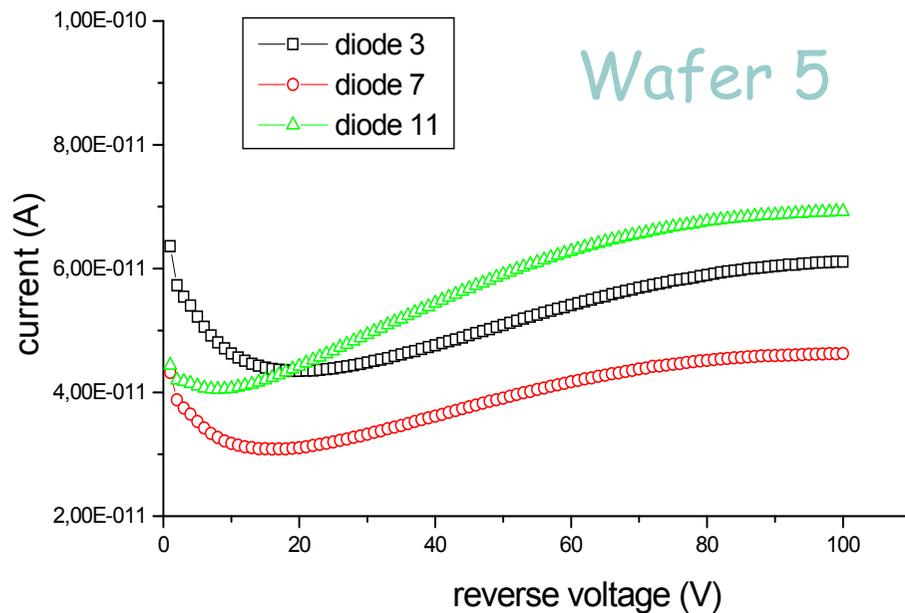
$1.2 \cdot 10^{-11} \text{ A} \rightarrow J = 3.8 \cdot 10^{-10} \text{ A/cm}^2$  contro  $J = 10^{-8} \text{ A/cm}^2$  del GaAs

# Electrical Characterization

Thickness 525  $\mu\text{m}$

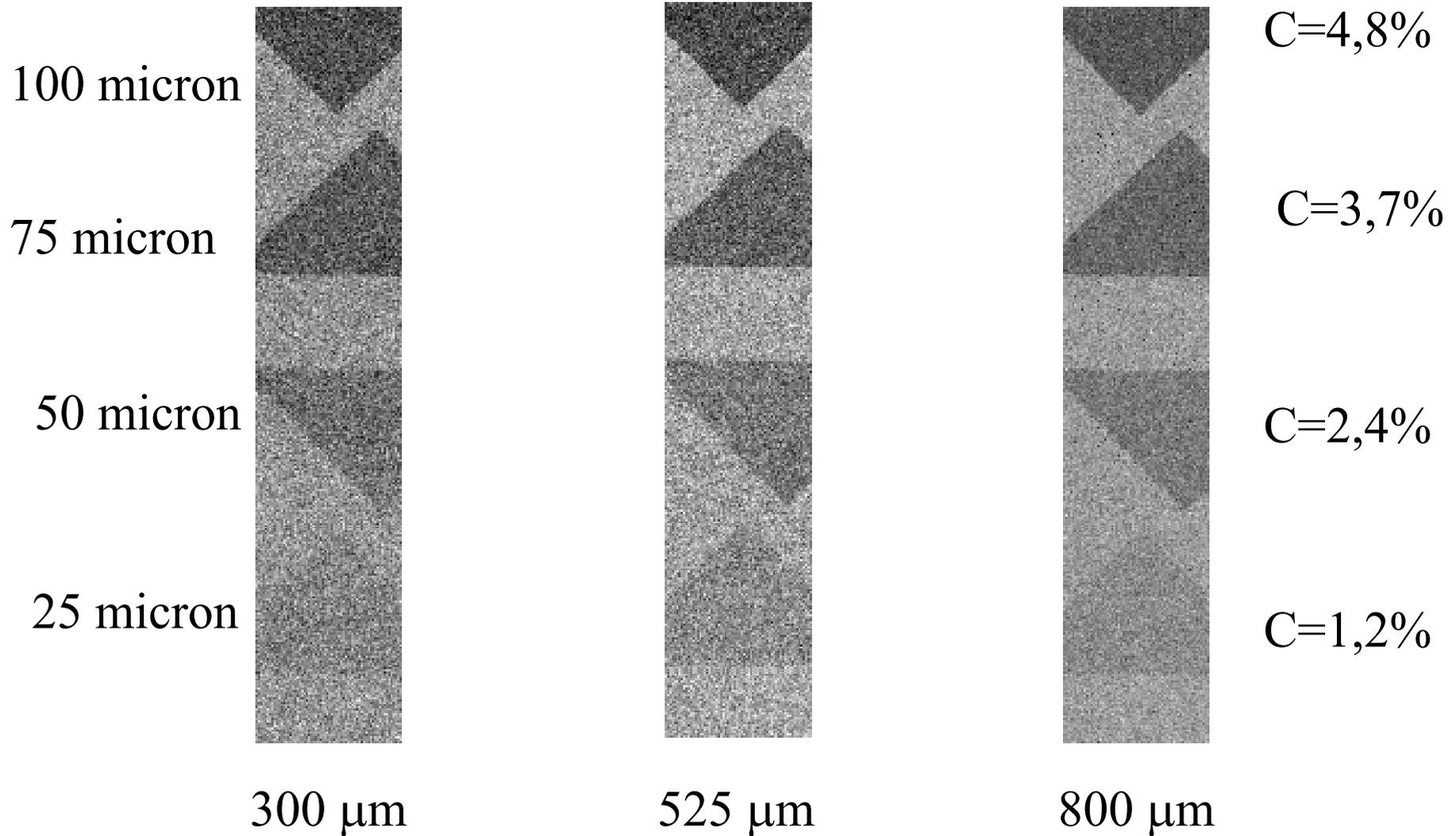
$T = 21.5\text{ }^\circ\text{C}$   $U = 65\%$

Current in the central diode with guardring at ground



# Image of different Al thickness

Exposure condition: W anode, 40 kV, 40 mA, 630 ms



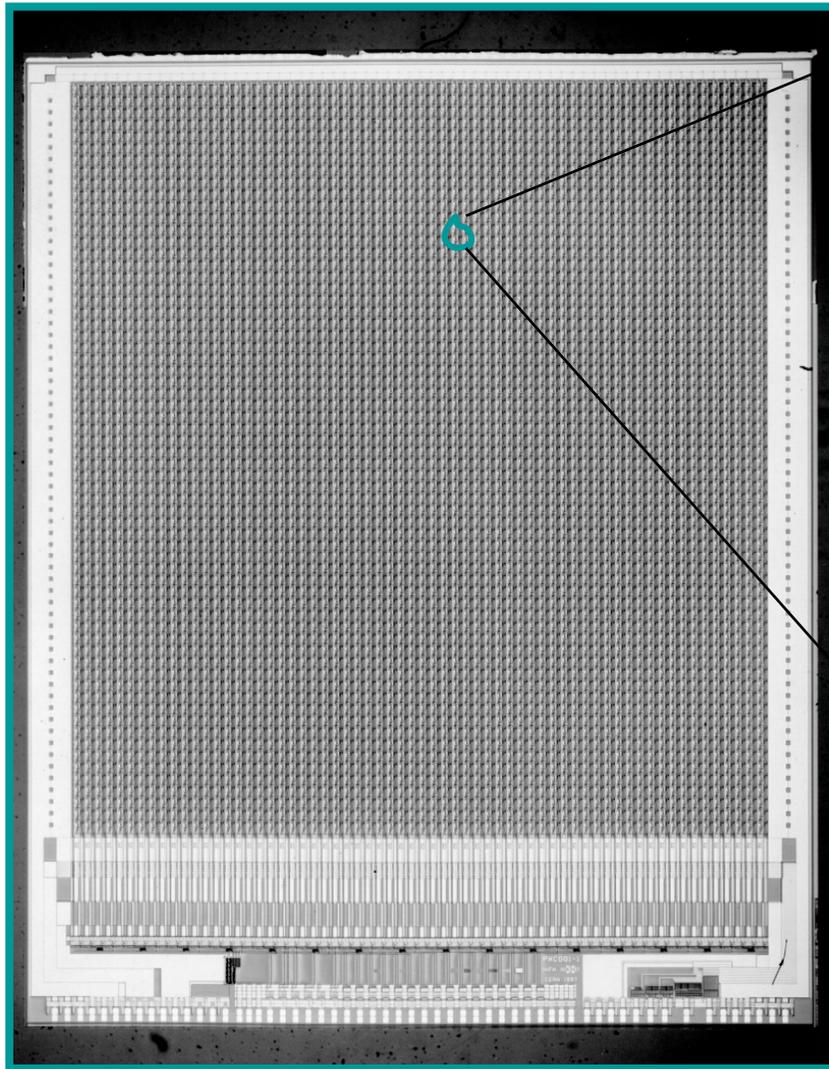


---

*Scelta la configurazione degli elettrodi  
di lettura e il materiale del rivelatore  
occorre un asic per leggerlo*

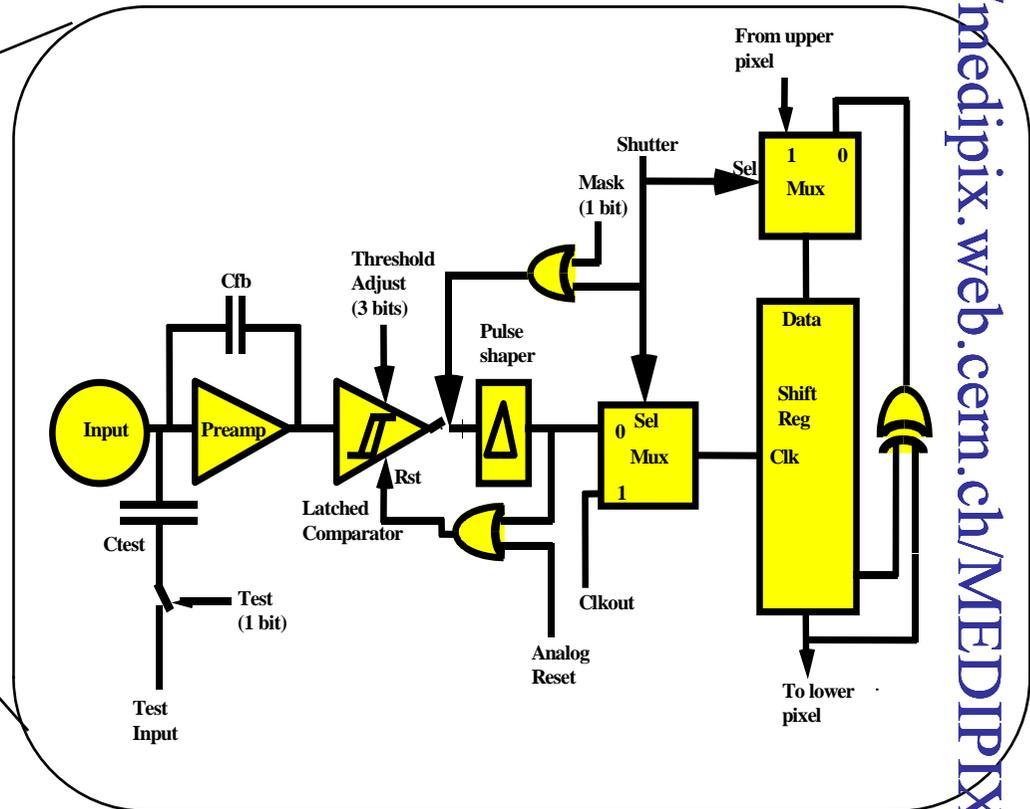
# MPXI: a single photon counting chip

<http://medipix.web.cern.ch/MEDIPIX/>



12 mm

2 mm



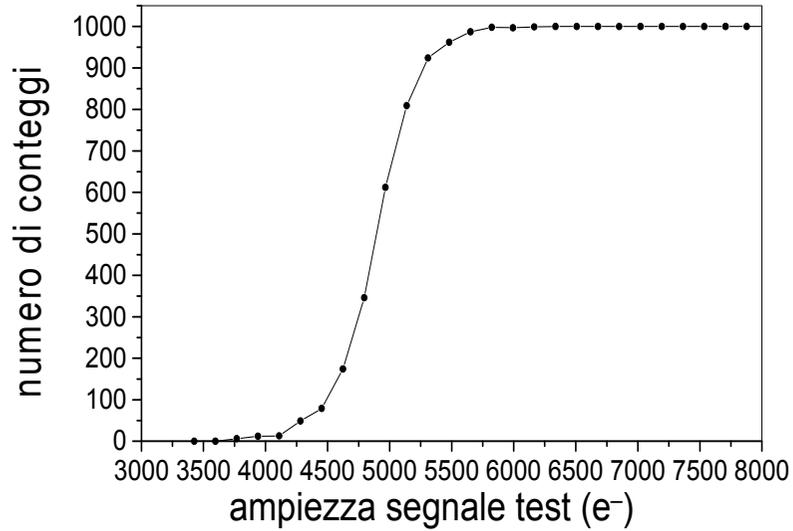
EP CERN SACMOS1  
FASELEC Zurigo  
pixel  $170 \times 170 \mu\text{m}^2$   
canali  $64 \times 64$   
area  $1.7 \text{ cm}^2$   
threshold adjust 3-bit  
pseudo-random counter 15-bit

## TEST ELETTRICI

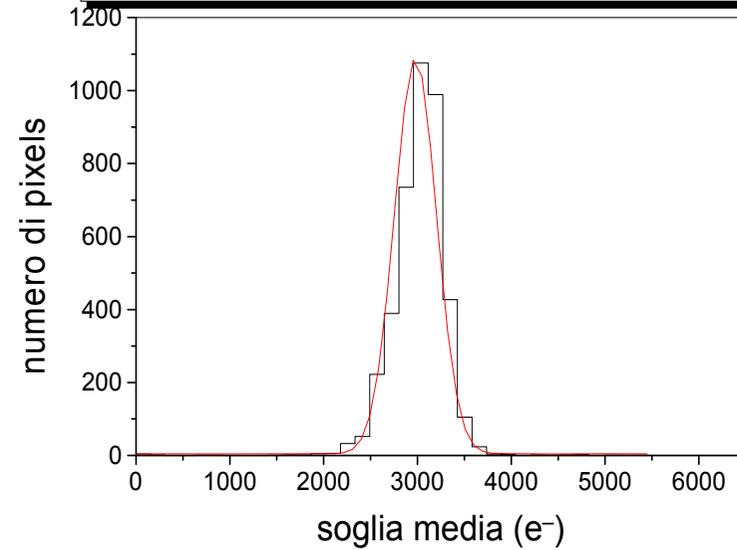
- Risposta di un singolo canale ad impulsi test
- Distribuzione di soglia media dei 4096 canali
- Costruzione della matrice di aggiustamento fine della soglia
- Misure di Cross-Talk
- Calibrazione elettrica del chip

# Test elettrici

Risposta di un singolo canale ad un treno di 1000 impulsi

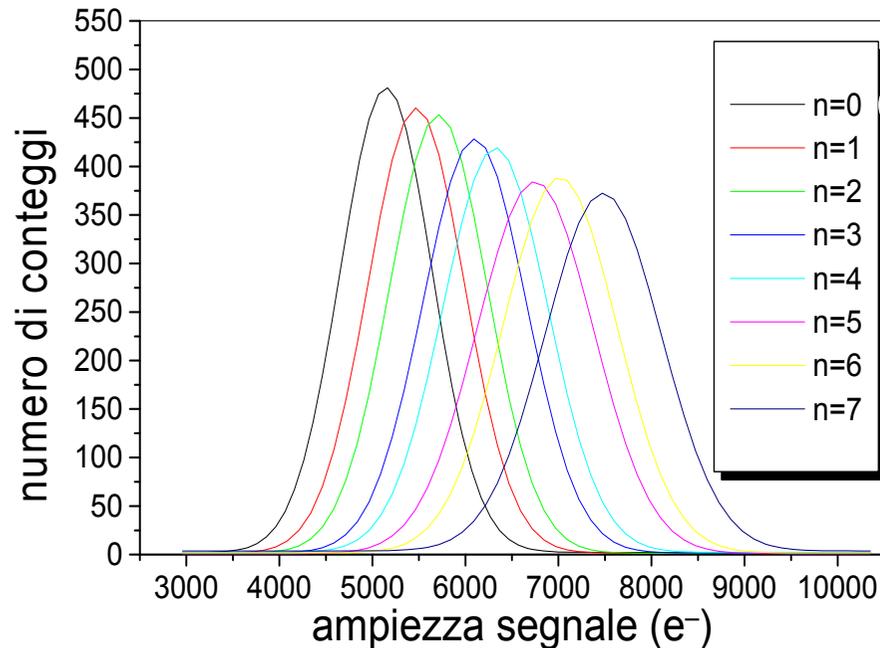


Distribuzione di soglia media per  $V_{th} = 1.2$  volt



SOGLIA(e <sup>-</sup> )	$\sigma_{TH}$ (e <sup>-</sup> )	ENC(e <sup>-</sup> )	$\sigma_{TOT}$ (e <sup>-</sup> )
2950	450	350	570

# Test elettrici



Aggiustamento fine della soglia

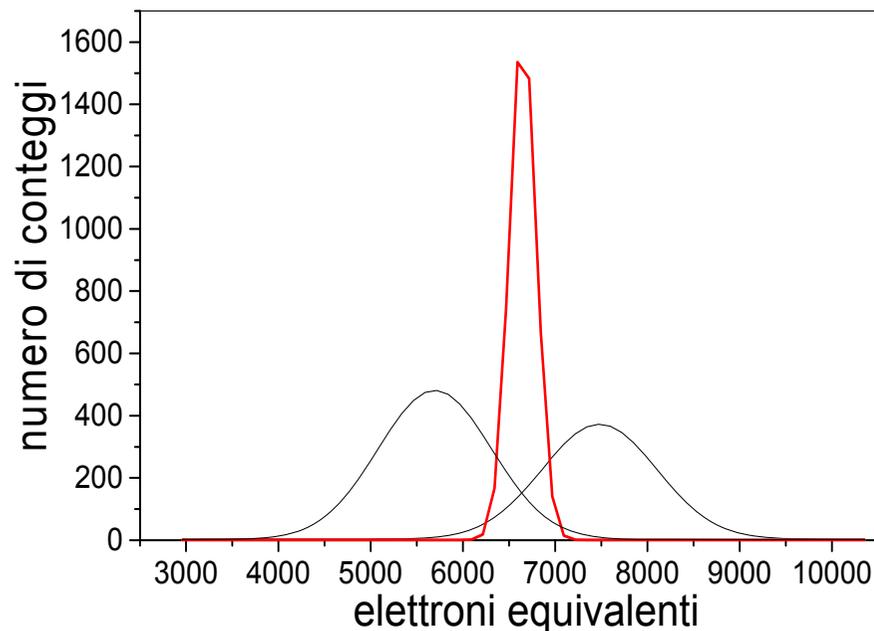
$$\text{Tensione di soglia} = V_{th} + n \times (V_{tha}/8)$$

$$n = 0, \dots, 7$$

Ad ogni pixel viene associata la combinazione di 3 bit che ne fa cadere la soglia nella regione di sovrapposizione fra la curva ottenuta per n=0 e quella per n=7



Matrice di configurazione fine della soglia



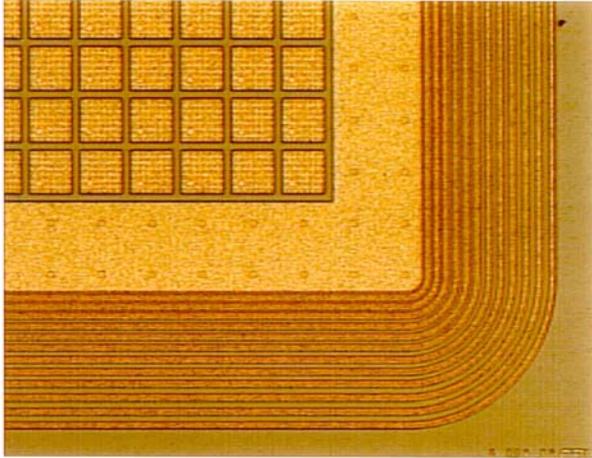
Scelto il lay-out del rivelatore pixels

Scelto il materiale

Scelto l'asic di lettura

Realizzare l'assembly

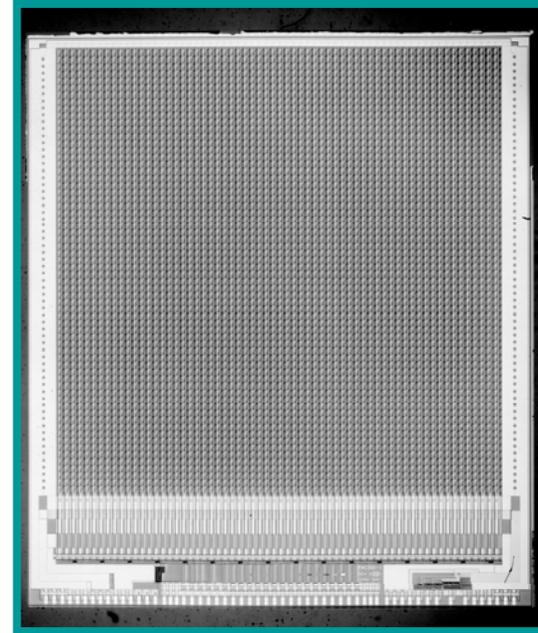
# Imaging system



## ITC-Irst Detector

- Si <111>
- 300-800  $\mu\text{m}$  thick
- pixel 170 x 170  $\mu\text{m}^2$
- p+ side 150x150  $\mu\text{m}^2$
- 64 x 64 chs
- 1.2  $\text{cm}^2$  area

Photon Counting Chip  
Medipix collaboration

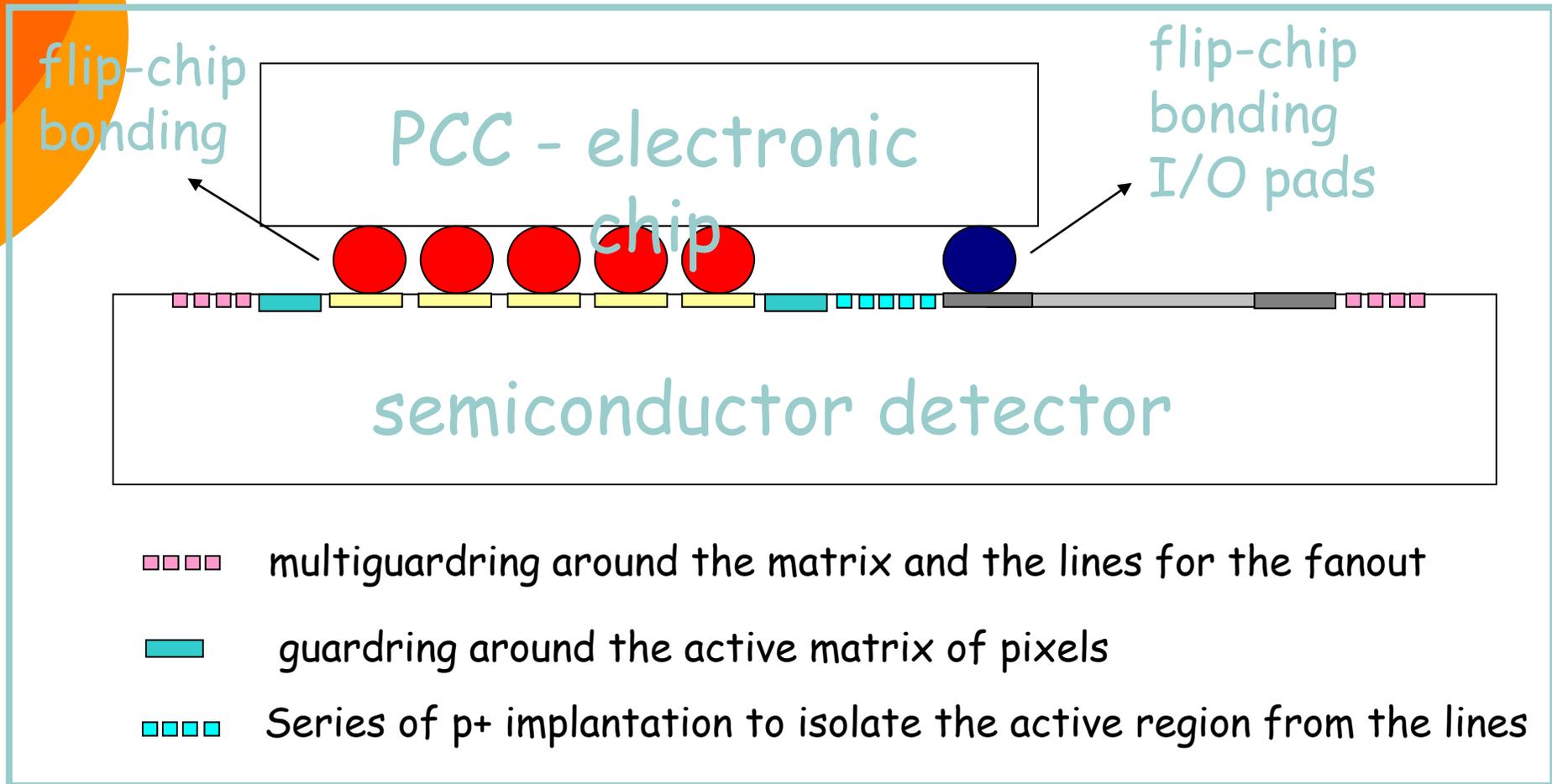


SACMOS 1  $\mu\text{m}$  technology  
pixel: 170 x 170  $\mu\text{m}^2$   
64 x 64 channels  
area 1.7  $\text{cm}^2$   
threshold adjust 3-bit  
15-bit counter

<http://medipix.web.cern.ch/MEDIPIX/>

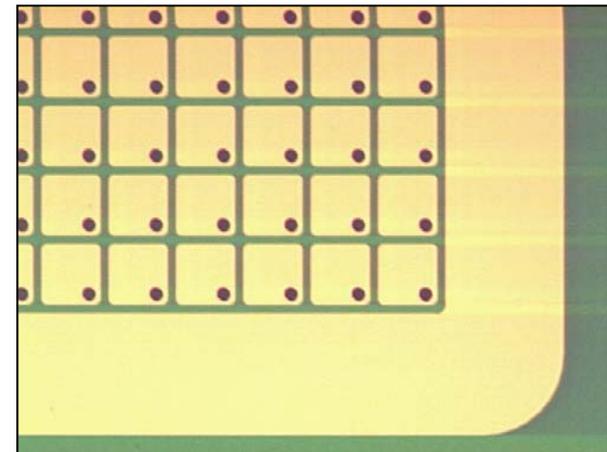
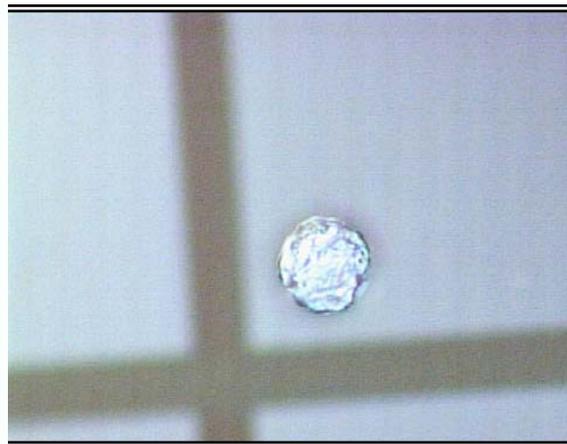
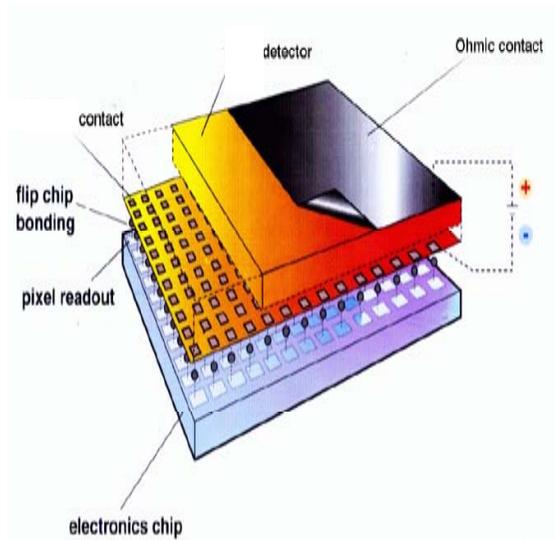
# Detector of area larger than the electronic chip

Wafer 4 inches in diameter, type of production p+/n, thickness 300 - 500  $\mu\text{m}$

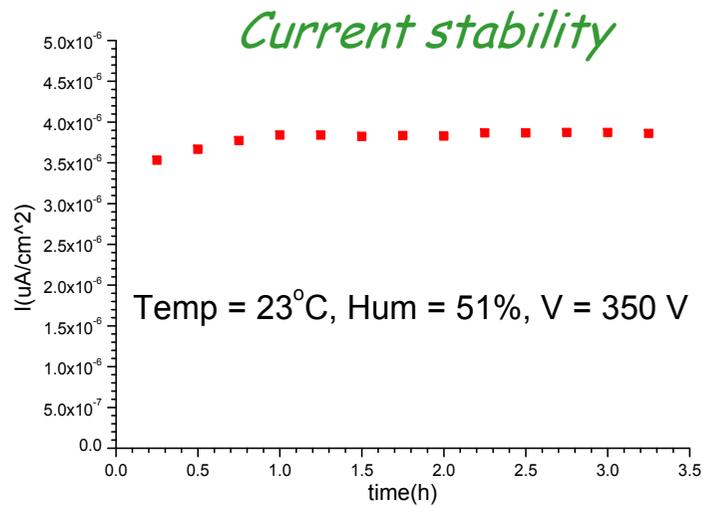


# The Indium Bump Bonding

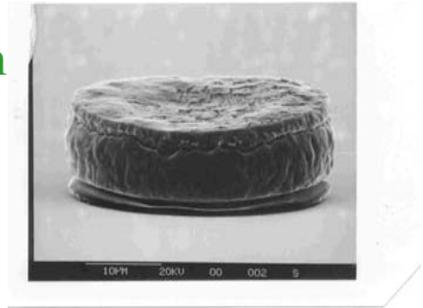
- The AMS (Alenia Marconi Systems) process
  - Under Bump Metal (UBM): evaporation of a Ti/Al multilayer.
  - Bumps: Indium evaporation on the electronics and the detector pads
  - Bumps: cylindrical 30 $\mu\text{m}$  in diameter, 9 $\mu\text{m}$  high



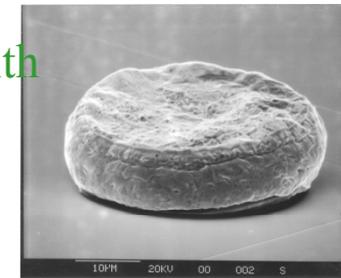
# Processes: Indium evaporation process adapted to GaAs New Au/Sn (10 mm high) galvanic growth



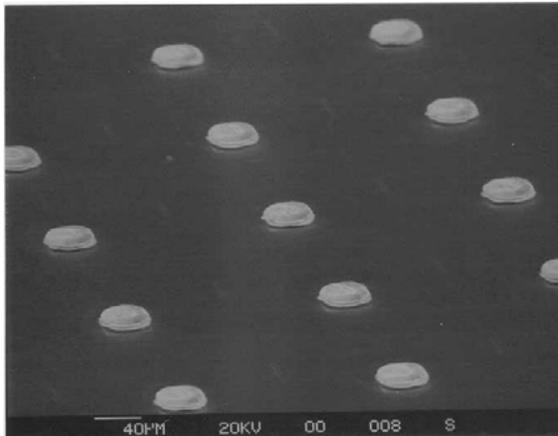
Au/Sn grown  
without  
thermic  
treatment



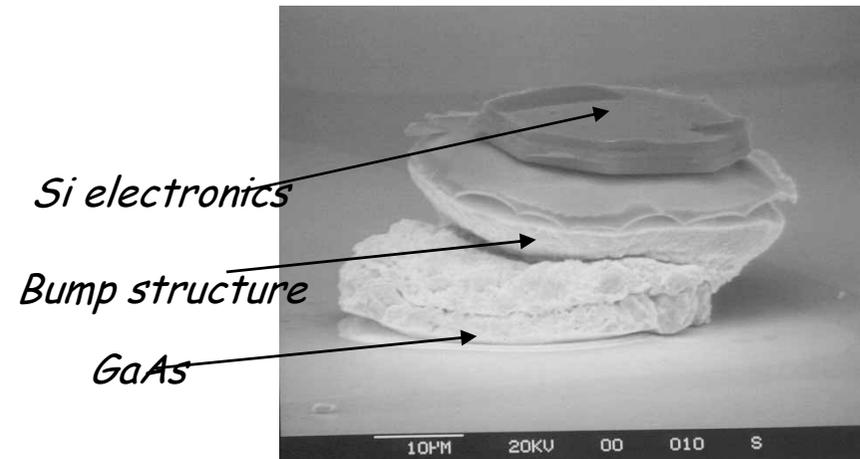
Au/Sn grown with  
alloy at 320°C



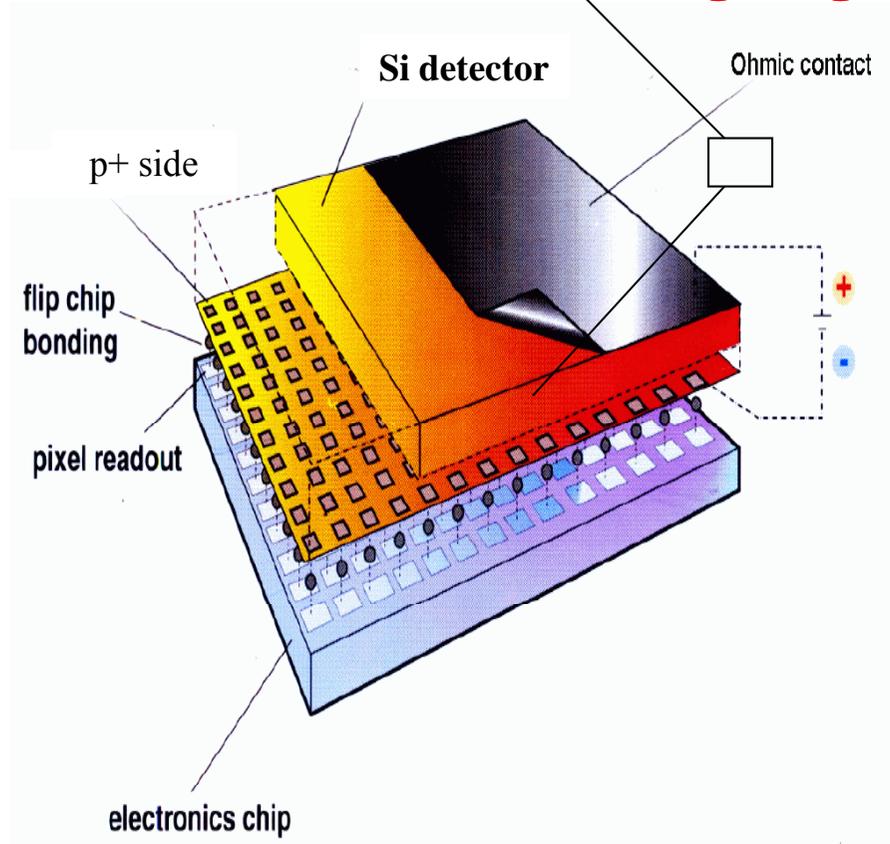
Overall sight of the bumps



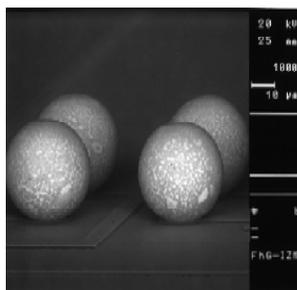
After mechanical breakage ...



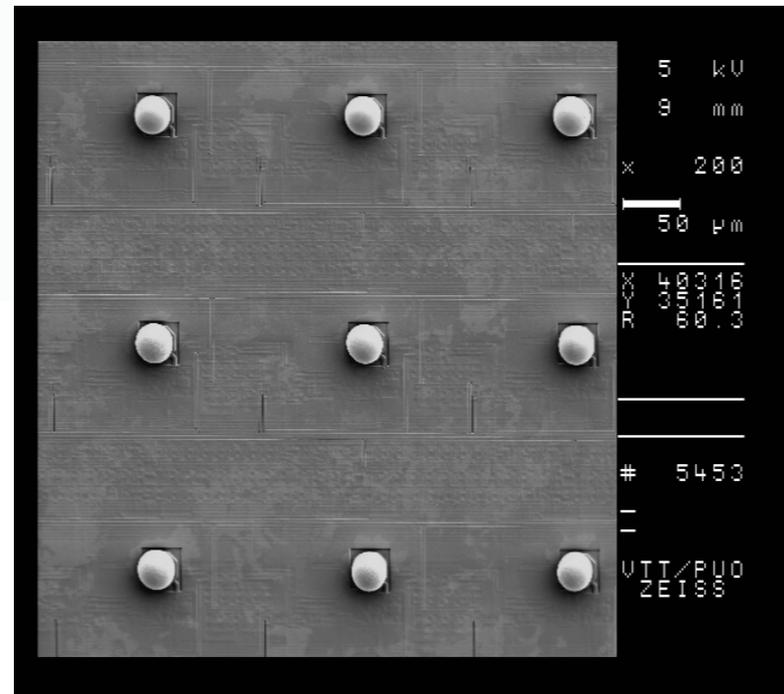
# Imaging system



VTT Bump-bonding:

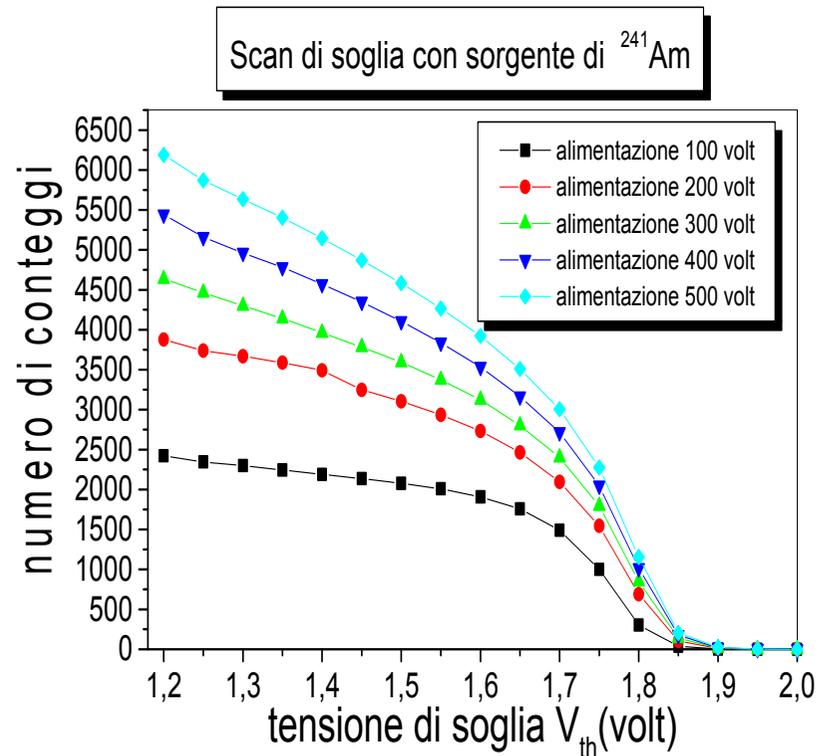
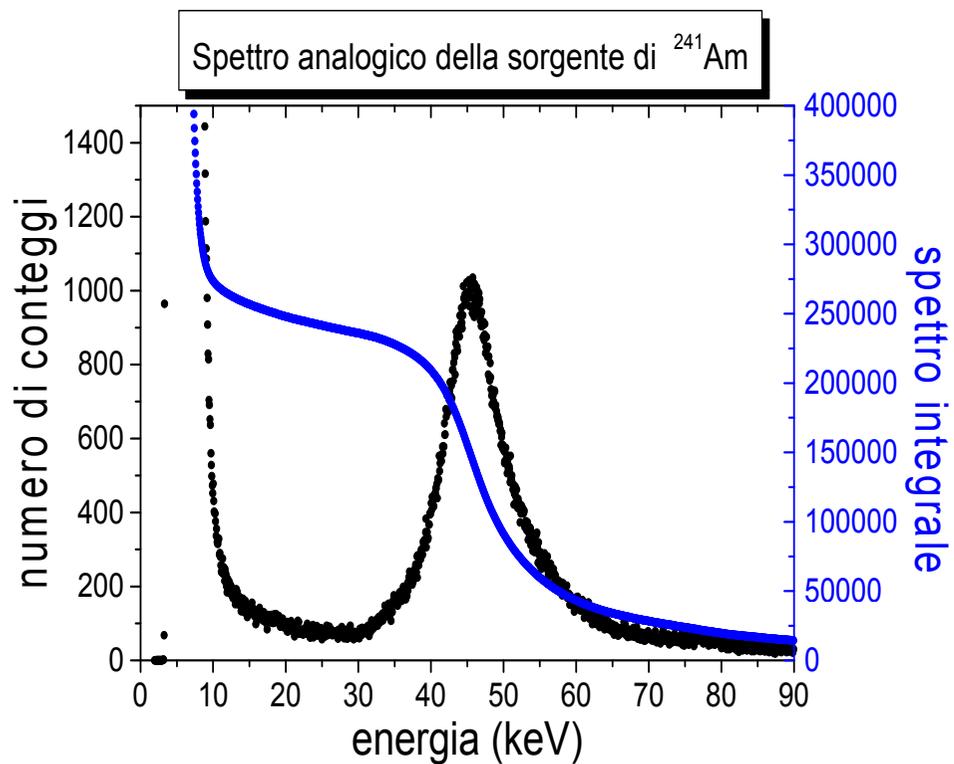


25 μm

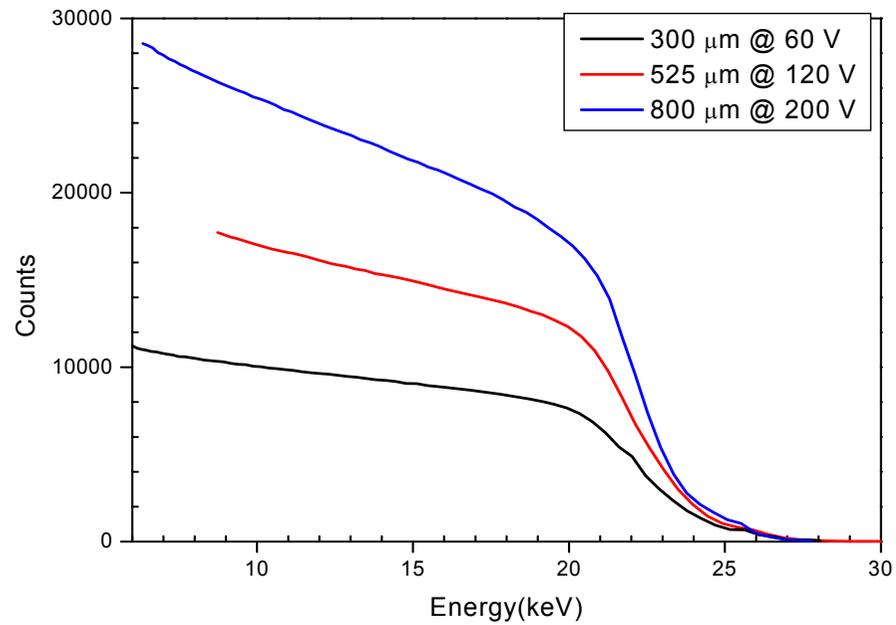


# REALIZZATO UN ASSEMBLY VA CARATTERIZZATO

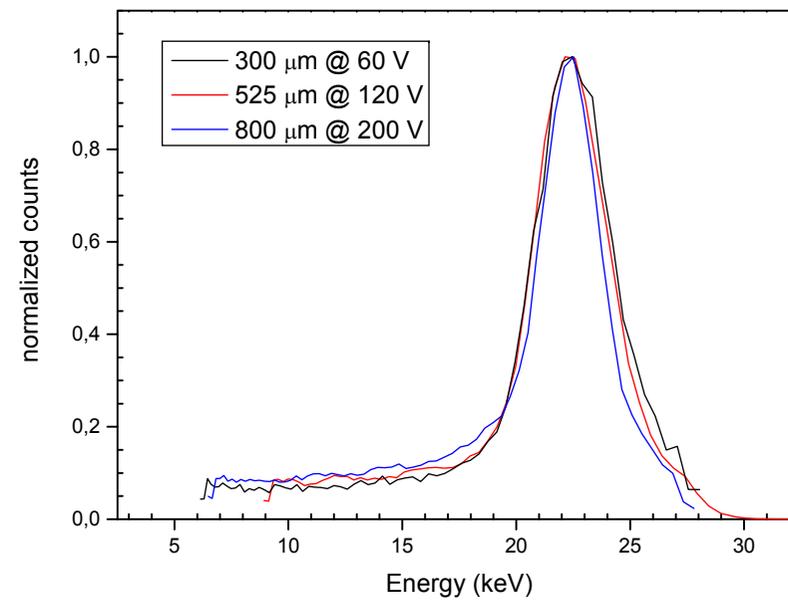
# Calibrazione con sorgenti radioattive



# Spectroscopic capability

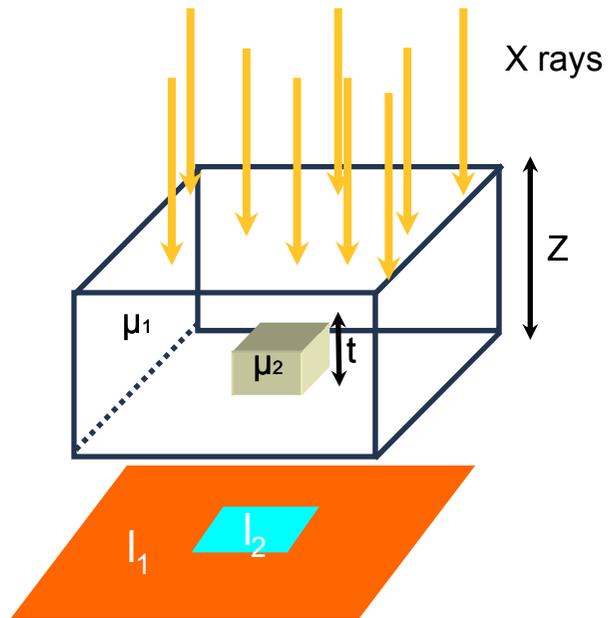


$^{109}\text{Cd}$  Integral spectra



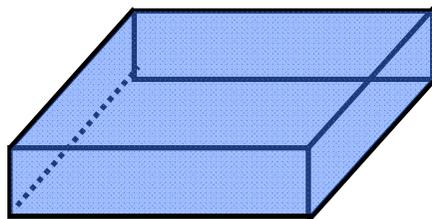
$^{109}\text{Cd}$  Differential spectra<sup>47</sup>

# Physical Parameters



$$C_{rad} = \frac{n_1 - n_2}{n_1} = 1 - e^{-\Delta\mu t}$$

$$SNR = \frac{n_1 - n_2}{\sqrt{\sigma_1^2 + \sigma_2^2}} = \frac{n_1 - n_2}{\sqrt{n_1 + n_2}}$$



Digital  
Detector



Detected Image

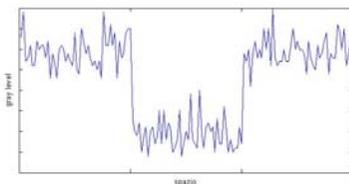
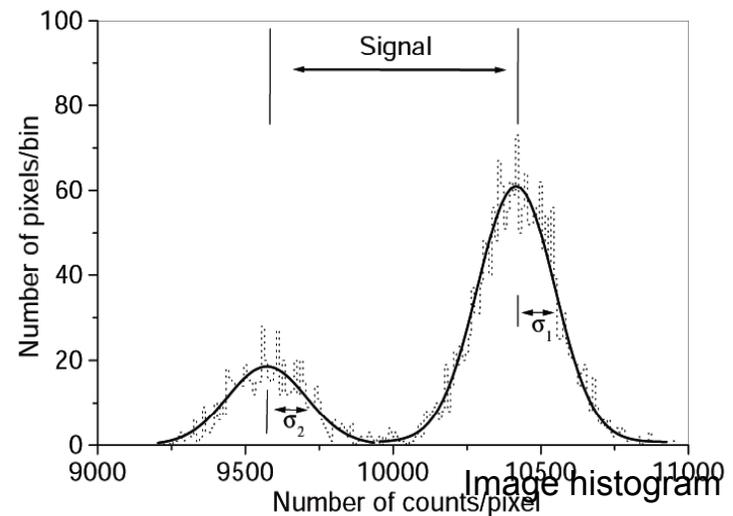
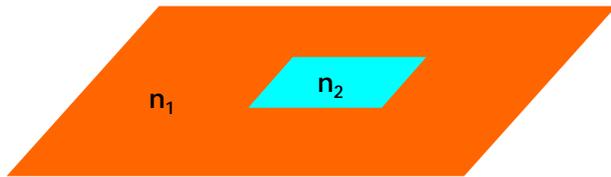


Image line profile

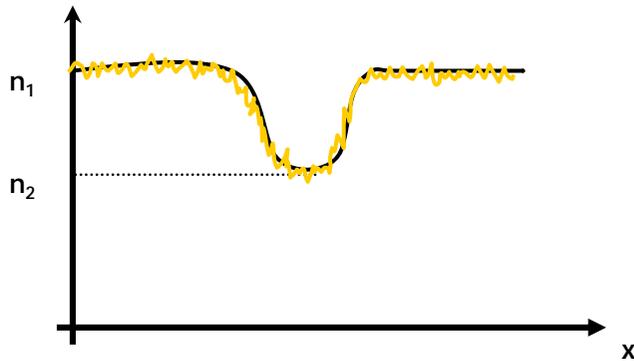


# Signal to Noise Ratio



$$SNR = \frac{n_1 - n_2}{\sqrt{\sigma_1^2 + \sigma_2^2}}$$

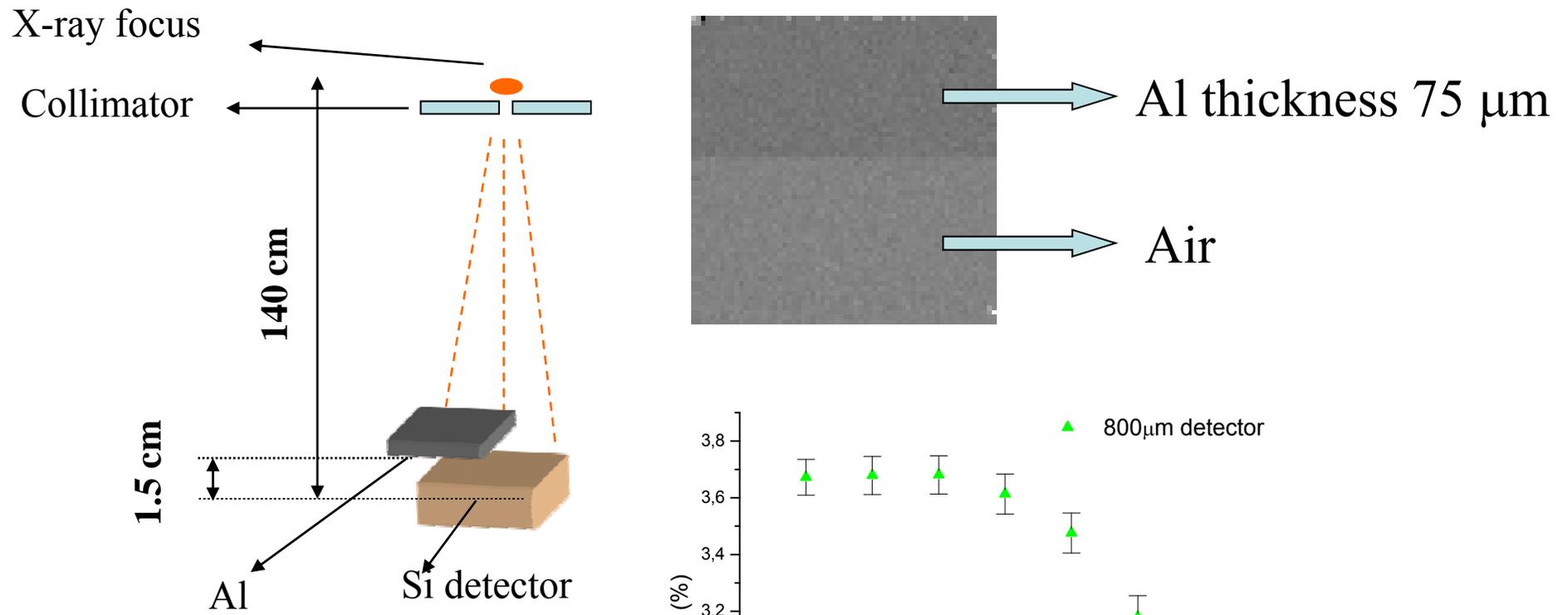
Only statistics fluctuations



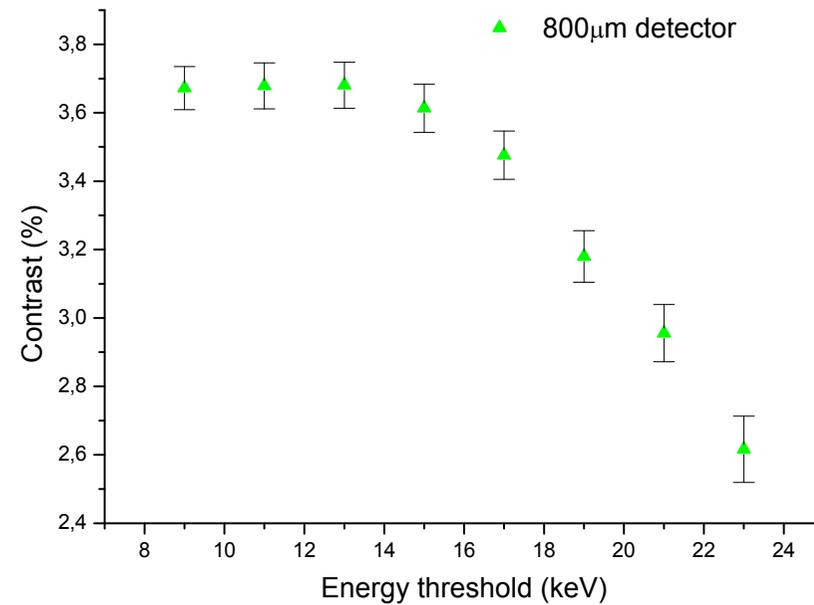
$$SNR = \left(1 - e^{-(\Delta\mu)s}\right) \sqrt{\frac{NAe^{-\mu t} \epsilon}{1 + R}}$$

# Contrast measurements

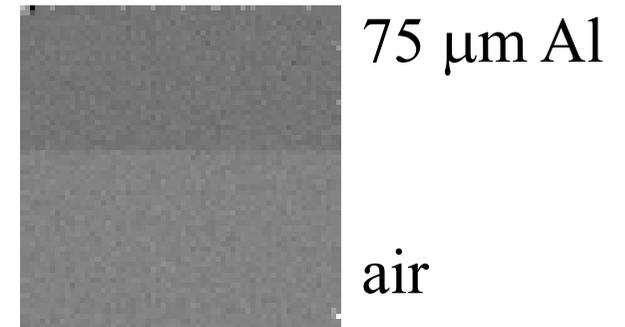
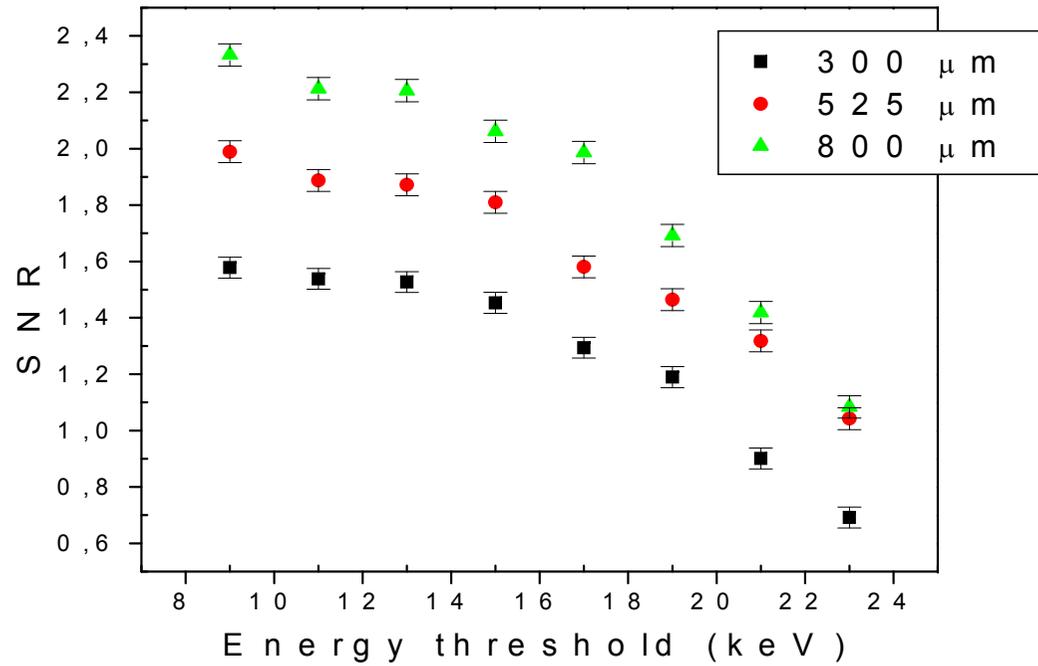
X-ray (W-anode) settings : 40 kV, 25 mA, 500 ms



$$C = \frac{N_{air} - N_{Al}}{N_{air}}$$



# Signal to Noise Ratio



$$SNR = \frac{|N_{air} - N_{Al}|}{\sqrt{\sigma_{air}^2 + \sigma_{Al}^2}}$$

# APPLICAZIONI

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- ❑ **DIGITAL MAMMOGRAPHY**
- ❑ **CARATTERIZZAZIONE DEL FASCIO DI PROTONI A CATANA**
  - ❑ **DUAL ENERGY**
- ❑ **MAMMOGRAFIA A TRIESTE**

***A MAMMOGRAPHIC HEAD  
DEMONSTRATOR WAS DEVELOPED IN  
THE FRAMEWORK OF THE “IMI”  
PROJECT***



# The Integrated Mammographic Project

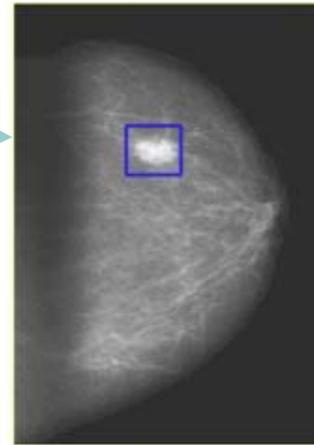
- The Integrated Mammographic Imaging (IMI) project aims to realize innovative instrumentations for morphological and functional mammography.
- Funded by the Italian Ministry of Education, University and Research (MIUR) and promoted by the INFN for the technological transfer to the national industry  
A. Stefanini, University of Pisa, project-leader
- Research lines:
  - An advanced gamma camera for scintimammography
  - GaAs detectors and bump bonding techniques
  - A prototype of a mammographic head and related developments
  - A high intensity tunable quasi-monochromatic X-ray source

# Digital Mammography

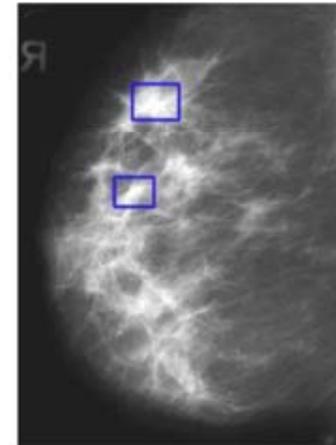
Principal Mammography task:

✓ Detection of the tumor masses  
(objects with contrast  $< 1\%$  and  
diameter  $\approx 1-5$  mm)

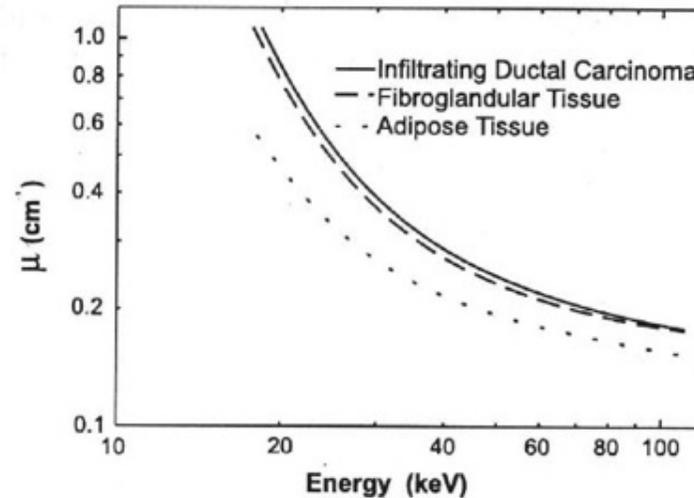
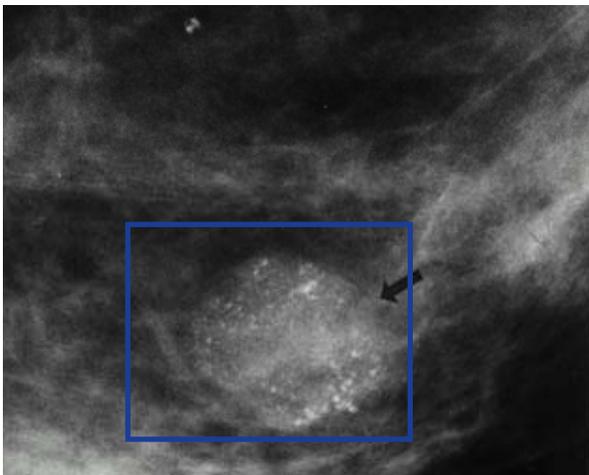
✓ Detection of the  
microcalcifications  
(objects with high contrast and  
small dimensions  $\approx 100 \mu\text{m}$ )

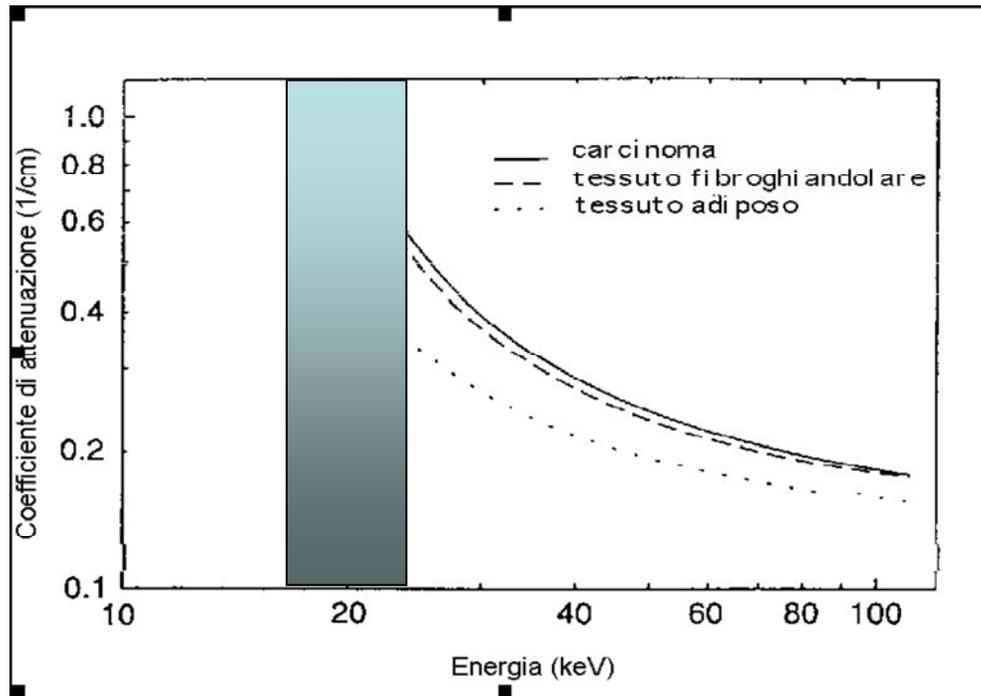


a) Breast carcinoma surrounded by adipose tissue



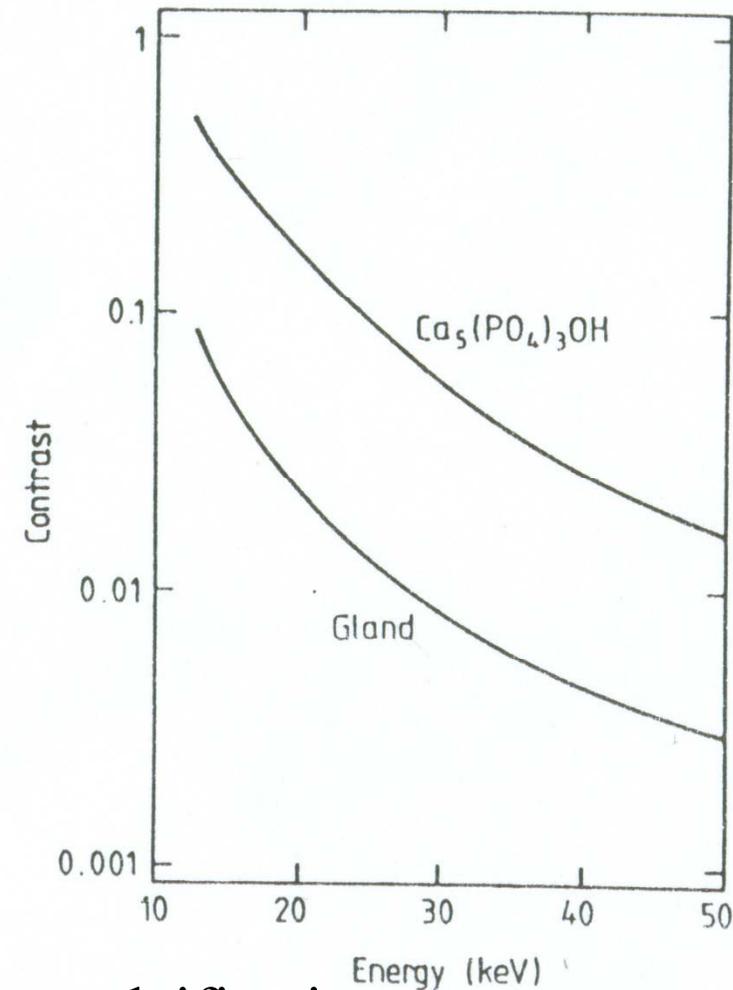
b) Breast carcinoma surrounded by fibroglandular tissue





## Tumour masses

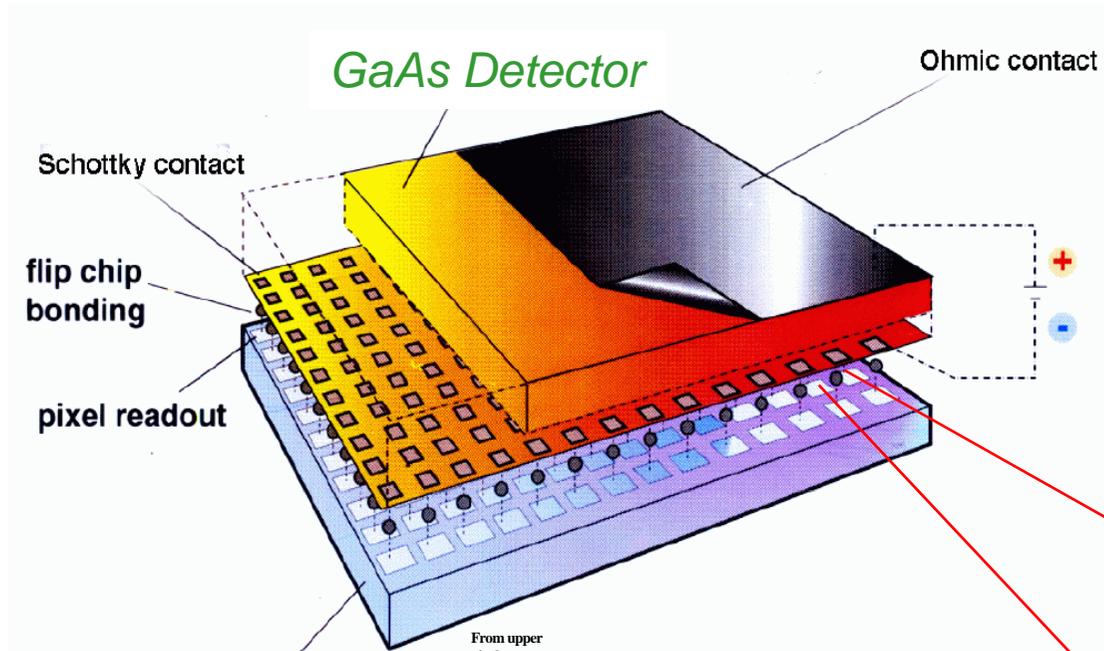
- Healthy tissue degeneration
- X-ray Attenuation properties similar to healthy tissue
- Size > 5 mm



## Microcalcifications

- Submillimetric calcium deposits
- Denser than gland and adipose tissues
- Cluster of microcalcifications are tumour markers

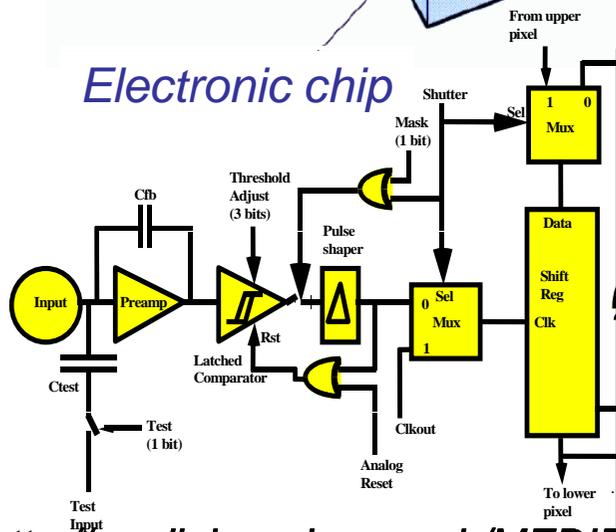
# The MedipixI/PCC detection unit



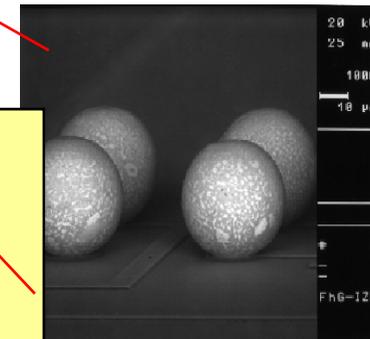
## Detectors by AMS Italy

- ⑩ semiconductor :  
GaAs: 200  $\mu\text{m}$  thick
- ⑩ pixel 170 x 170  $\mu\text{m}^2$
- ⑩ Schottky 150x150  $\mu\text{m}^2$
- ⑩ channels 64 x 64
- ⑩ area 1.2  $\text{cm}^2$

## Electronic chip



*Photon Counting Chip (PCC)*  
*MIC CERN SACMOS 1  $\mu\text{m}$*   
*FASELEC Zurigo*  
*Pixel 170 x 170  $\mu\text{m}^2$*   
*Channels 64 x 64*  
*Area 1.7  $\text{cm}^2$*   
*Threshold adjust 3-bit*  
*Pseudo-random counter 15-bit*



*Indium Bump-bonding*  
*By AMS Italy*

# Digital Mammography

## Imaging detector requirements:

- High efficiency
- Low Noise
- High Spatial Resolution
- Maximization of the contrast information contents

## Technical solutions:

- Semiconductor Pixels Detector
- Direct Detection technology
- High Z material (GaAs)
- Single Photon Counting



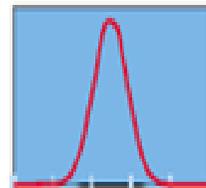
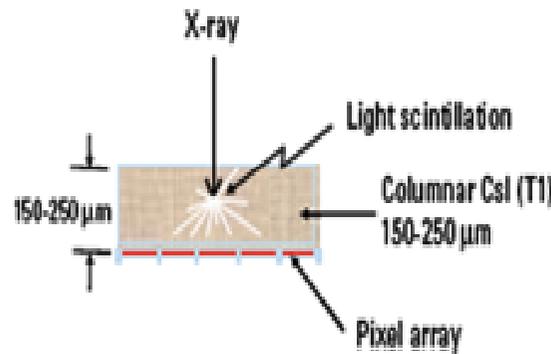
Indirect Detectors electronics

Direct Detectors

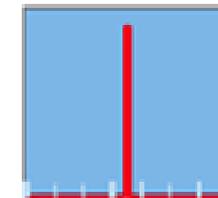
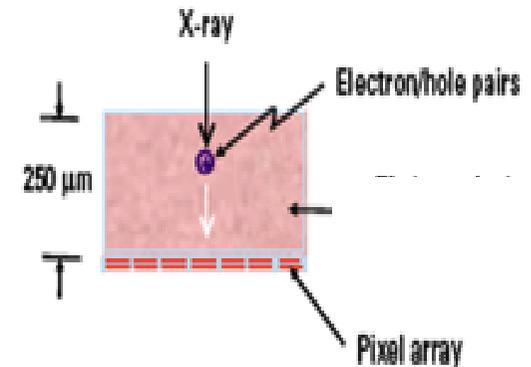
Conventional Digital Mammography: Indirect detection

Charge Integration

Flat-panels Phosphor Systems  
Scanning Phosphor-CCD Systems



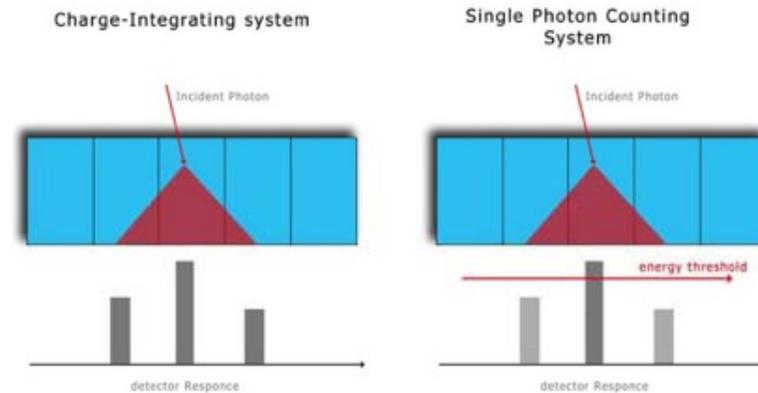
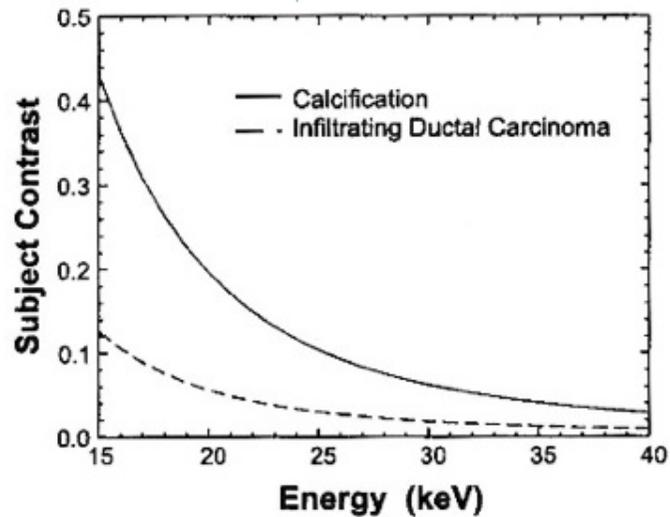
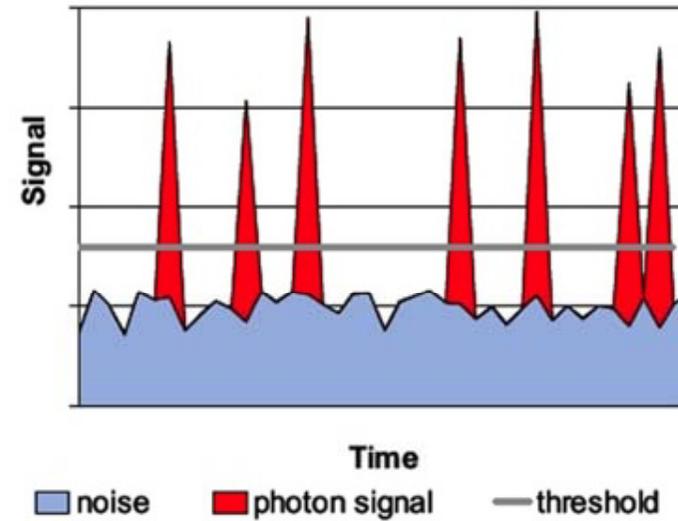
Line spread function



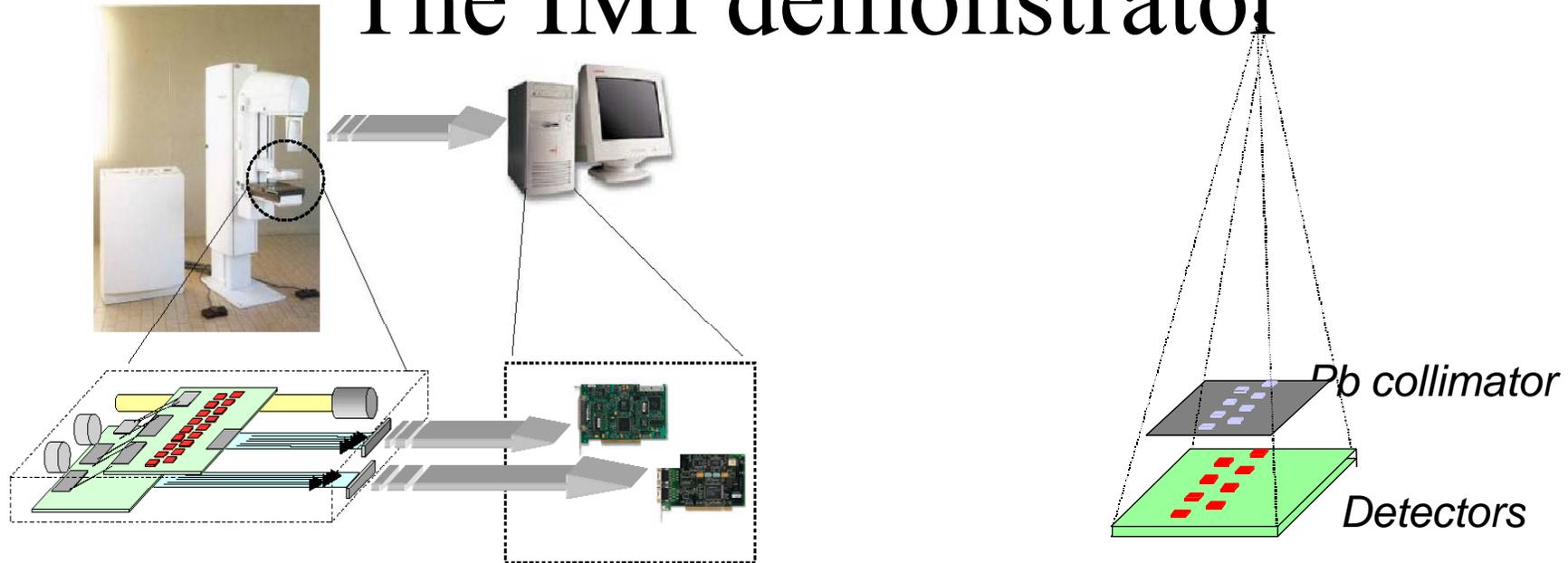
Line spread function

# Why Single Photon Counting?

- Good noise discrimination
- Improvement of the Spatial Resolution
- Maximization of the contrast information contents



# The IMI demonstrator



- Mosaic geometry with staggered rows of nine assemblies each one,
- Scanning across the exposure field by means of a stepper motor.
- The read-out system MMRS (Multichip Medipix Readout System) (LABEN)
  - custom designed chipboard
  - interface board (IB), connected to the chipboard, implements all the logic functions of the MMRS
  - PCI board commercial board (NI 6533) that interfaces the IB to the PC.
- The BIAS Board (CAEN) provides the analog and digital biases of the chips.
- The X ray tube (Gilaroni) is the clinical mammographer SYLVIA adapted to host the collimator and the detection head.
- A controller PC handles the whole image acquisition process by means of a software program written in LabWindows CVI.

# The IMI Demonstrator



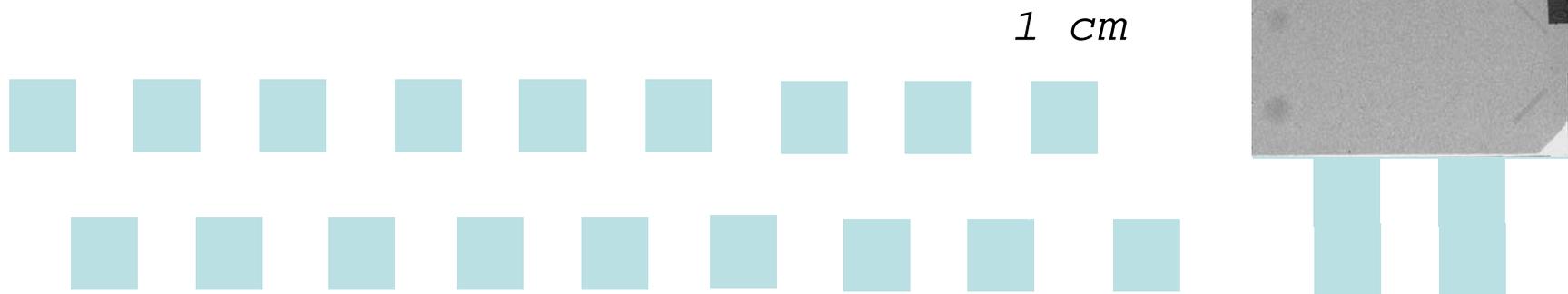
*X ray tube*

*Mammographic  
Head*

*LEAD COLLIMATOR*

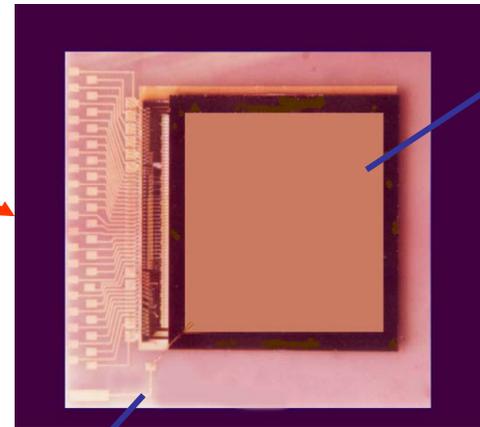
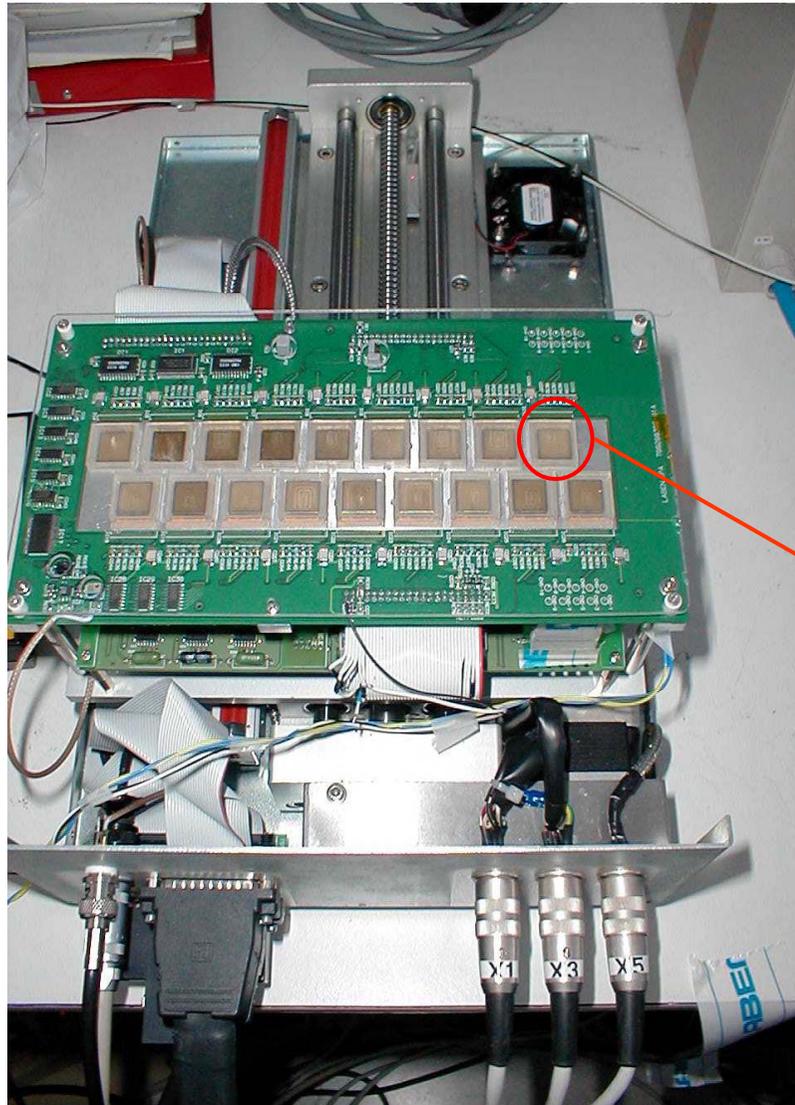
# Scanning simulation

- 18 x 24 cm<sup>2</sup> exposure field
  - 1D scanning
  - 9 x 2 assemblies
  - 26 exposures
- “off-line” image reconstruction



# The Detection head

- The Detection Unit
  - The assemblies have been produced and bump bonded by Alenia Marconi Systems (Roma)
  - Each detection unit has been mounted in a protective case.



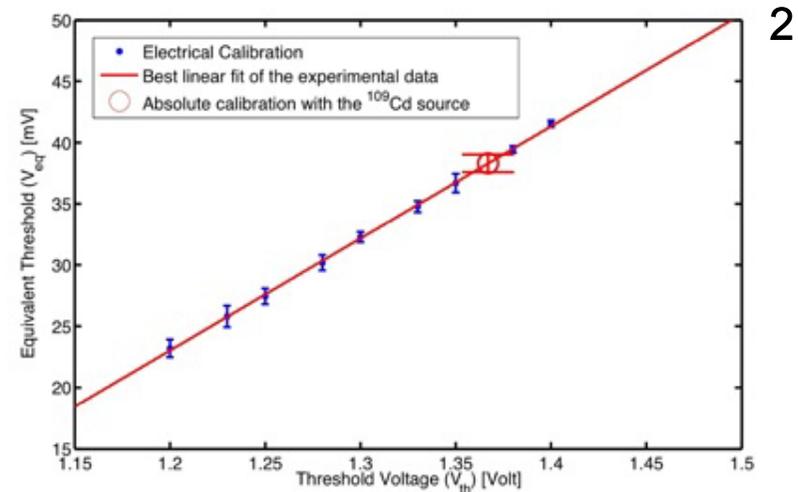
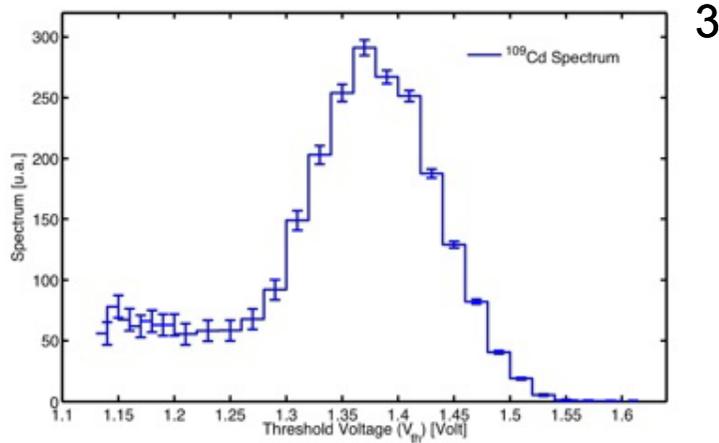
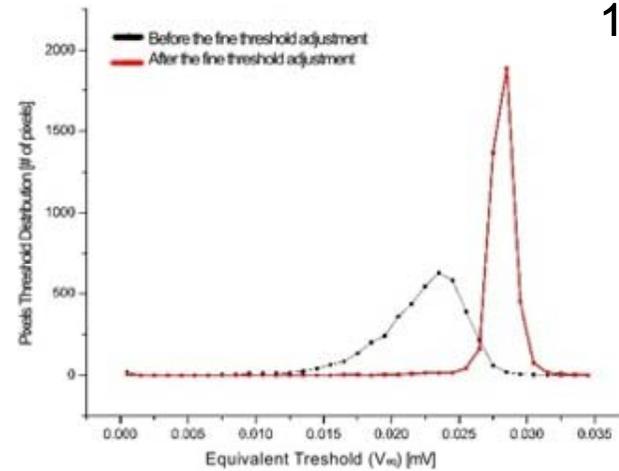
**GaAs  
MPXI/PCC  
assembly**

*Aluminum nitride (AlN)  
substrate,  
LEXAN cover on top (not  
shown)*

# Calibration of the IMI system

- Threshold equalization:
- Fine pixel threshold adjustment (3-bit resolution)
- Electrical calibration
- Absolute energy calibration

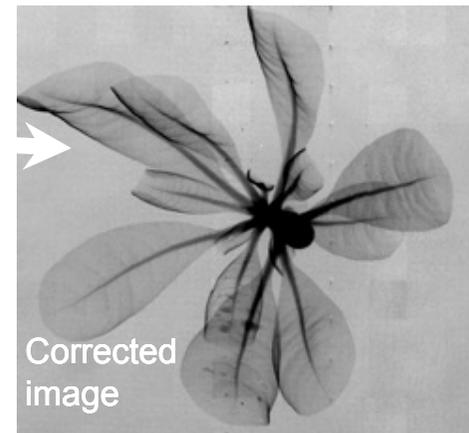
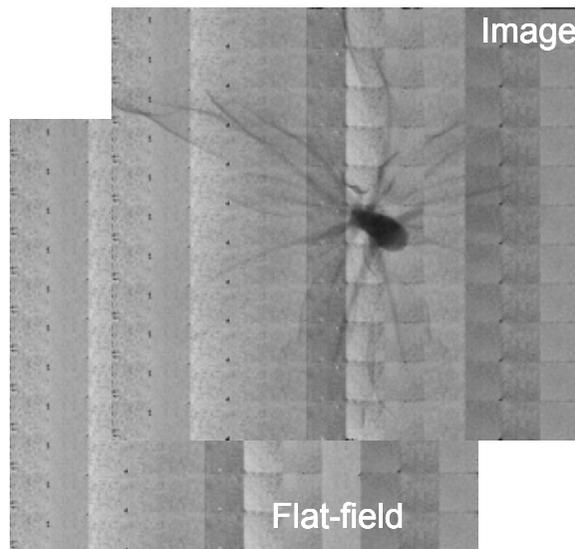
Energy threshold = 11 keV  
(spread 1keV)



# Calibration of the IMI system

## Gain equalization:

- Flat-field equalization
- Noise pixels removing procedure

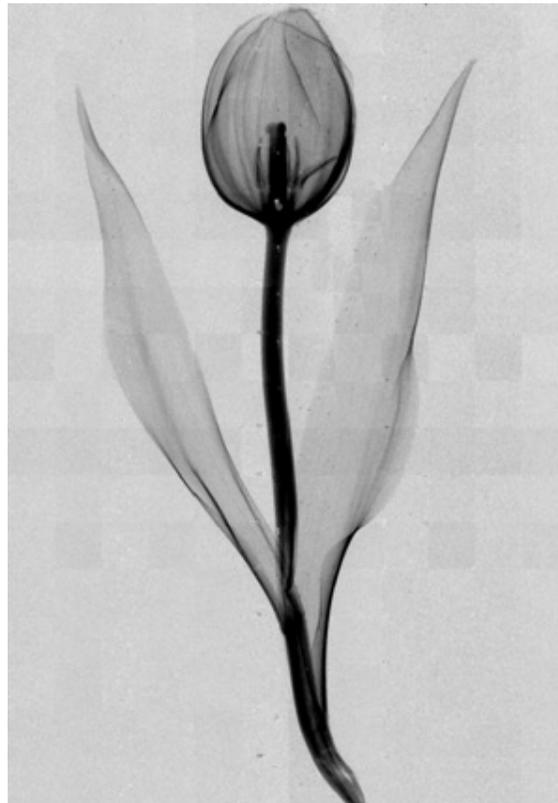


## The IMI Prototype (firsts acquired images)

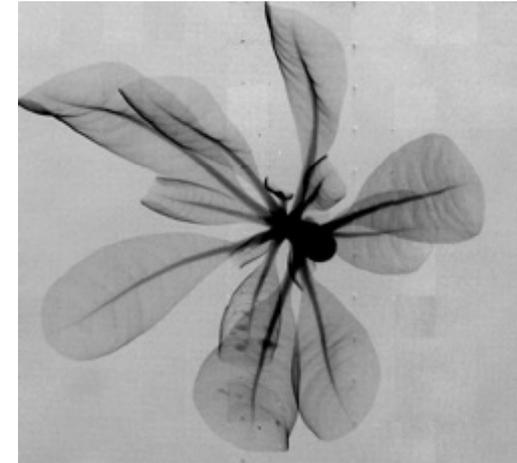
---



12cm x 20cm

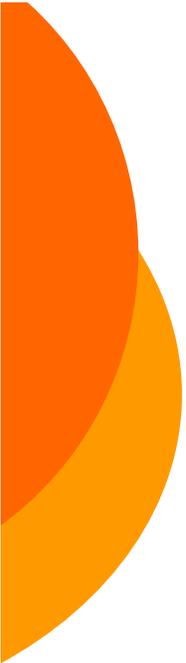


12cm x 17cm



12cm x 11cm

Mo/Mo, 28kVp, 20 mAs



# Assessment of the Imaging Quality of the IMI Prototype

---

Two different strategies have been followed:

## 1. Transfer Functions analysis:

(Protocol IEC 62220-1-2: "Medical electrical equipment - Characteristics of digital X-ray imaging devices - Part 1-2: Determination of the detective quantum efficiency - Detectors used in mammography")

- Presampling Modulation Transfer Function (PMTF)
- Detective Quantum Efficiency (DQE)

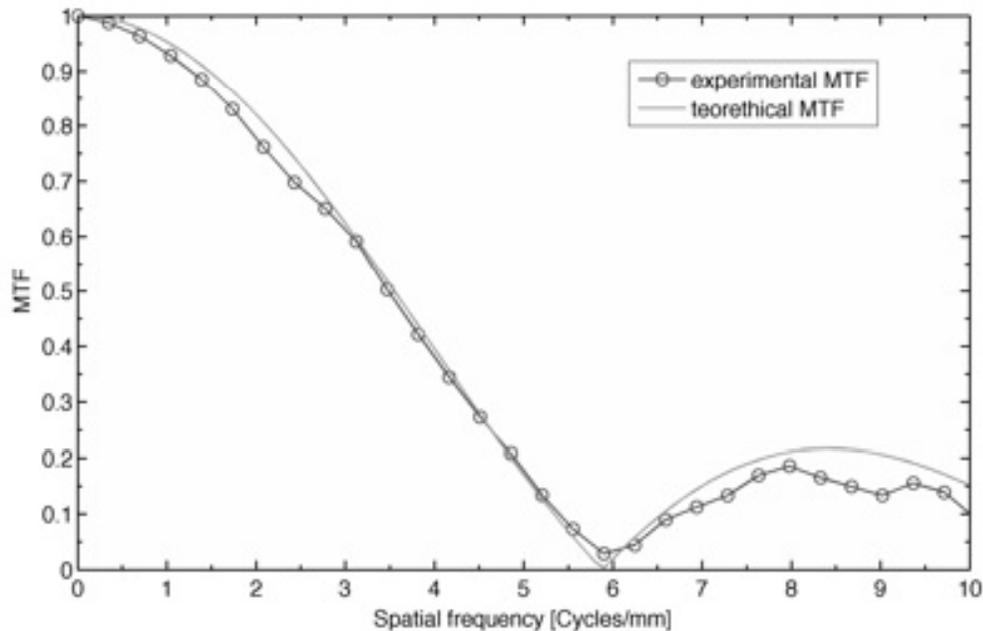
## 1. Contrast-Threshold Analysis:

• EUREF Protocol: Perry N, Broeders M, de Wolf C, Törnberg S, Holland R, von Karsa L (eds), "European Guidelines for quality assurance in breast cancer screening and diagnosis – Fourth Edition", Luxembourg (2006)

- Thickness-Threshold diagrams (CDMAM phantom)

S.R. Amendolia, Med. Phys. **36**, 4, (2009), 1330-1339

## experimental results: Presampling MTF



Experimental Presampling MTF.

maximum uncertainty = 3%

Low frequency Drop effect.

Fit with the function  $|\text{sinc}(\pi a u)|$ :

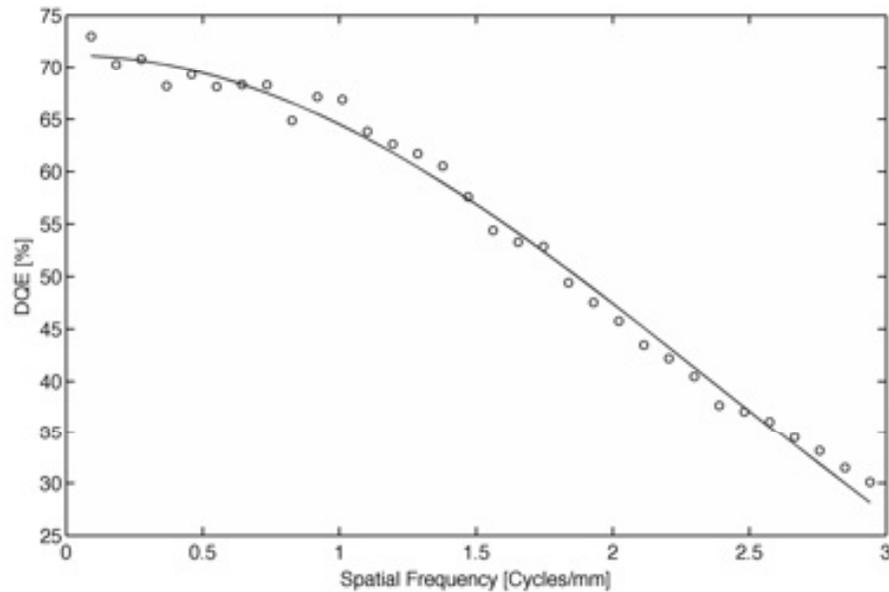
$a = 170 \mu\text{m} \pm 5 \mu\text{m}$ .

Perfect agreement with the physical pixel dimensions!!!

### Tilted edge

- Tungsten Edge: 80mm x 13mm  
70 $\mu\text{m}$  thick
- Edge angle:  $\vartheta = 3.05^\circ \pm 0.05^\circ$
- $N = 1/\tan\vartheta = 18.8 \pm 0.4$
- Oversampling distance = 9  $\mu\text{m}$

# experimental results: Detective Quantum Efficiency



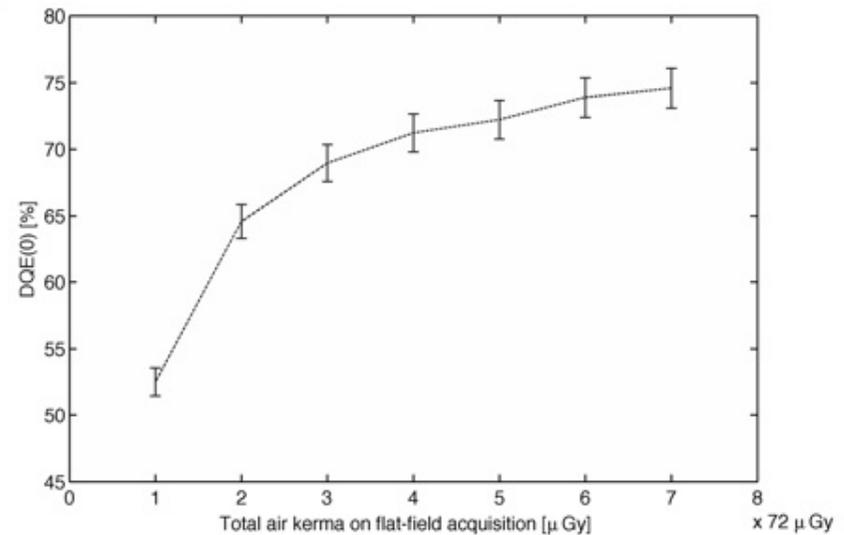
DQE(u) for a single detection unit working in stationary mode.  
a flat-field with high statistics has been used to correct the image

experimental detection efficiency

$$G = \bar{I}/\bar{q} = 74\% \pm 2\%$$

DQE(0) as a function of the incident dose on the flat-field

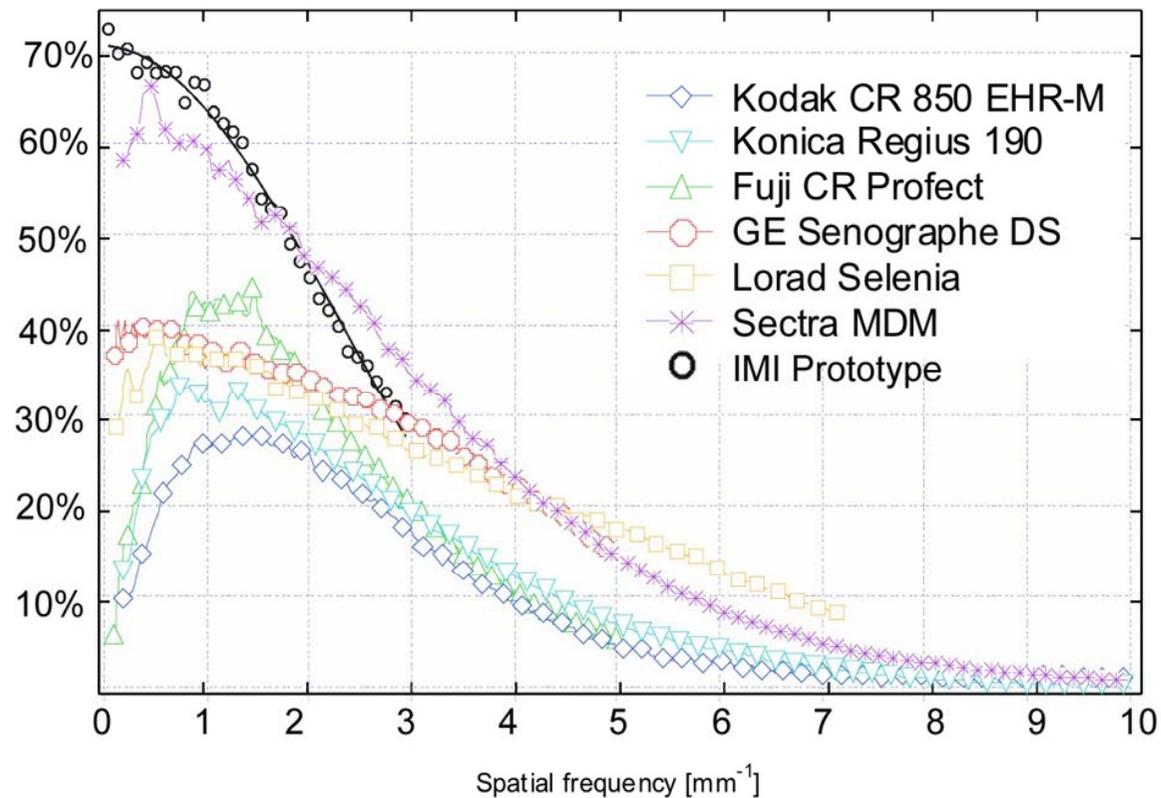
The DQE(0) grows up to the  $74\% \pm 1.6\%$



experimental results:

## Detective Quantum Efficiency

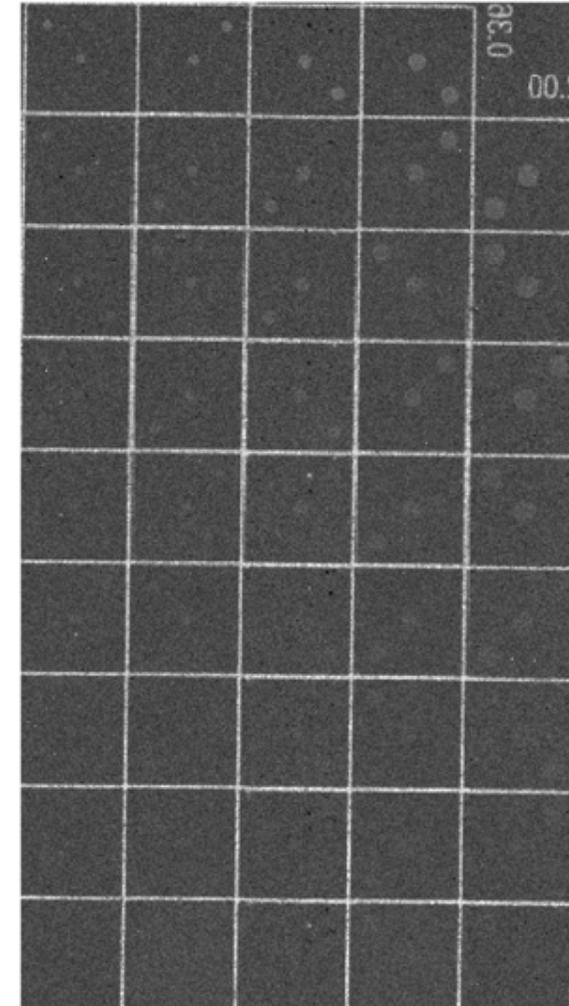
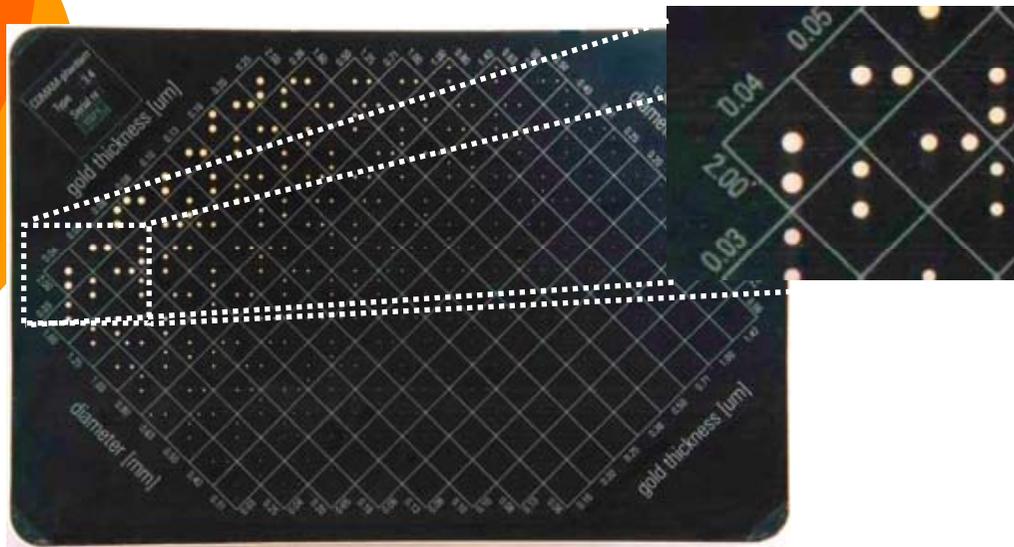
Comparison of the DQE of the IMI Prototype with the most common digital mammographic systems



\* Monnin et al. Medical Physics, March 2007, Volume 34, Issue 3, pp. 906-914

experimental results:

## Thickness-Threshold curves

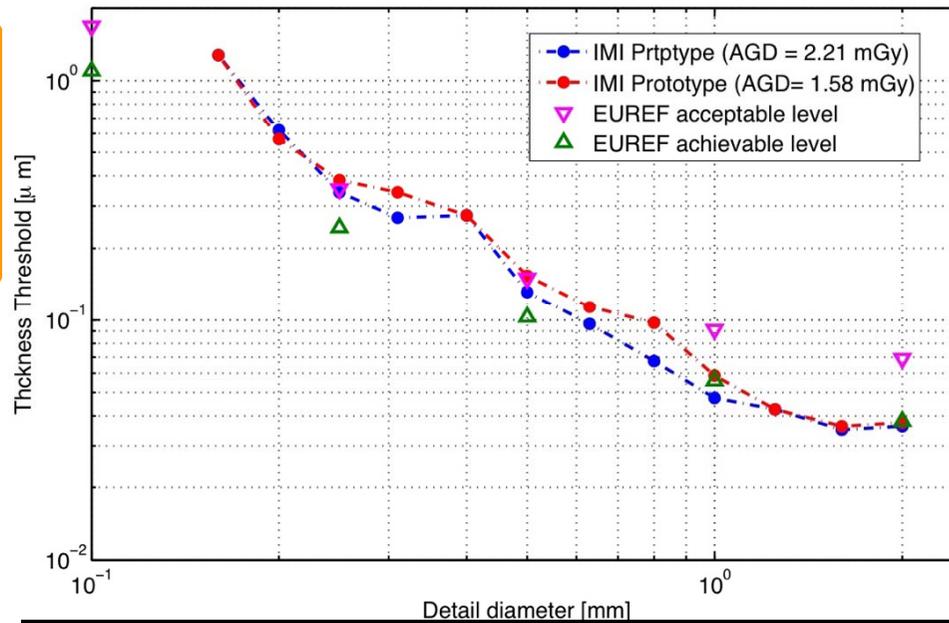


### CDMAM Phantom

aluminum base 0.05 mm thick  
gold disks (99.99% pure gold),  
with diameter and thickness in the rang:  
diameter: 0.01 mm to 2 mm  
thickness: 0.03  $\mu\text{m}$  - 2 $\mu\text{m}$   
16 x 16 rows. Each row has constant diameter  
and each columns constant thickness

experimental results:

## Thickness-Threshold curves



Thickness-Threshold for details of 1.6 mm of diameter = 35 nm of gold, corresponding to an intrinsic contrast of 0.49%

Disk diameter (mm)	EUREF Acceptable value (μm)	EUREF Achievable value (μm)	IMI Thick.-Tresh, (μm) 1.58 mGy	IMI Thick.-Tresh., (μm) 2.21 mGy
2 mm	0,069	0,038	0,0375	0,0362
1 mm	0,091	0,056	0,0588	0,0475
0.50 mm	0,15	0,103	0,1537	0,1312
0.25 mm	0,352	0,244	0,3833	0,3417
0.1 mm	1,68	1,1	-	-

# Conclusions

Transfer Functions Analysis: MTF  
DQE

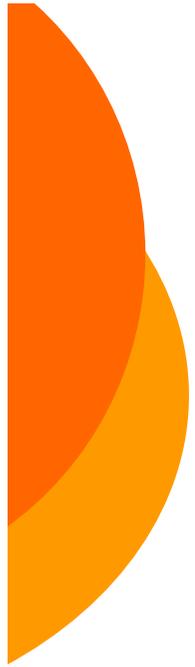
The transfer functions are in accord with the model of the ideal SPC detector

The spatial resolution is limited only by the pixel size:

The pixels are uncorrelated and there are not additive or multiplicative noise: the system is quantum limited

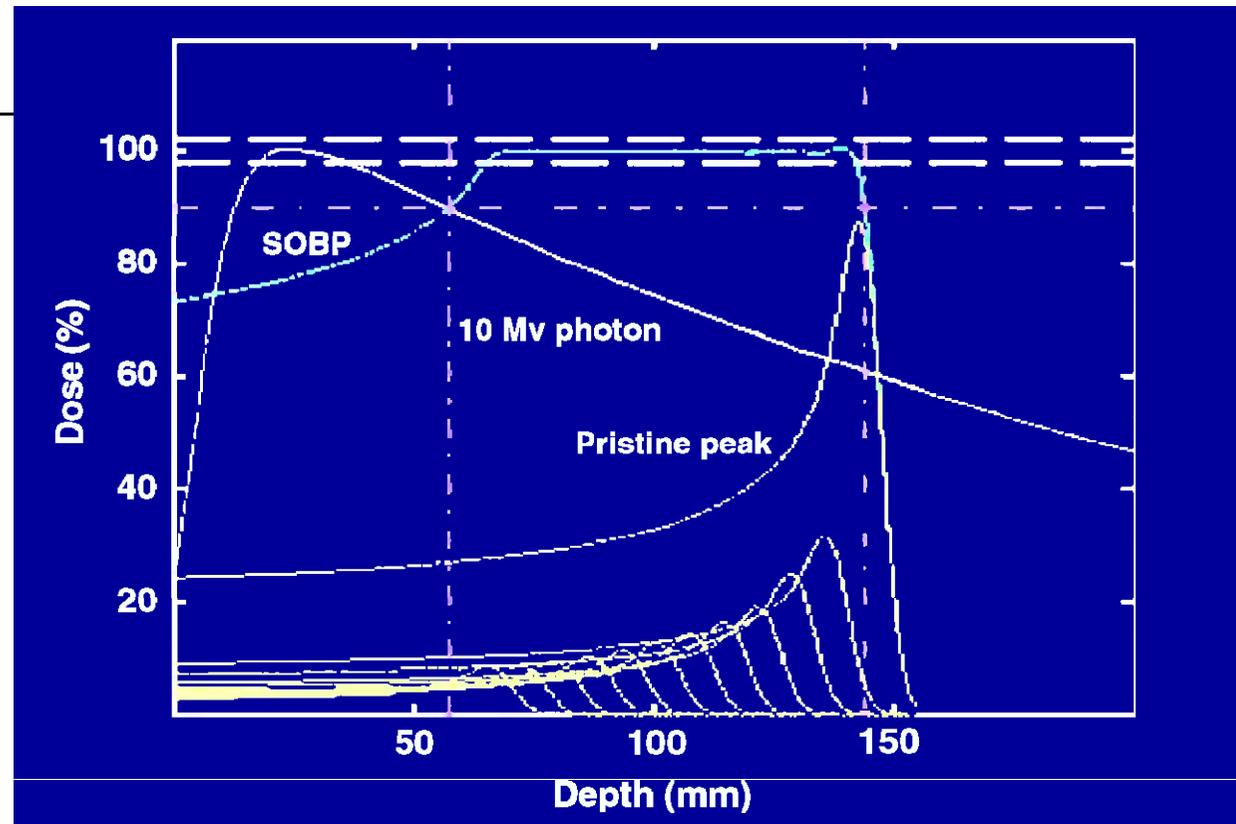
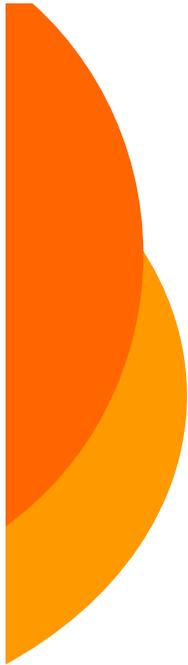
Thickness-Threshold Analysis

The system comply with the EUREF limits for details bigger than the pixel size. The system shows the best performance in the detection of detail in the range 2mm - 1mm



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*proton beam characterization*



- The tumors are still one of the main cause of death reason in Europe
- Light ion beams**, as proton, can overcome the limitations of conventional electromagnetic radiation due to the more selective energy deposition in depth.

⑩ Proton-therapy is a technique used to deliver a highly accurate and effective radiotherapy for a variety of tumor diseases.

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⑩ To characterize the proton beam an instrument able to give on-line information on the beam penumbra and the flatness will be useful.

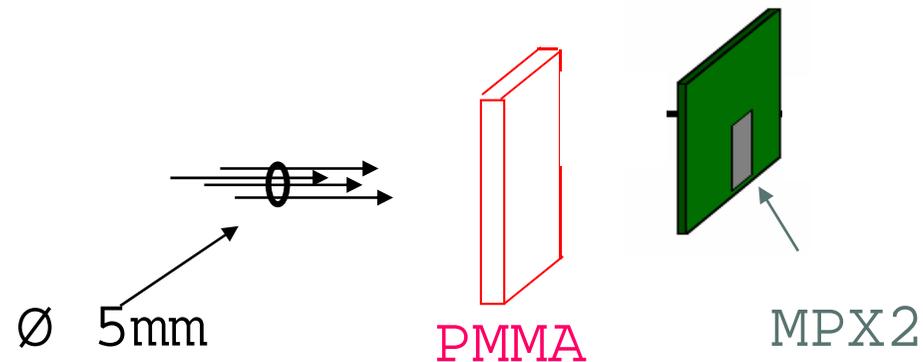
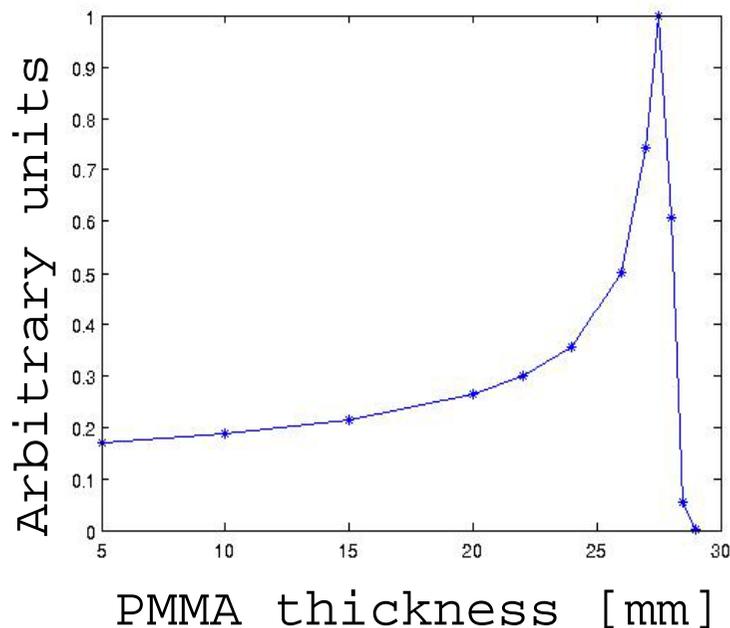
## Contents

- Monte Carlo simulations
- Experimental measurement with MPX2 system
  - broadening of the proton beams as the beam passes through a medium
  - the beam penumbra and flatness
  - the dose and dose rate of the incident proton beam

# Monte Carlo simulations:

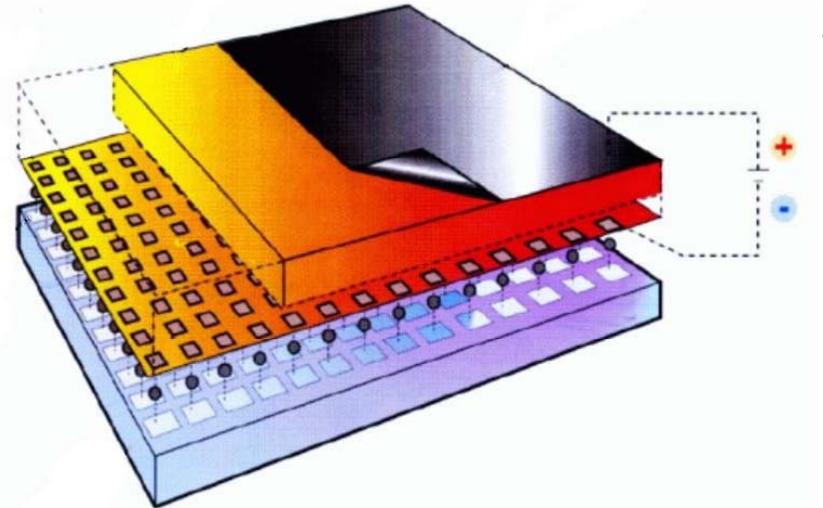
## ⑩ GEANT-4

1. - Uniform irradiation of a  $\varnothing$  5mm area with 62 MeV protons
  2. - Silicon detector 300  $\mu\text{m}$  thick
  3. - a 55  $\mu\text{m}$  mesh was superimposed to the silicon detector
- $V_{th} = 120\text{keV}$
  - different PMMA specimen as absorber



# DETECTION SYSTEM

300 $\mu$ m Si  
detector

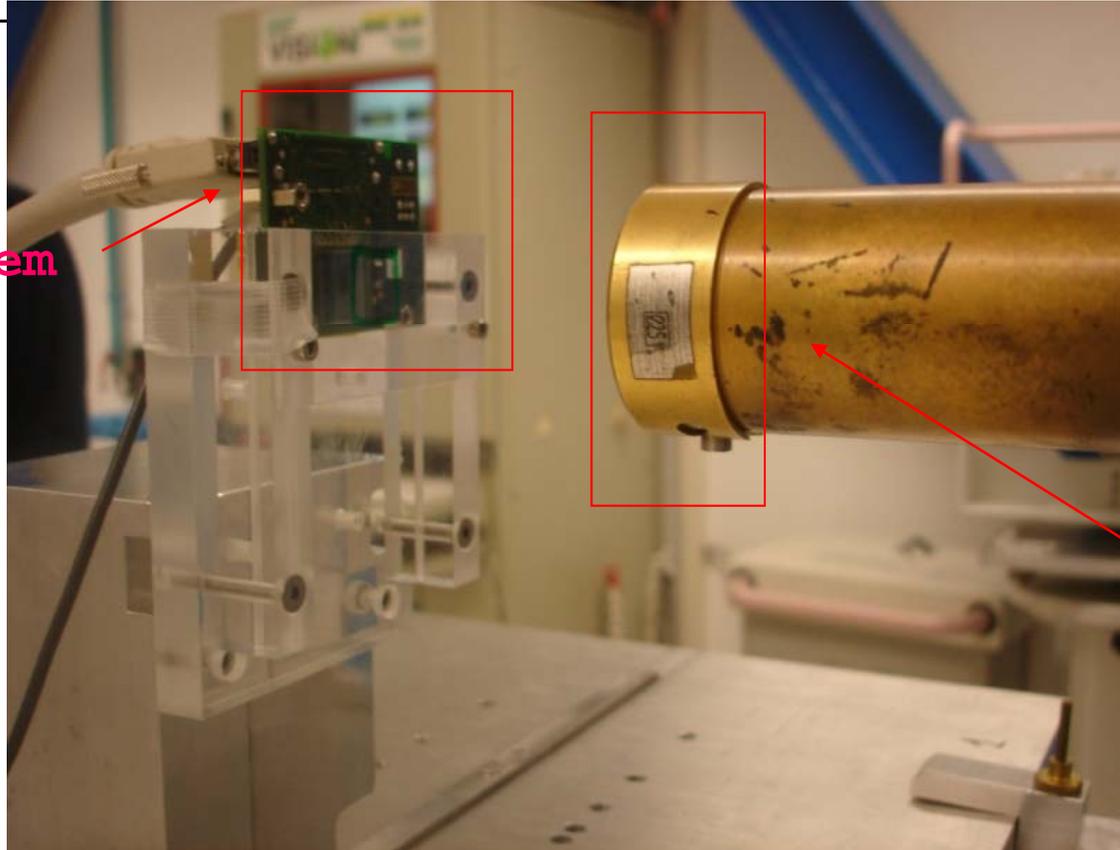


## ***MPX2 read-out chip***

- 256 x 256 square pixel matrix (size 55  $\mu$ m)
- 13 bit pixel counter
- Max. count rate per pixel 1 MHz
- Electronic noise (sigma) 105 e<sup>-</sup>
- Window threshold discriminator (low and high level)
- 8bit conf. reg. (mask, enable, 3-bit thrs. adj. per each discriminator)
- Radiation tolerance <200 krad (10 keV X-ray)

A 62 MeV low flux proton beam. Due to the small detector surface collimators were used

MPX2 system

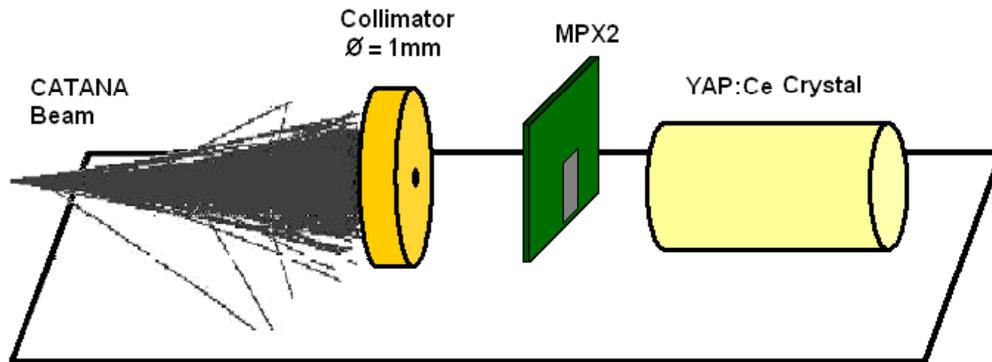


Final proton  
collimator

Ø 5mm

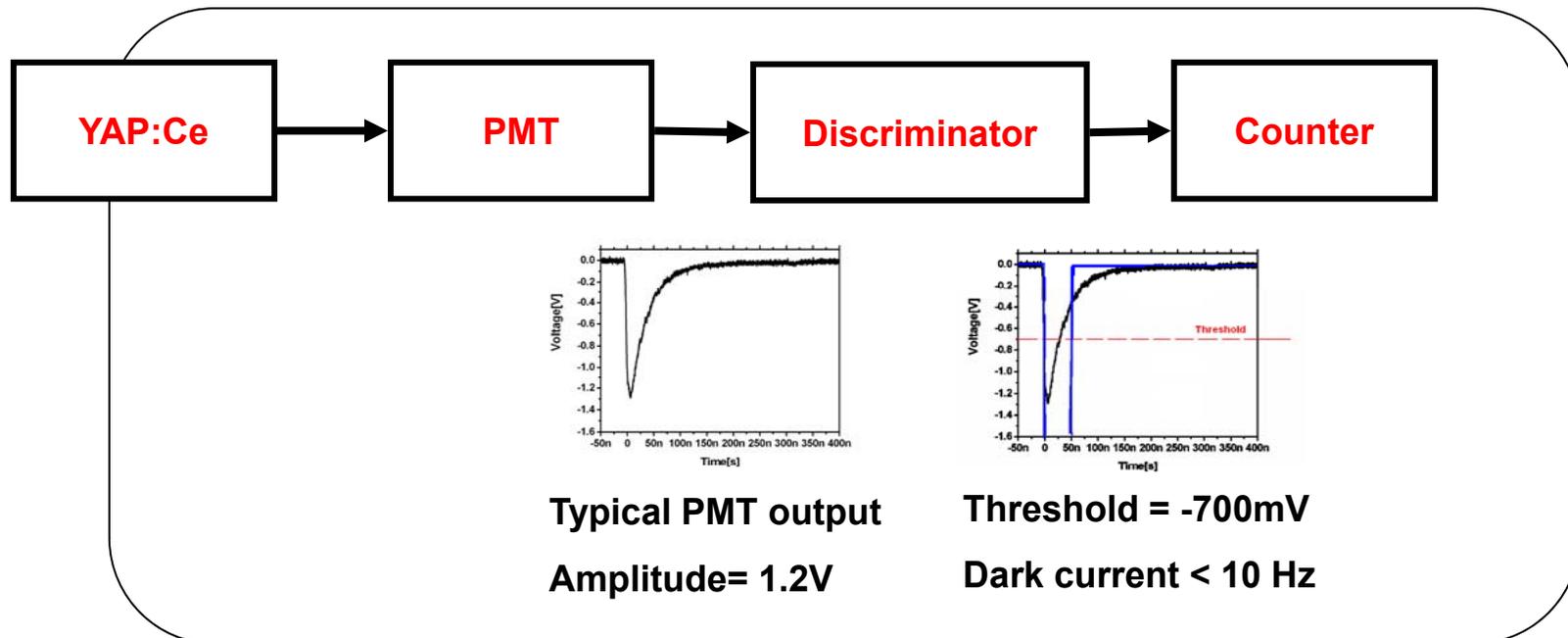
Experimental set-up @ Catana: Laboratori Nazionali del Sud- INFN Catania, Italy, where a Superconducting Cyclotron is used for the treatment of the choroidal and iris melanoma (in Italy about 300 new cases for year) with 62 MeV proton

To check the MPX2 counts , with no PMMA, a different detection system was used in cascade to our MPX2 system



<b>YAP:Ce Crystal</b>	
Length	10 cm
Diameter	2,5 cm
Time constant	30 ns
Light yield	15 10 <sup>3</sup> ph/MeV
Energy Resolution @ 60 MeV	2,6 %
Linearity (range 30-60MeV)	1%

### Data acquisition system



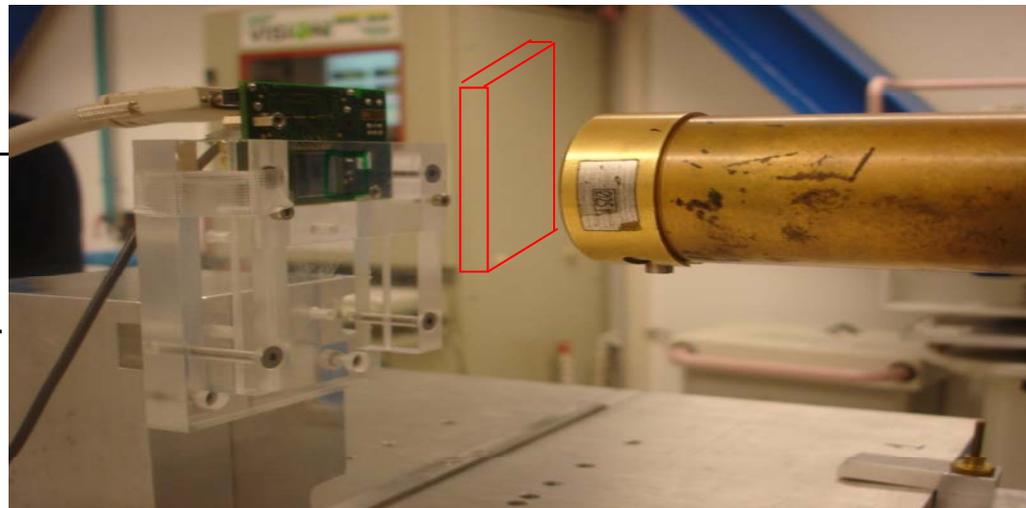


---

The two systems were operated together at a cyclotron current of 3pA, measuring the **same rate of 1.6 protons/(second\*pixel)**.

# Beam broadening

experimental beam image after several PMMA thicknesses



0 mm



5 mm



10 mm

15 mm

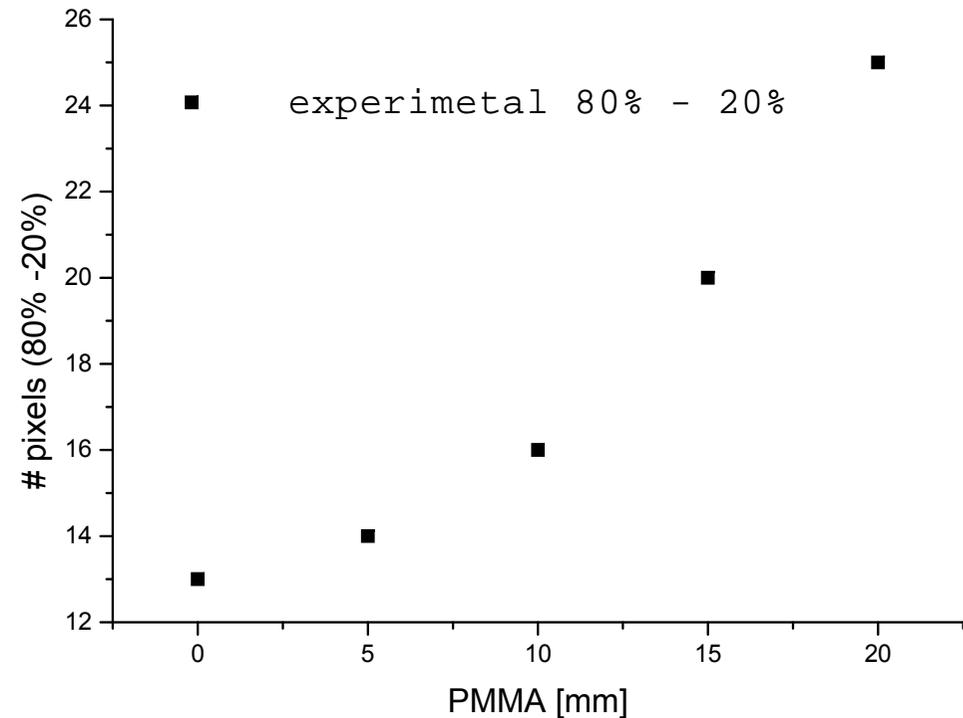
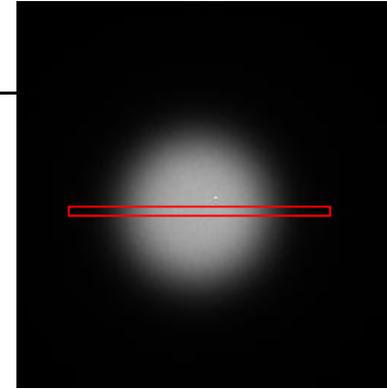
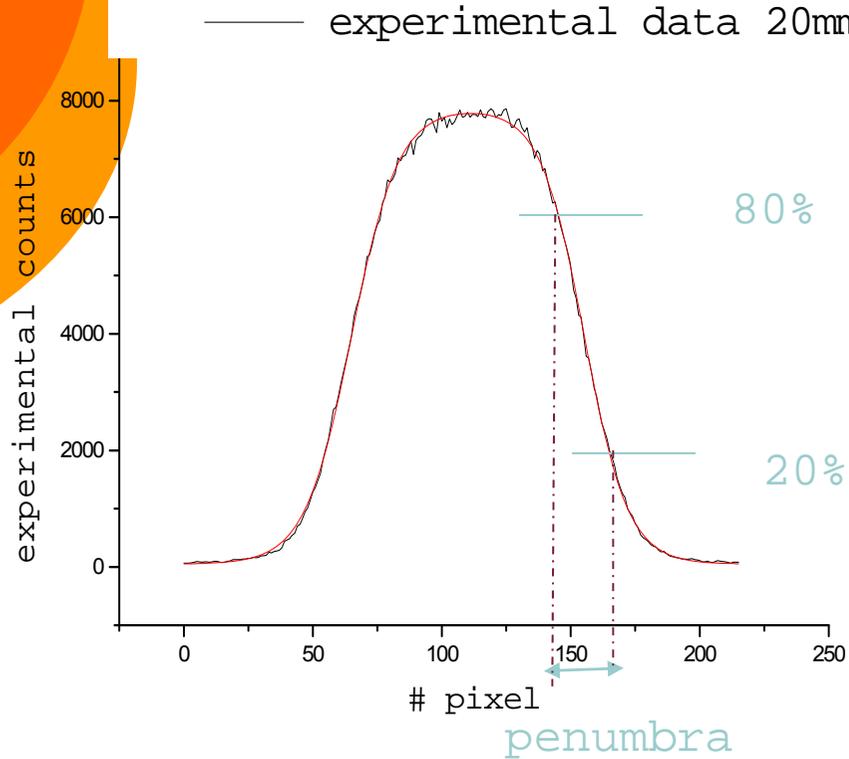
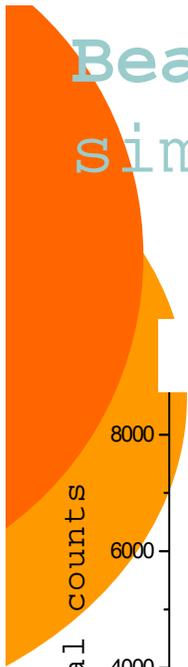
20 mm

Vth= 120 keV

Input dose 30 cGy

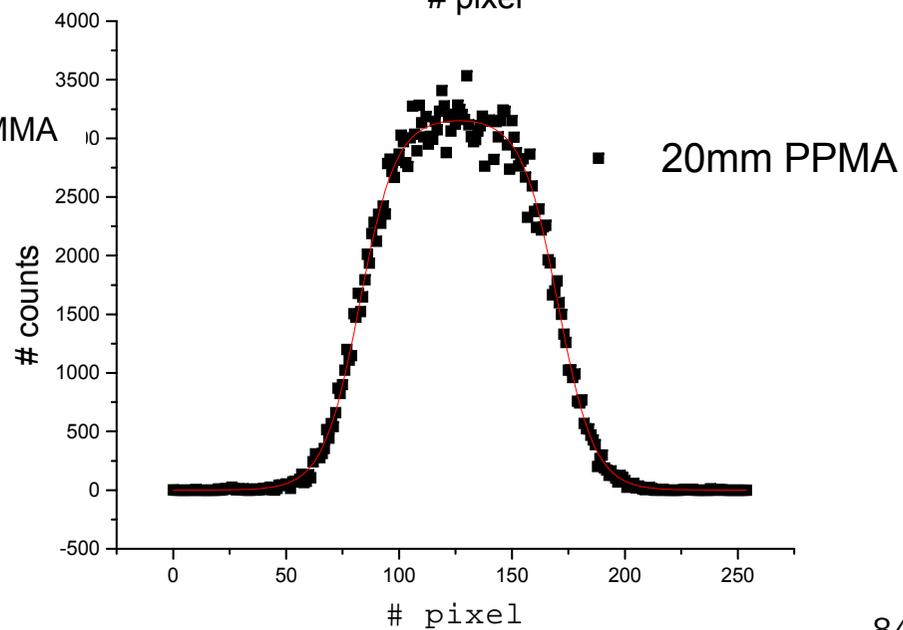
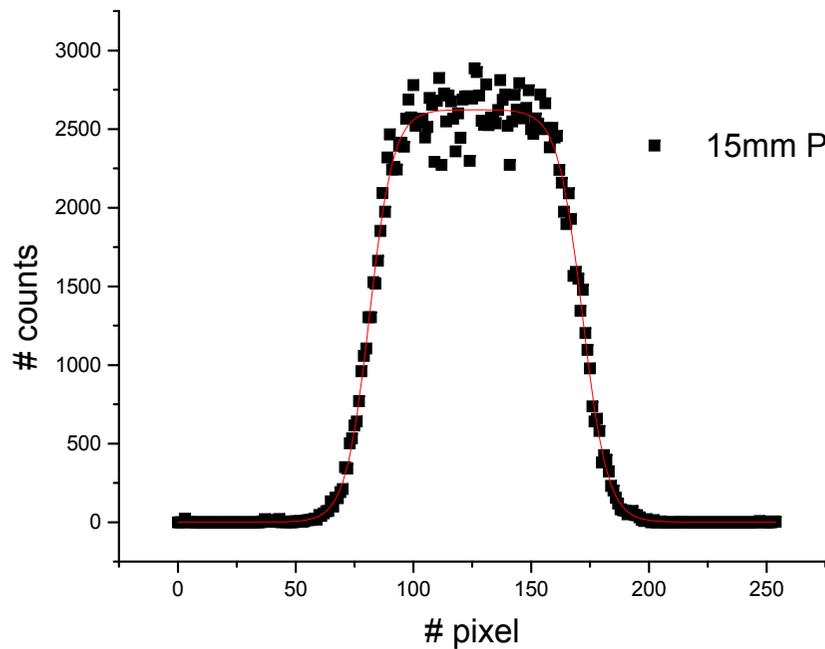
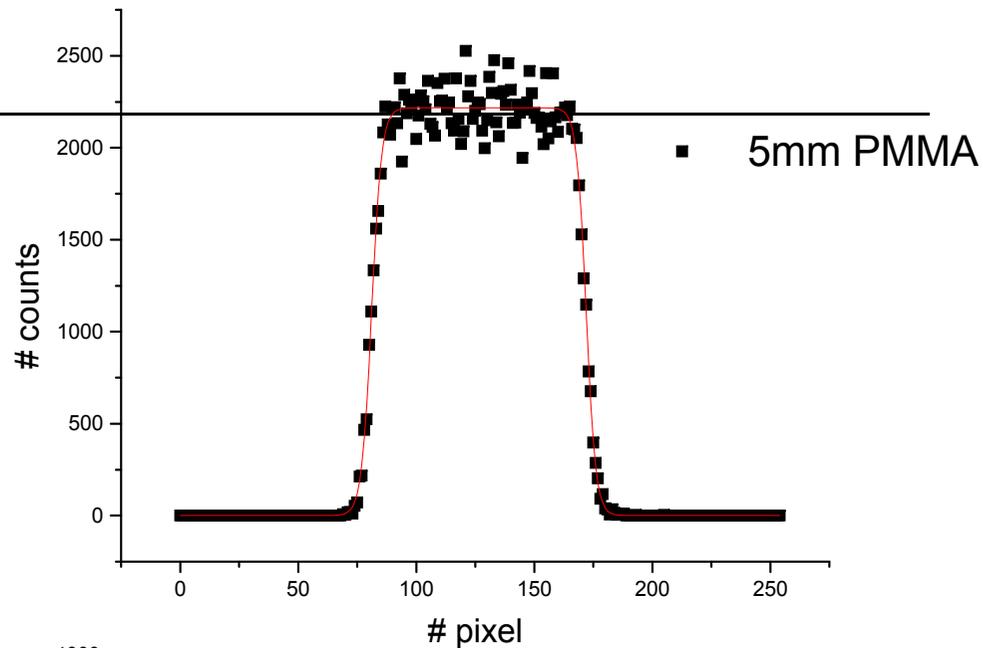
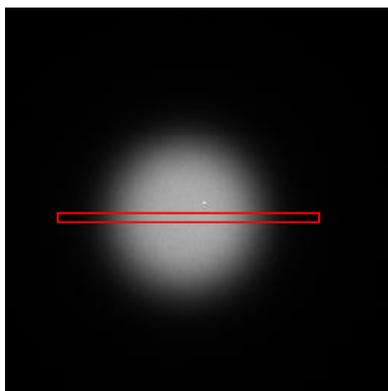
Cyclotron current of 1nA ( about a factor 6 lower than the current used during treatments)

# Beam broadening: experimental and simulated profiles



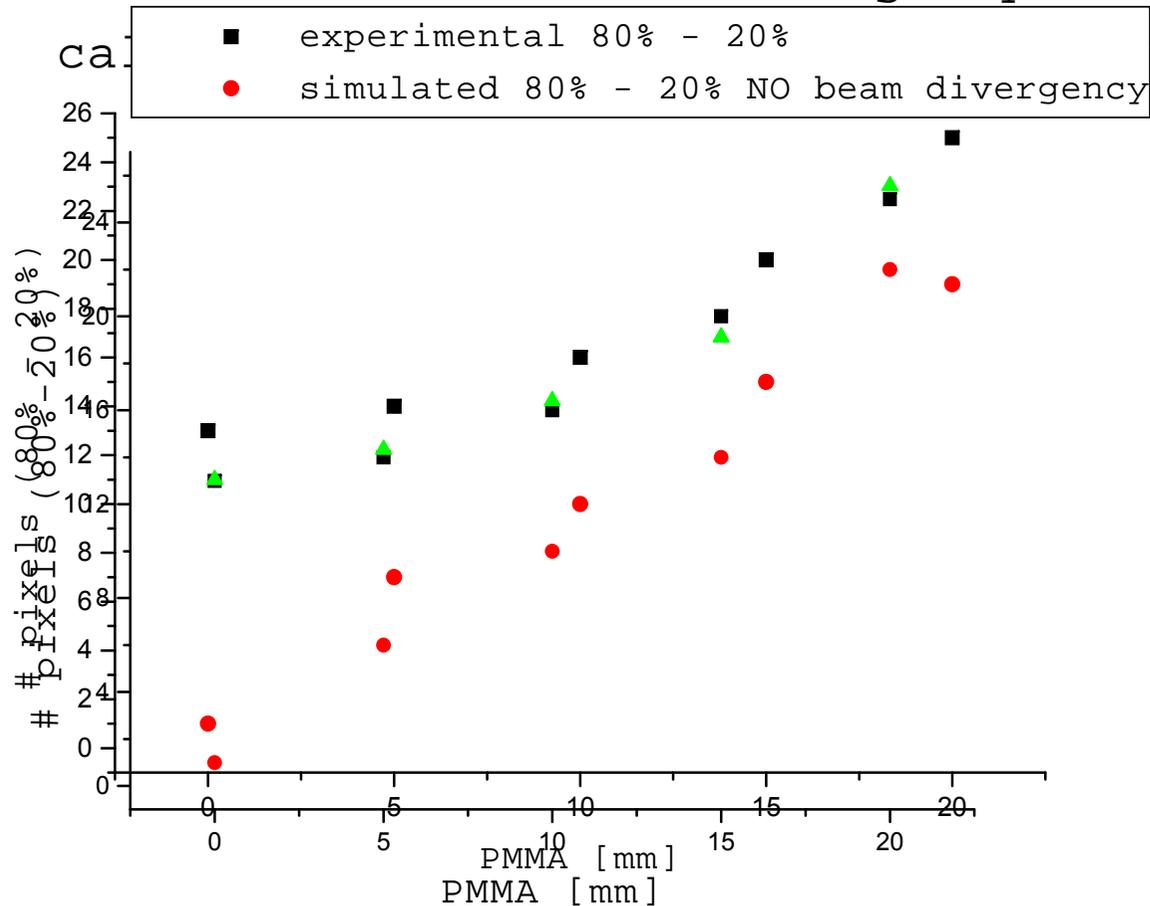
A double-Boltzman function was used to fit the rise and the fall of the profiles

# Beam broadening



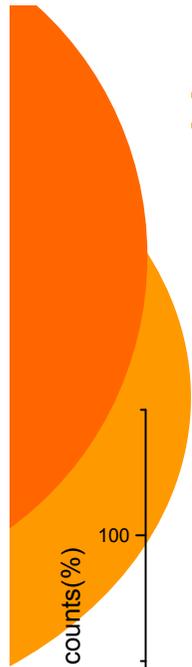
# Beam broadening: experimental and simulated penumbra

- experimental 80%-20%
- simulated 80%-20% no divergency
- ▲ simulated 80%-20% NO beam divergency

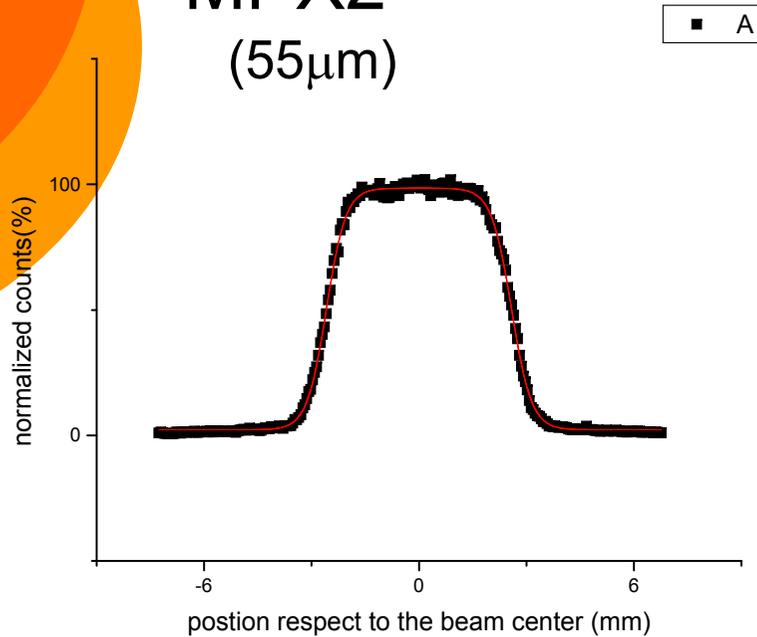


$$P_{\text{calculated}} = \sqrt{(P_{\text{exper0mm}}^2 + P_{\text{simul}}^2)}$$

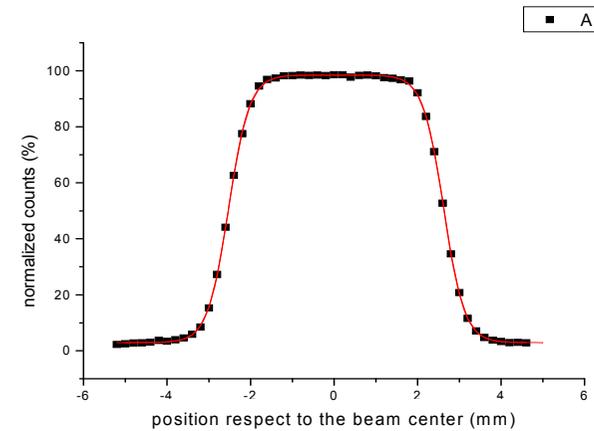
# Beam penumbra and flatness



MPX2  
(55 $\mu\text{m}$ )



Gafchromic  
(200  $\mu\text{m}$ )



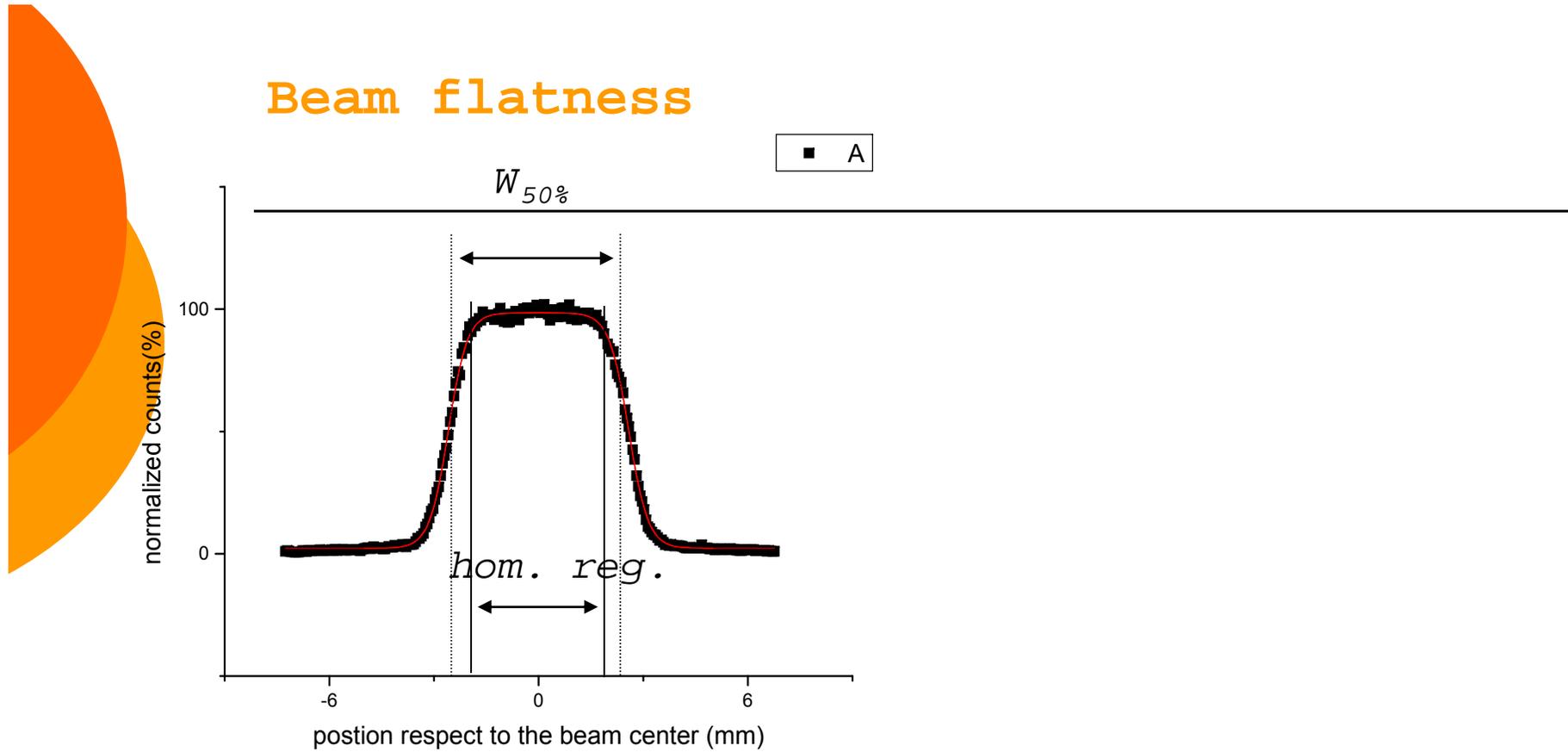
Mpx2\_penumbra\_rise = 0.79mm

Mpx2\_penumbra\_fall = 0.81mm

Gaf\_penumbra\_rise = 0.73mm

Gaf\_penumbra\_fall = 0.73mm

## Beam flatness

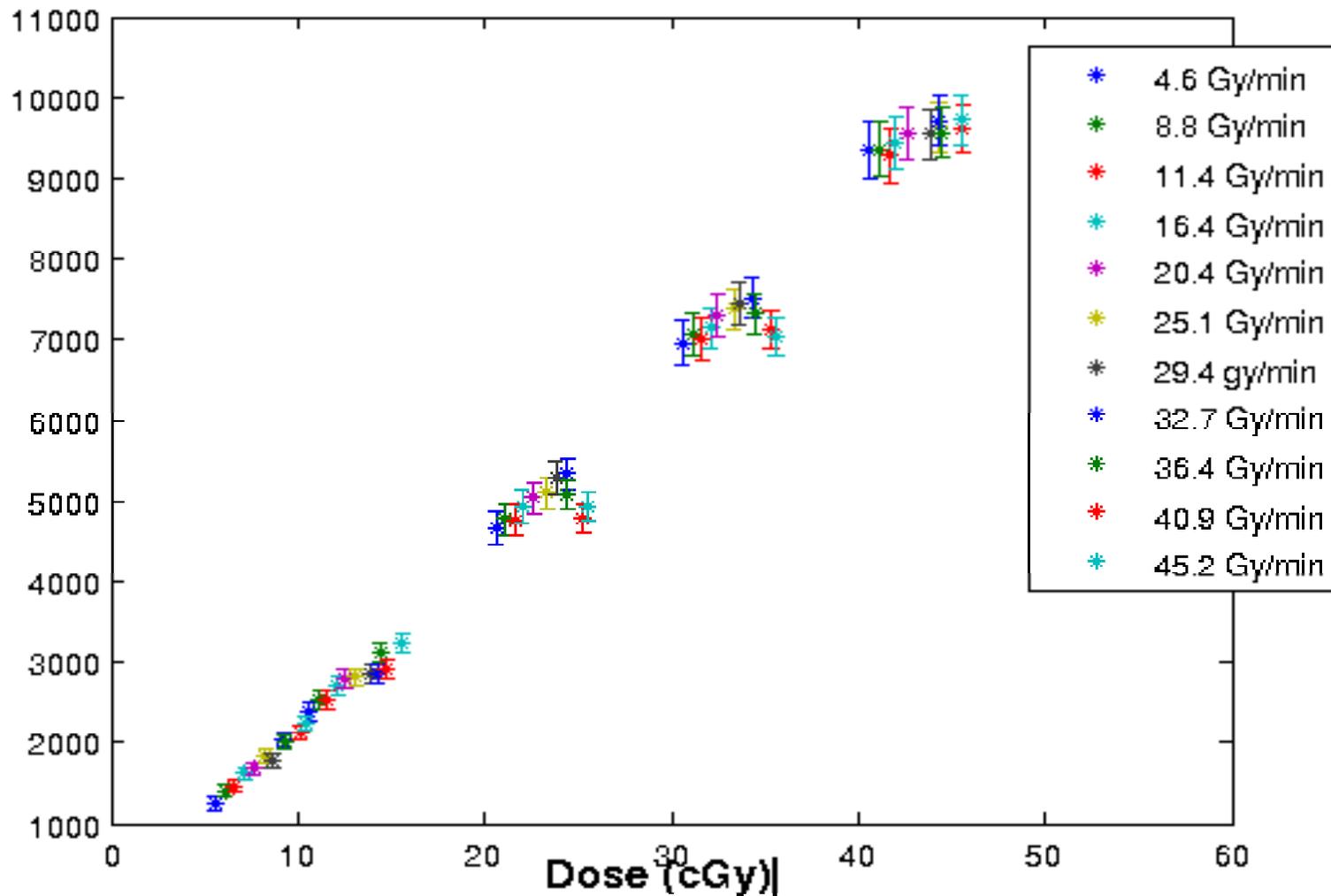


Gaf  $R_T\% = 6.3\%$

MPX2  $R_T\% = 6.3\%$

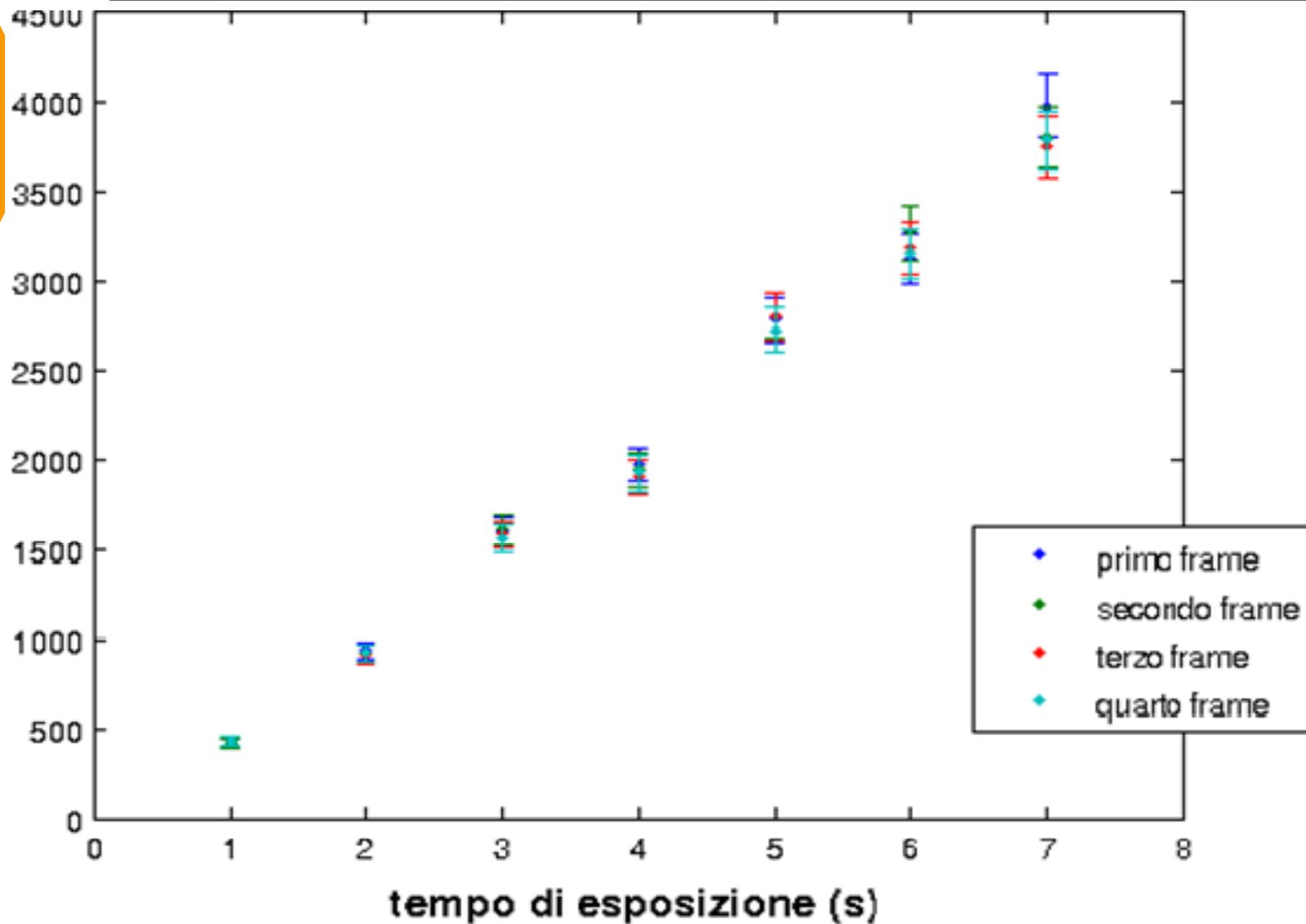
$$R_T \% = \frac{P_{\max} - P_{\min}}{P_{\max} + P_{\min}} \times 100\%$$

Count rate as a function of the dose for different dose rates



**Linear and independent on the dose rate up to 35 Gy/min**  
**Clinical dose rate 15 Gy/min**

*Count rate as a function of the exposure time and reproducibility*





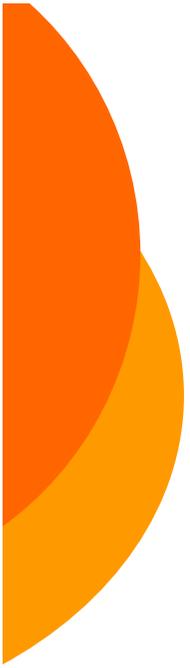
## Conclusions

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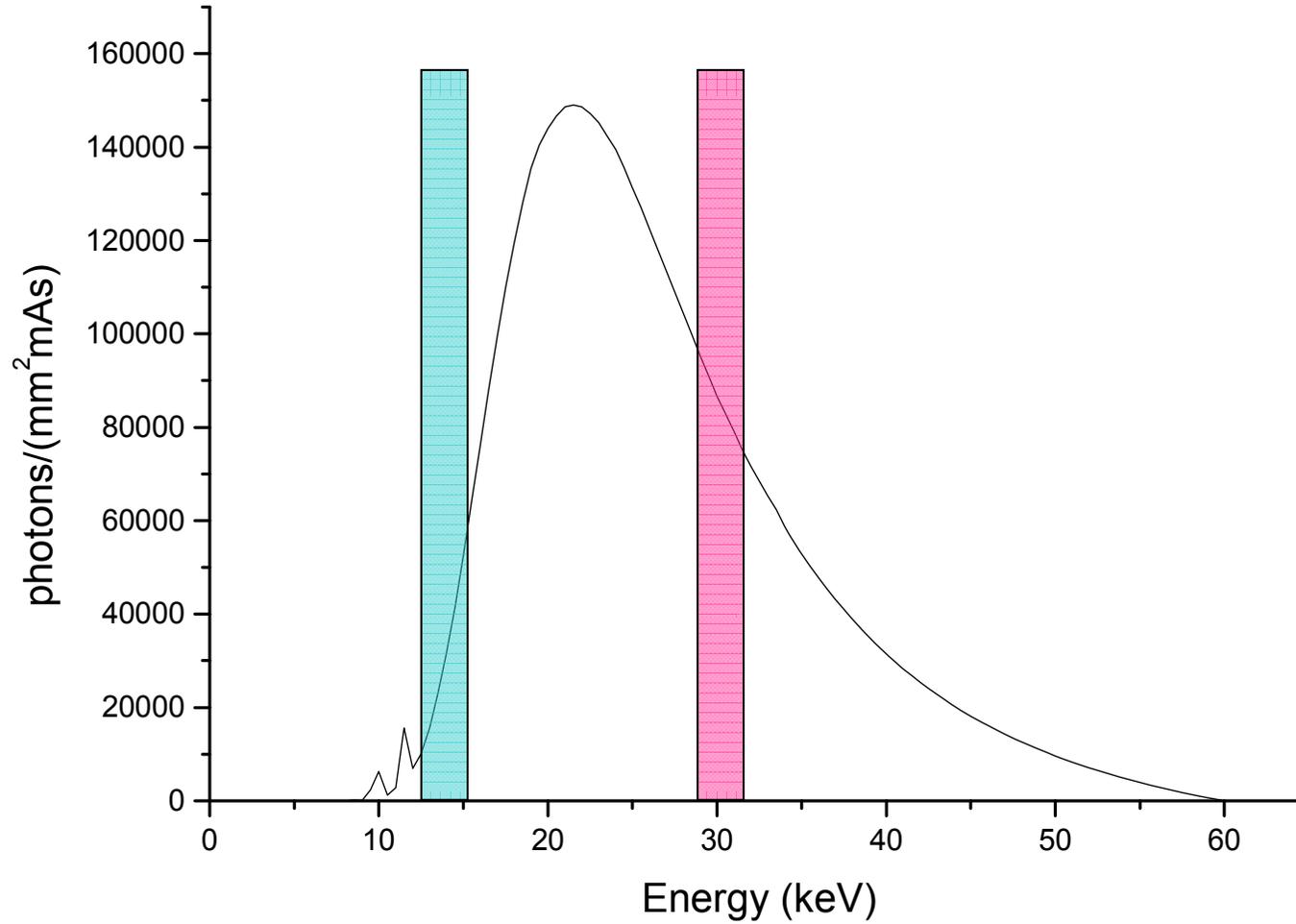
MPX2 can measure the beam characteristics on-line: very good agreement with reference systems measurements

Linearity as a function of the dose, independence on the dose rate above clinical dose rates and reproducibility of the measurements have been assessed.

The proposed detection system can be suitably applied in the monitoring and characterization of the beam and of the dose in hadrontherapy and it can be considered as a valid alternative to the systems currently used for the beam characterization.



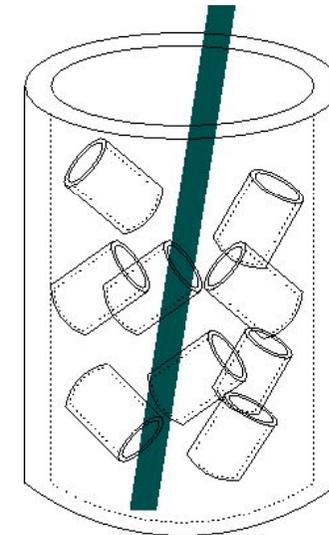
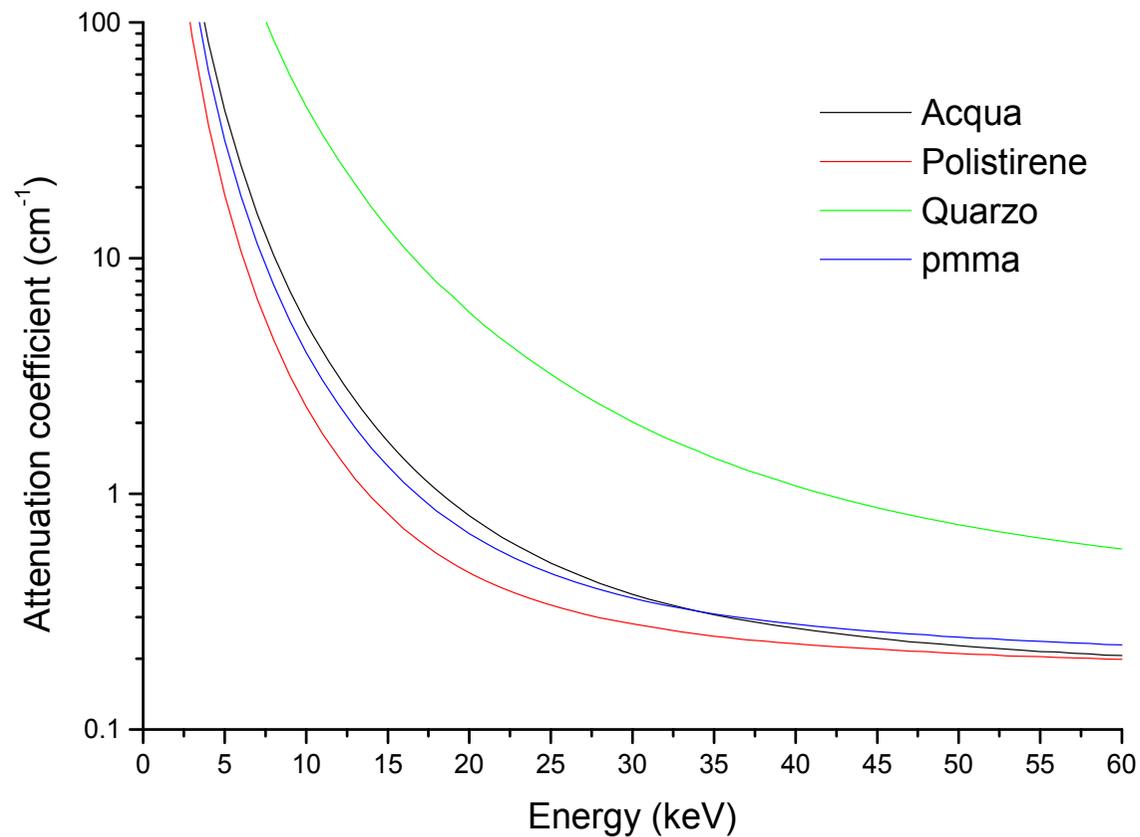
# Spettro energetico

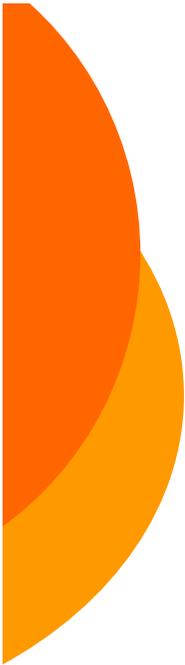


\_\_\_\_\_

# Fantoccio

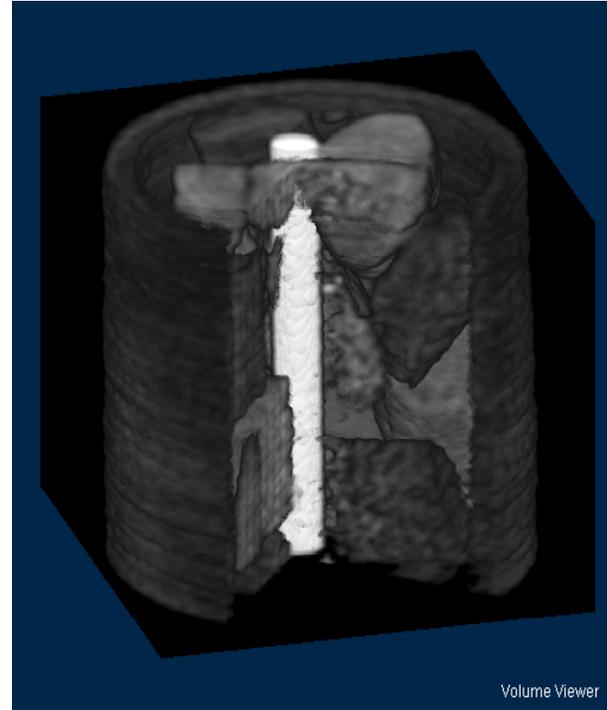
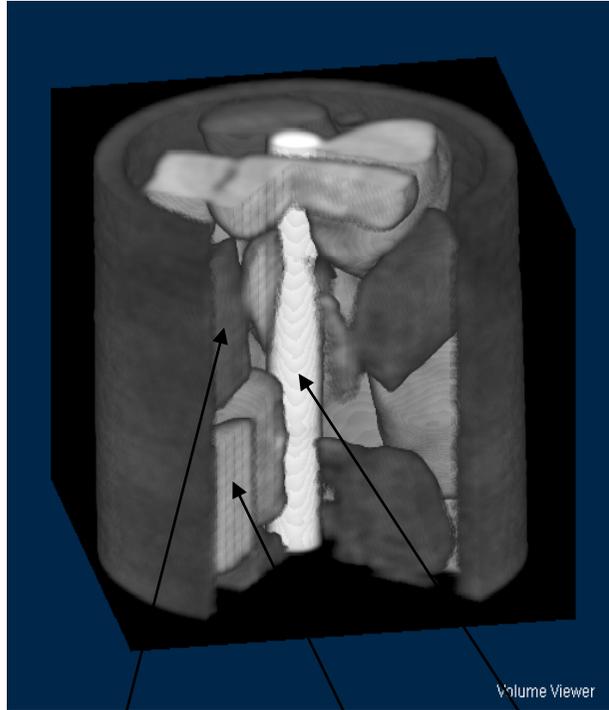
- Cilindro di plastica  $\varnothing = 1$  cm riempito con:
- Polistirene: pezzi  $\sim 3$  mm<sup>3</sup>;
- PMMA: pezzi ottenuti da rod  $\varnothing = 3$  mm
- Quarzo: rod  $\varnothing = 1$  mm



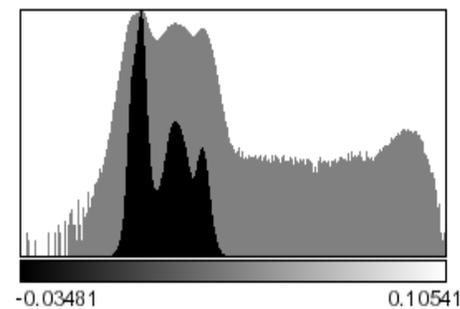
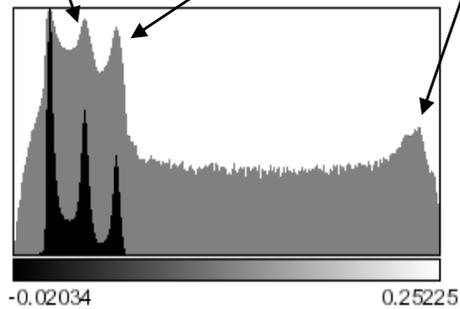


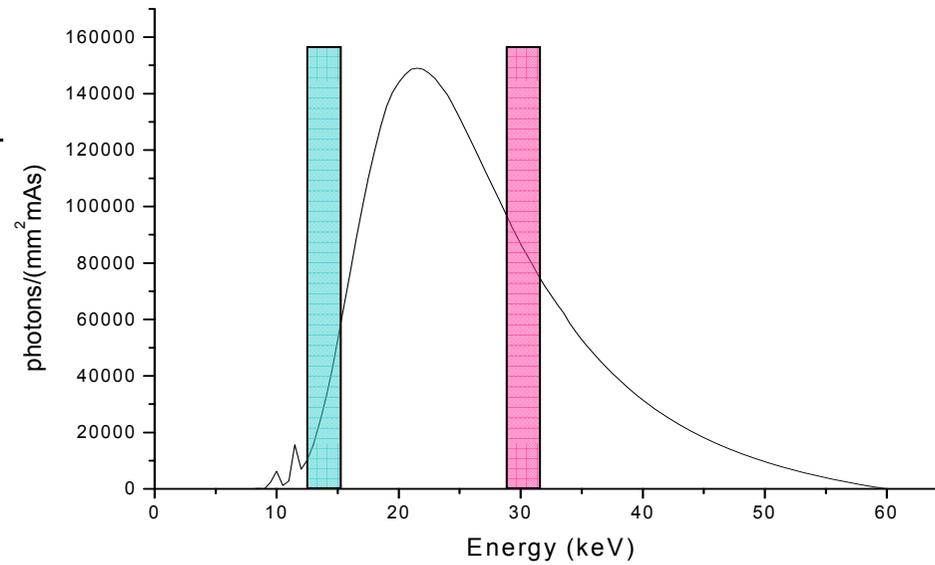
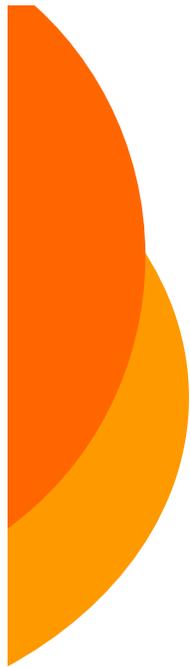
12.1-15.3 keV

26.7-30.1 keV

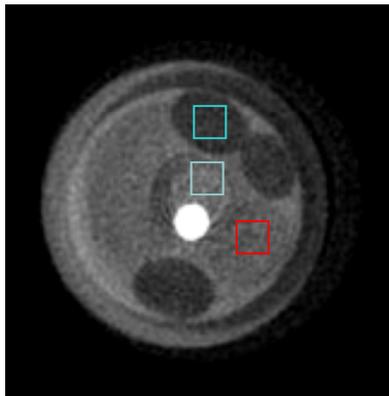


Polystyrene Polyethylene  
Terephthalate Silicon dioxide



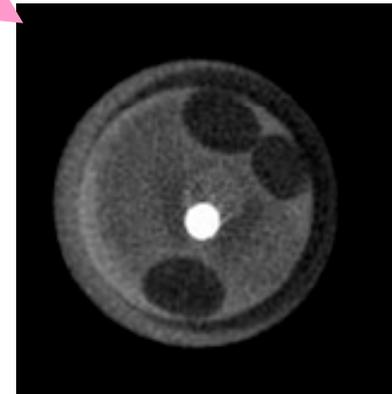


$\langle E \rangle = 13.21 \text{ keV}$



$Cps = 34.4 \pm 0.2 \%$   
 $Cpmma = 11.5 \pm 0.2 \%$

$\langle E \rangle = 27.01 \text{ keV}$



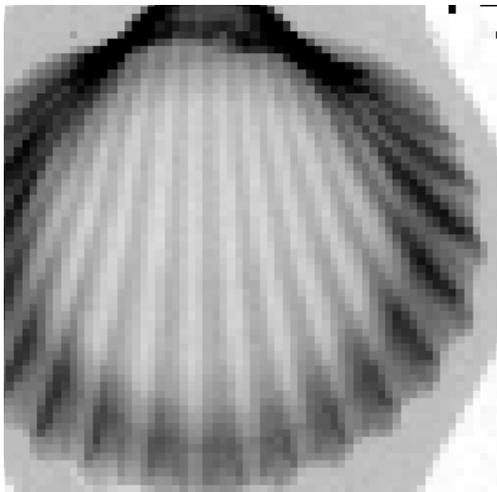
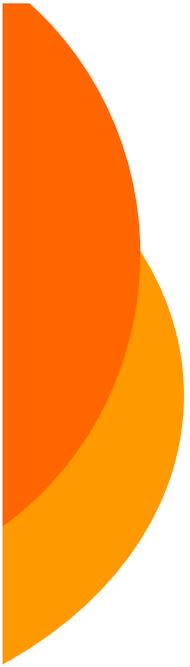
$Cps = 28.6 \pm 0.1 \%$   
 $Cpmma = 8.2 \pm 0.2 \%$



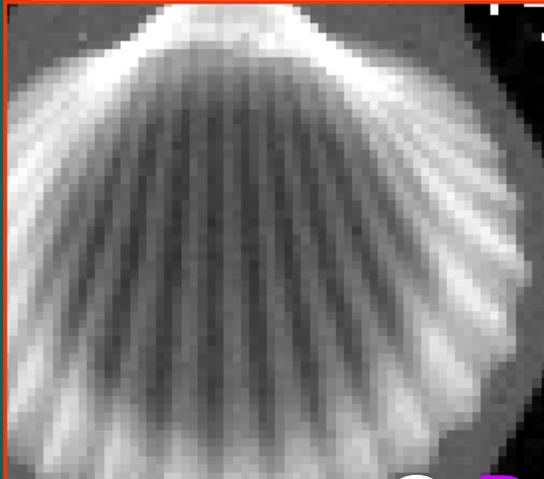
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*We have shown the good energy selection capability of our detection system also in CT applications: the SNR has a different maximum in energy for different thickness materials. For example for 3.1 mm Al thickness the SNR in the range 18.7-21.9 keV is 1.2 times the corresponding value for the whole spectrum. This improvement in SNR will lead to a better detectability of low contrast details as shown in the images below.*

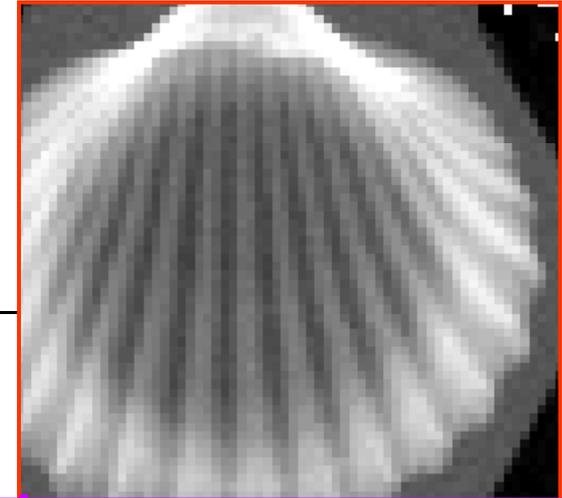
*This study is preliminary for a future development of a dual-energy CT that could add functional information to the morphological information that is obtained in a CT examination.*



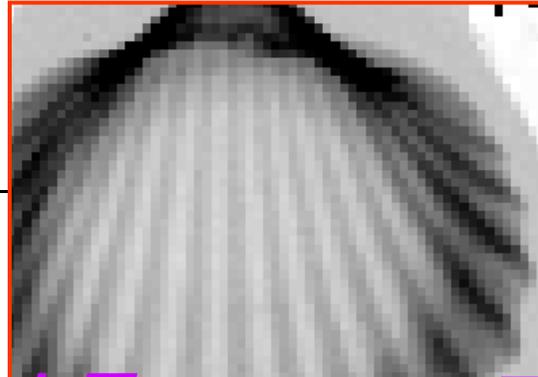
*High energy image*



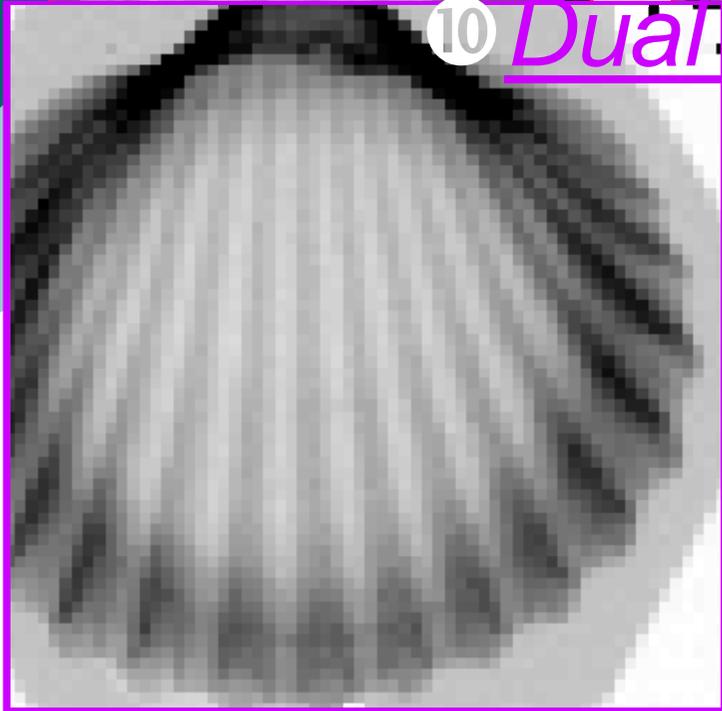
*Low energy image*



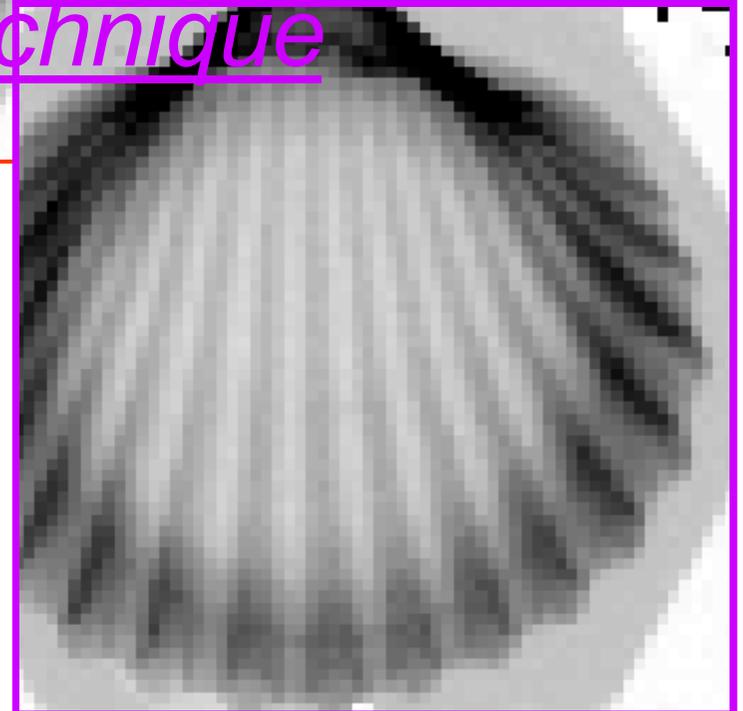
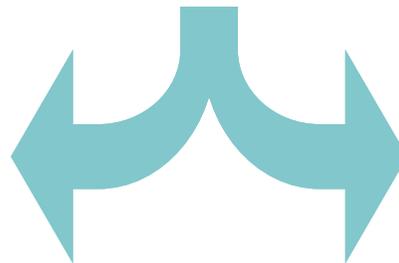
*Synthesized image*



10 *Dual Energy technique*



*Press a key  
Different angle  
projection*



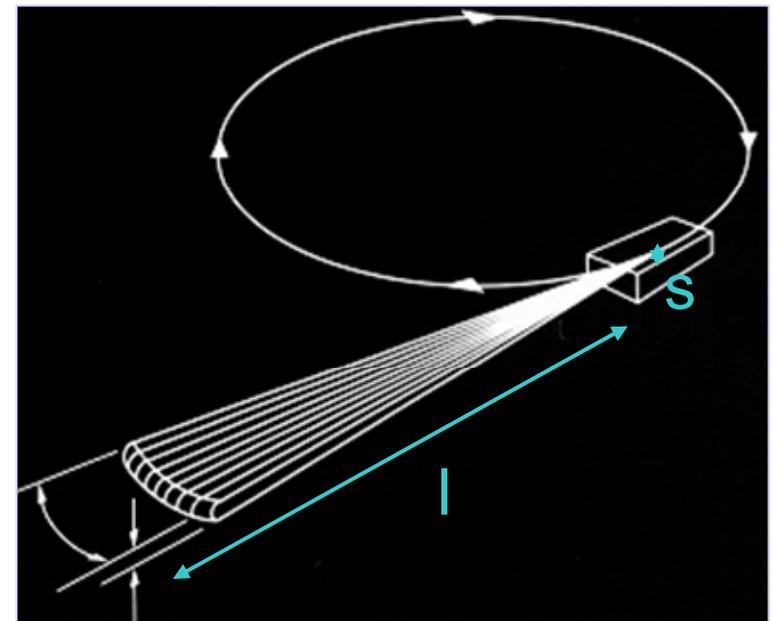
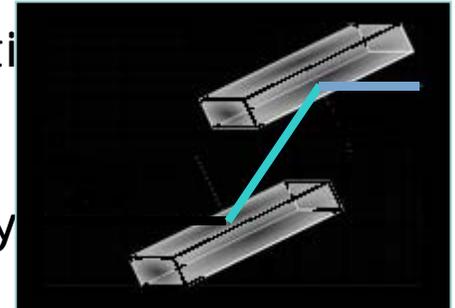


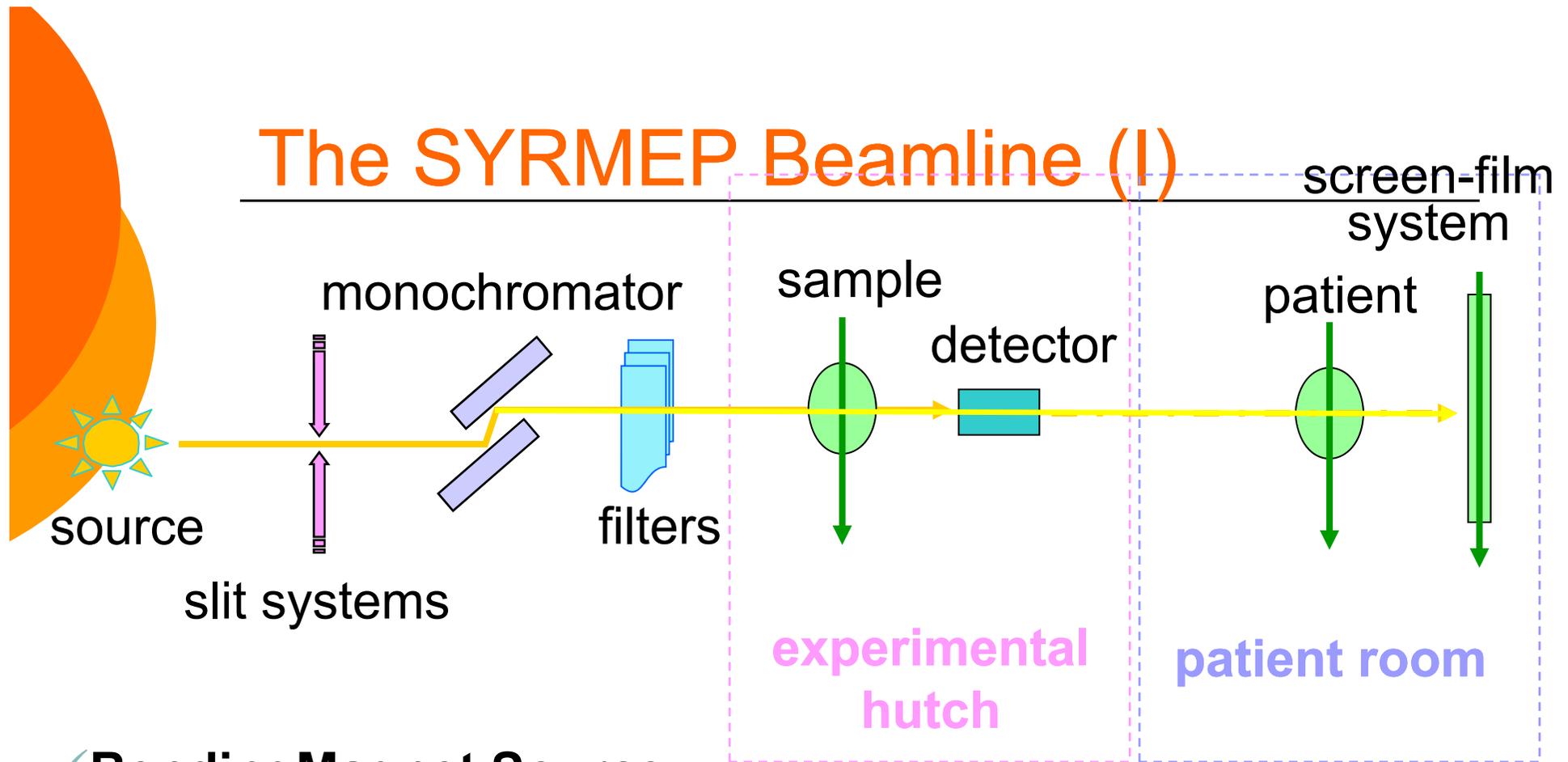
# Imaging con raggi X da luce di sincrotrone: metodi e applicazioni

Renata Longo  
University of Trieste & INFN  
Italy

# Characteristics of synchrotron radiation (SR)

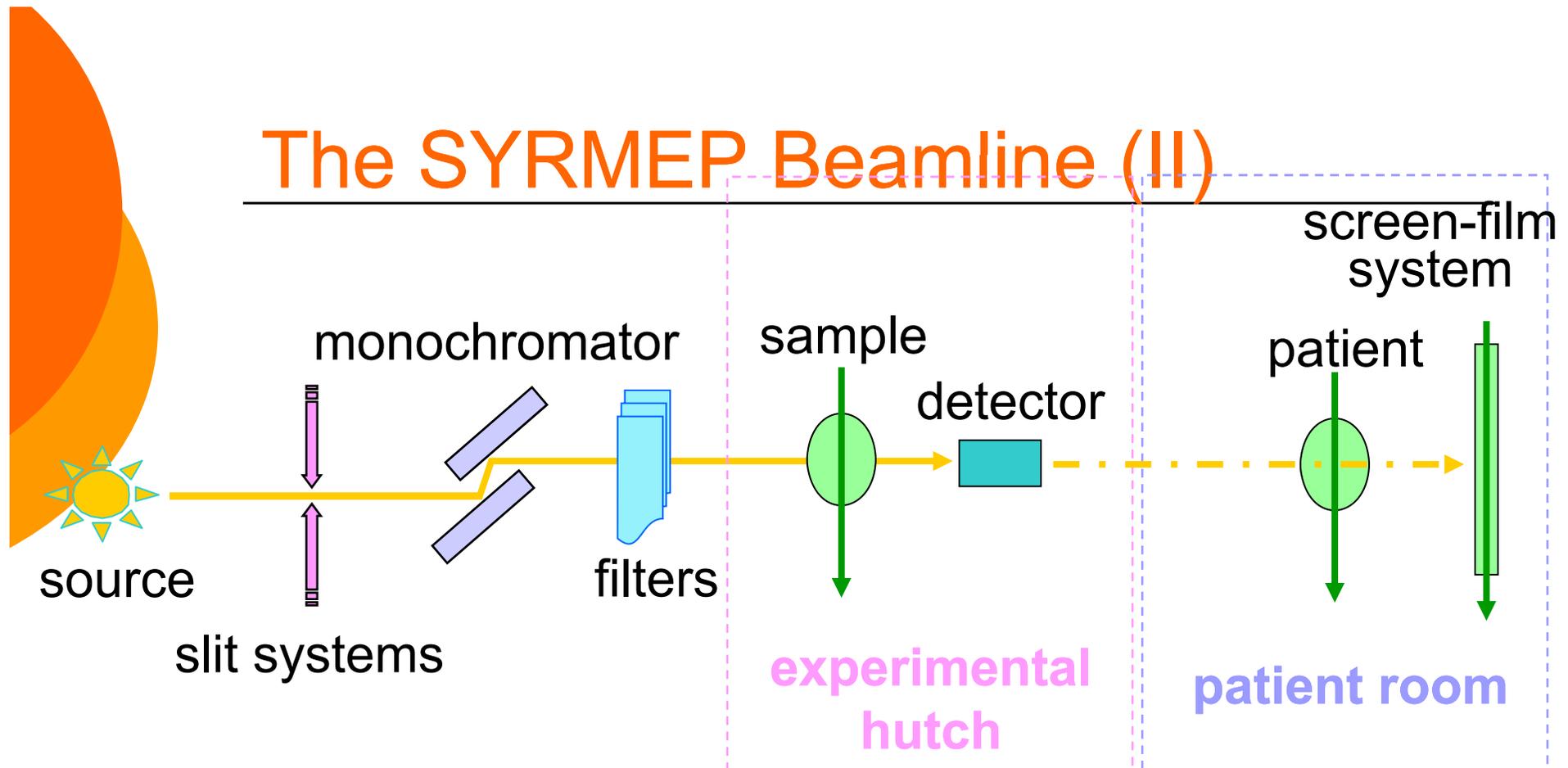
- High x-ray intensity on a broad energy range
  - Tunable monochromatic beam
  - Choose the optimum energy for a specific examination
  - Dose optimization/reduction
  - Allow double energy subtraction techniques
  - No beam hardening effects or artifacts (tomography)
- Laminar beam geometry: the beam is naturally collimated
  - Images are acquired by scanning the object through the fan beam
  - High scattering rejection
- Small source size and large source-to-sample distance
  - High degree of lateral coherence
  - Phase contrast (PhC) imaging





- ✓ **Bending Magnet Source**
- ✓ **Source size ~ 1.1 (horizontal) x 0.1 (vertical) mm<sup>2</sup>**
- ✓ **Monochromatic beam with tuneable energy (8.5 - 35 keV)**
- ✓ **Bandwidth:  $\Delta\lambda/\lambda \sim 2 \times 10^{-3}$**
- ✓ **Divergence: ~ 7 mrad (horizontal) x 0.2 mrad (vertical)**

# The SYRMEP Beamline (II)



• **Source-to-Sampled distance:** ~ 23 m ~ 32 m

Laminar beam cross section 4x 150 mm<sup>2</sup> 4x 210 mm<sup>2</sup>

• Flux available at 17 keV (Elettra operated at 2.4 GeV, 140 mA ring current): 6 10<sup>8</sup> ph/mm<sup>2</sup>/s 2 10<sup>8</sup> ph/mm<sup>2</sup>/s  
length at 17 keV ( $L_c = \lambda R_1 / 2s$ )

• 8 μm 11 μm

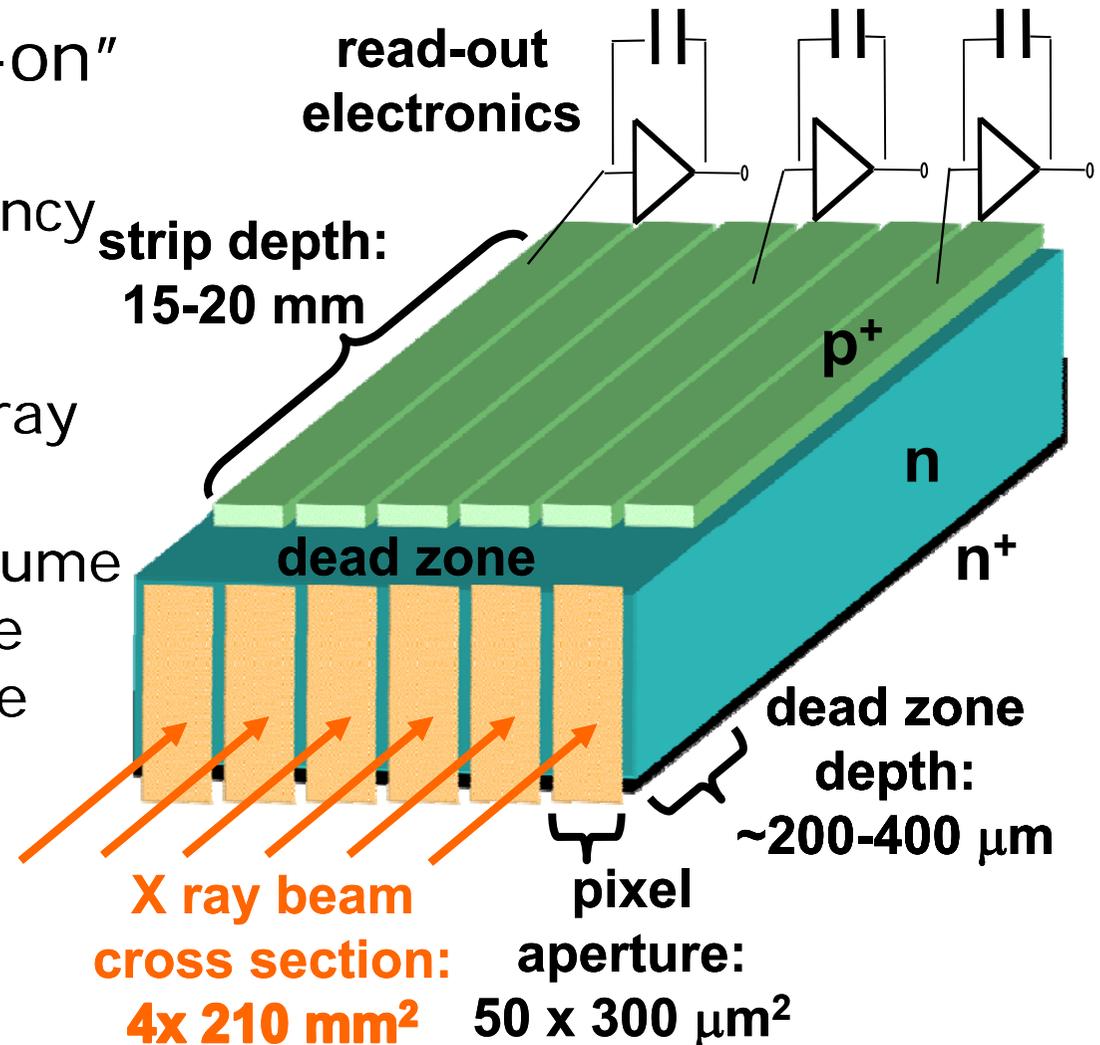
# PICASSO Detector Requirements

- Laminar geometry
  - Matching beam cross section
    - 21 cm
  - Scatter Rejection
- High efficiency
  - Low dose
- High spatial/contrast resolution
- Wide dynamic range
  - Detect both high and low contrast
- Fast Rate Capabilities and Read-Out
  - Image acquisition in a few seconds



# The SI microstrip detector: “edge-on” geometry

- Advantages of “edge-on” geometry:
  - High absorption efficiency
  - Matching the laminar geometry of the beam with a natural pixel array
- Problems:
  - Dead (undepleted) volume in front of the sensitive region that reduces the detection efficiency (~70-85% @20keV)



# Single Photon counting

- Each strip is bonded to a channel of the read-out electronics. Each channel features:

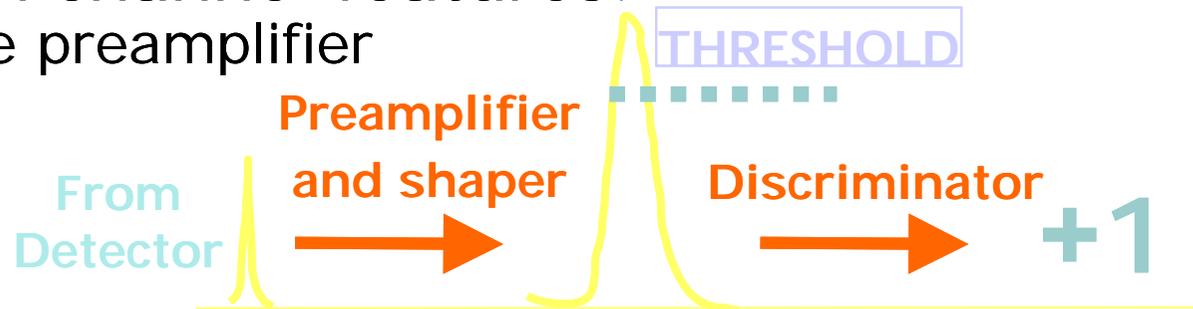
- Charge sensitive preamplifier
- Shaper
- Discriminator
- Counter

- Advantages

- The quantum nature of the information carried by the photon beam is preserved
- High (virtually infinite) dynamic range

- Challenges

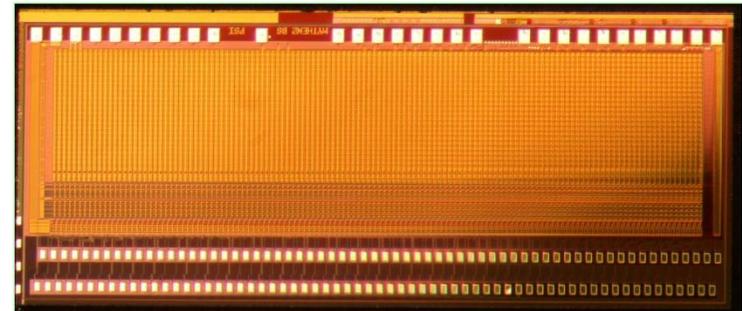
- Can we have a uniform response over all channels?
- Can we have a low noise AND high acquisition speed (~MHz)?
- Can we have all channels (pixels) counting simultaneously at full rate (when contrast is in the order of 1%)?



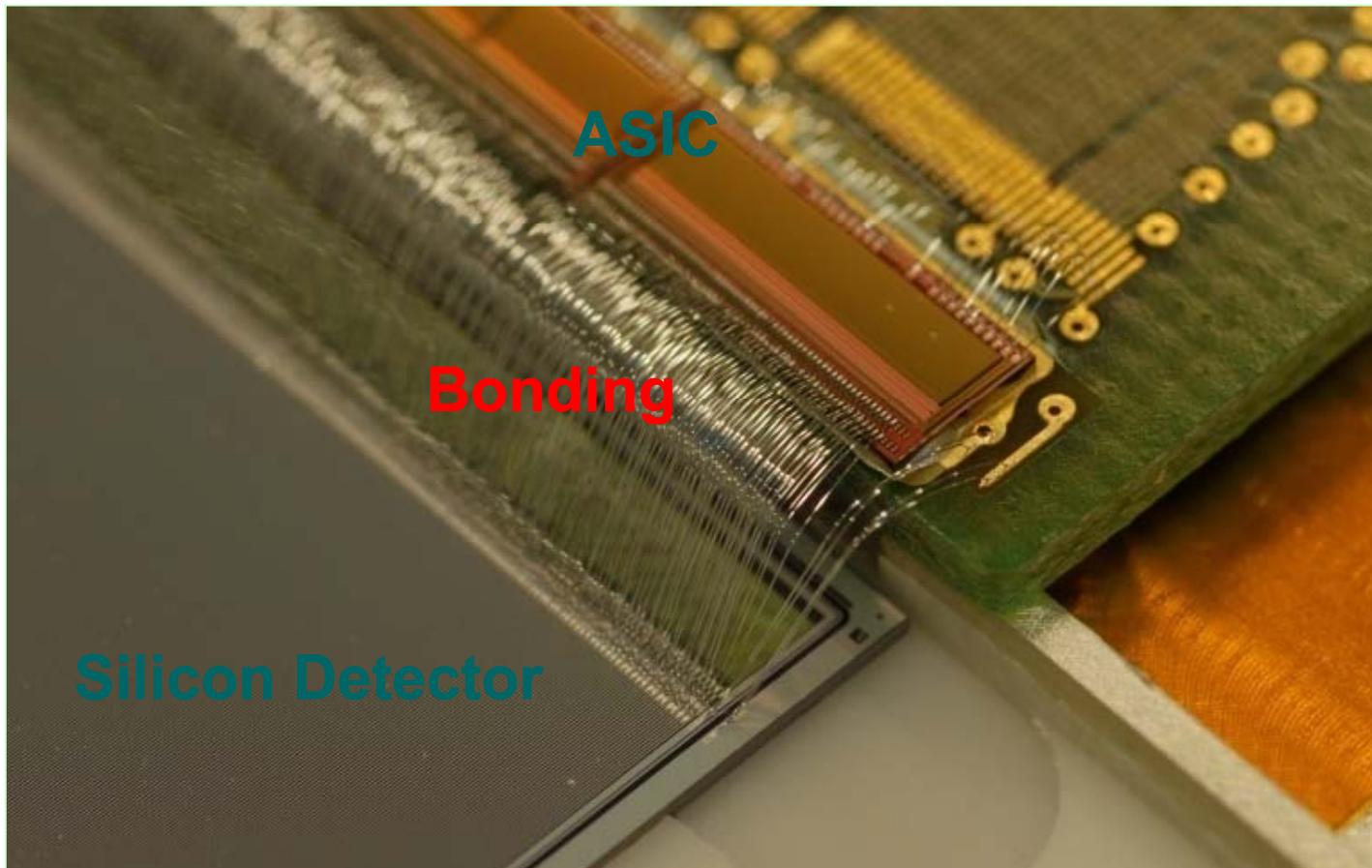
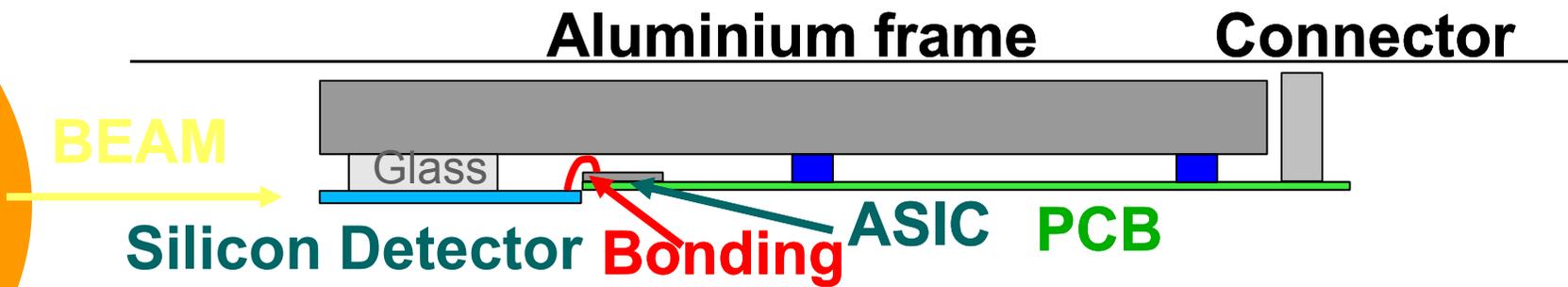
# Photon counting electronics

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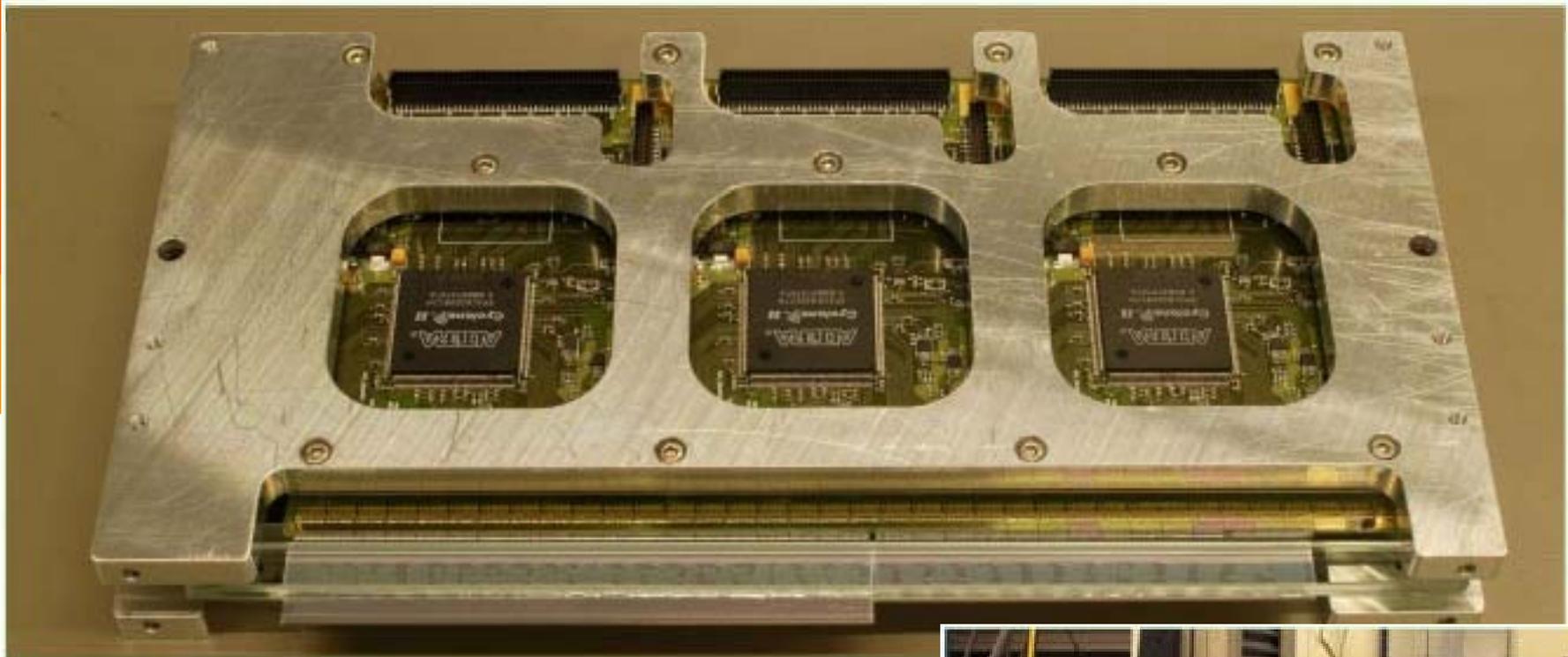
- Mythen-II ASIC developed by the SLS detector group of the Paul Scherrer Institute (PSI, Swiss) for photon counting ASIC for powder diffraction studies
- Features:
  - 0.25  $\mu\text{m}$  UMC technology
  - 128 channels, 50 micron pitch
  - 24 bit counter
  - 50  $\mu\text{m}$  pitch
  - low noise preamplifier (noise about 230 e-)
  - 6-bit threshold trim DAC for each channel
  - Count rate: 1 MHz per channel
- Collaboration between INFN and PSI to apply the Mythen modules to SR imaging



# Single layer design

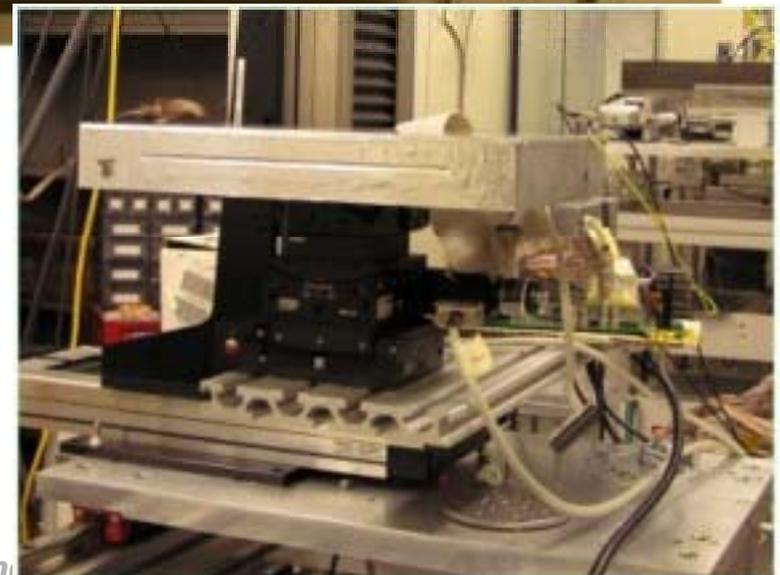


# Double layer prototype



Double layer silicon detector prototype:

- Active area 210mm x 0.3 mm each layer





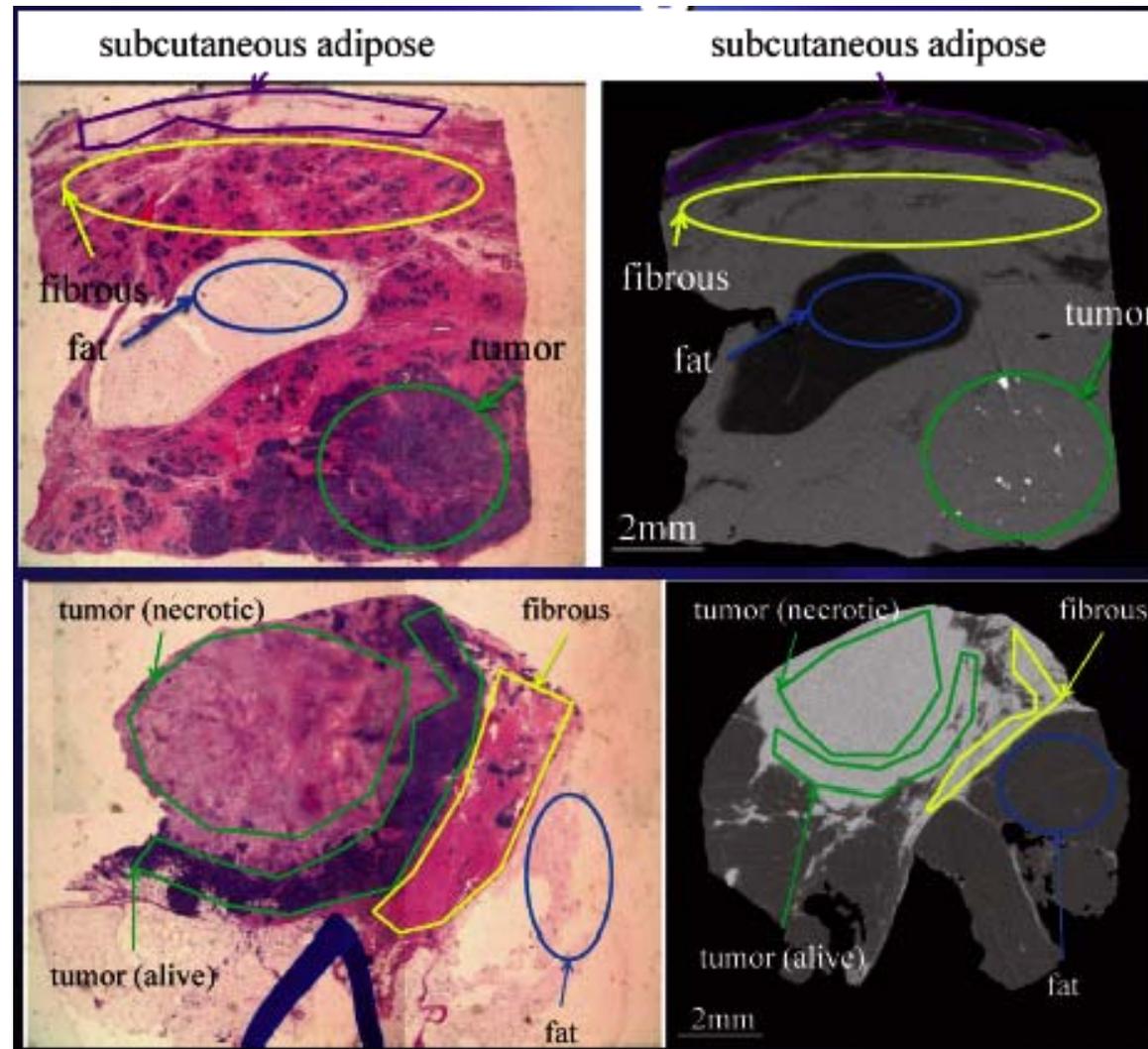
## Quantitative tomography

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- PICASSO detector was used
- The voxel values measured from the CT images were calibrated against the theoretical linear attenuation coefficients of 3 reference samples.
- The breast samples were histologically cut and evaluated
- Linear attenuation coefficients of different breast tissue components were measured from the tomographic slices.

# Histology and Tomography selected images

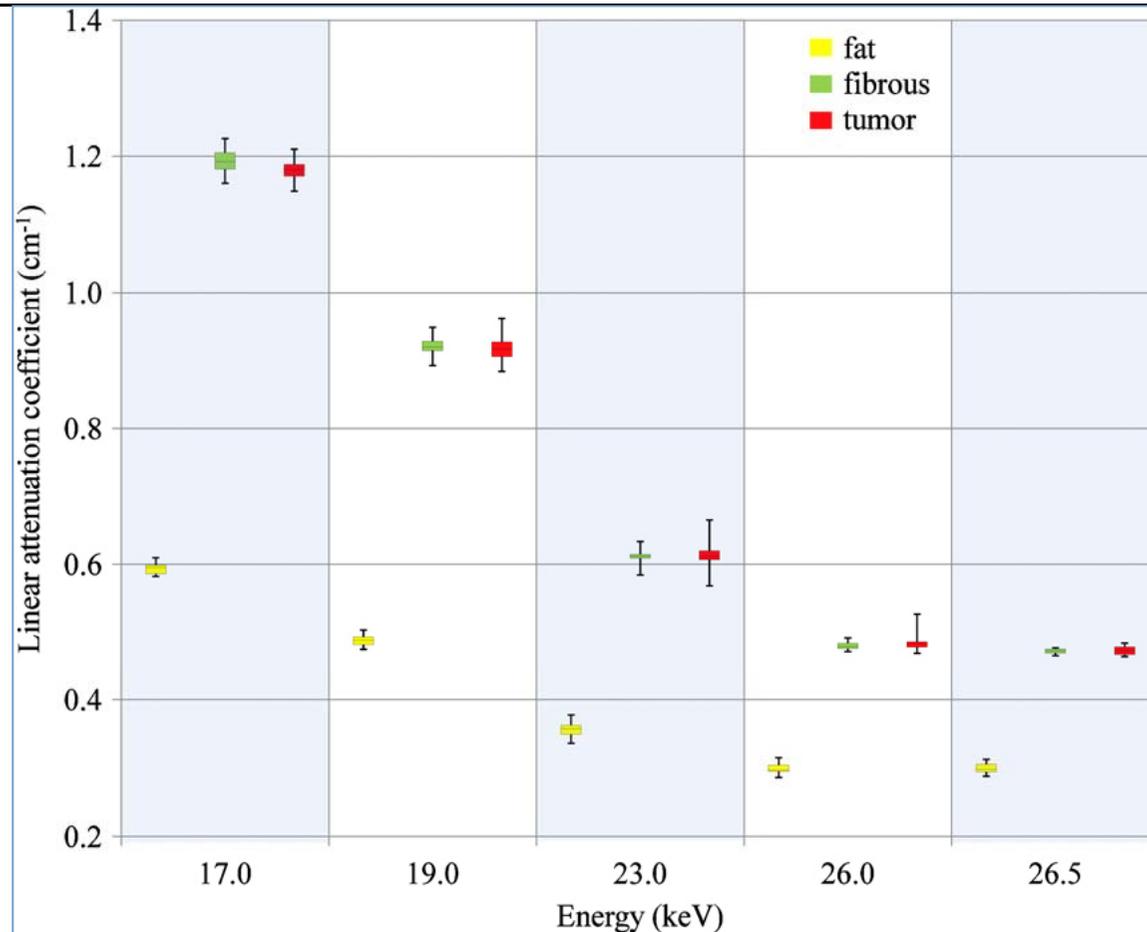
○ 23 keV



○ 26 keV

*By courtesy of Renata Longo*

# Linear attenuation coefficient



- ✓ **No significant differences between fibrous tissue and tumor**
  - **Chen R.C., Longo R, Rigon L et al. Phys Med Biol 2010 55, 4993**

# *A violin tomographic study*

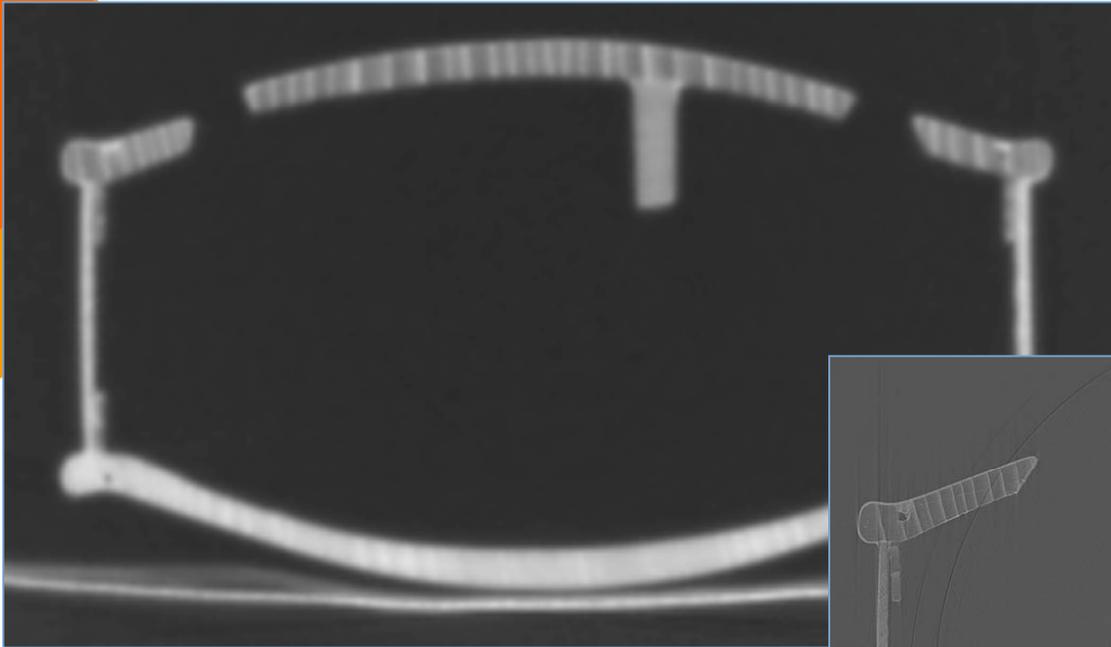


The main limitation in the use of synchrotron radiation is related to the reduced dimensions of the samples under investigation.

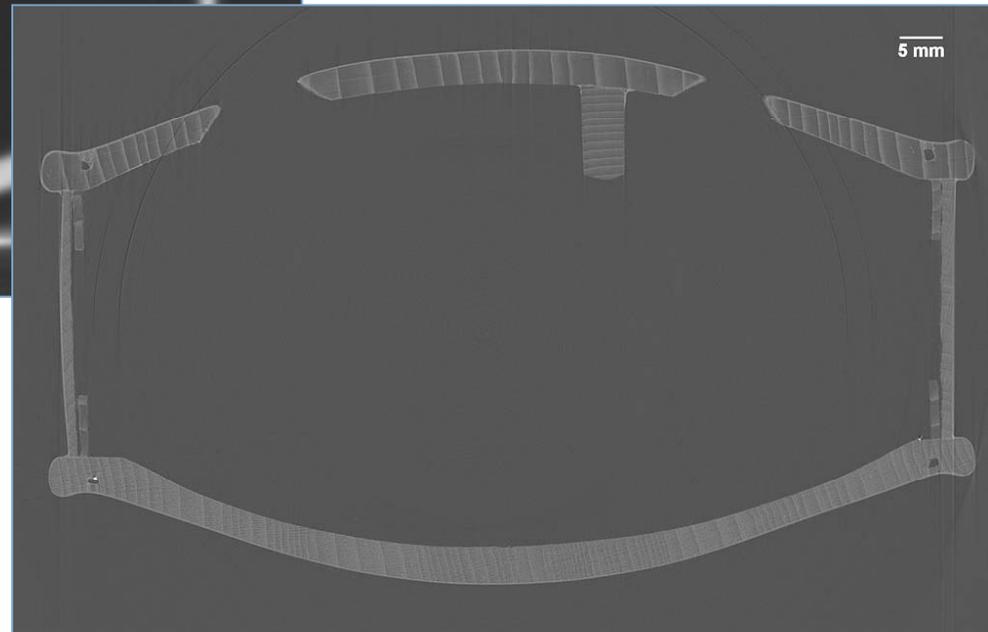
The development of new X-ray detectors designed for the particular characteristics allows the researchers to overcome this kind of problems.



# *A violin tomographic study*

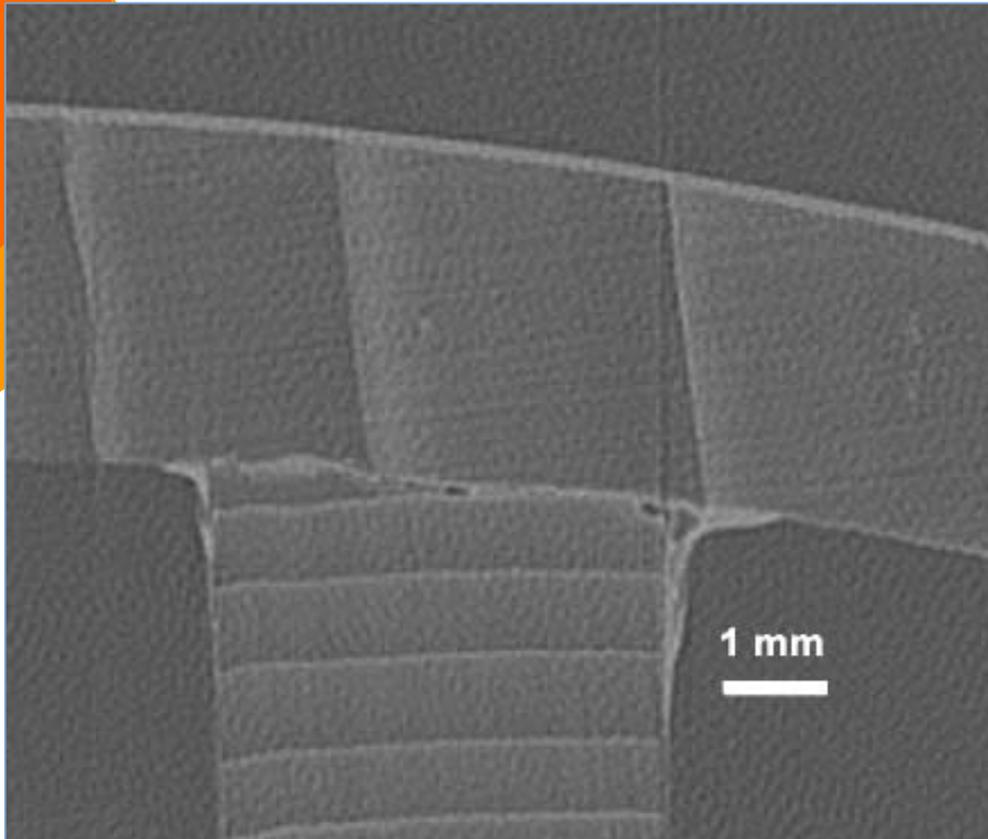


**CT image acquired using a state-of-the-art clinical instrument**

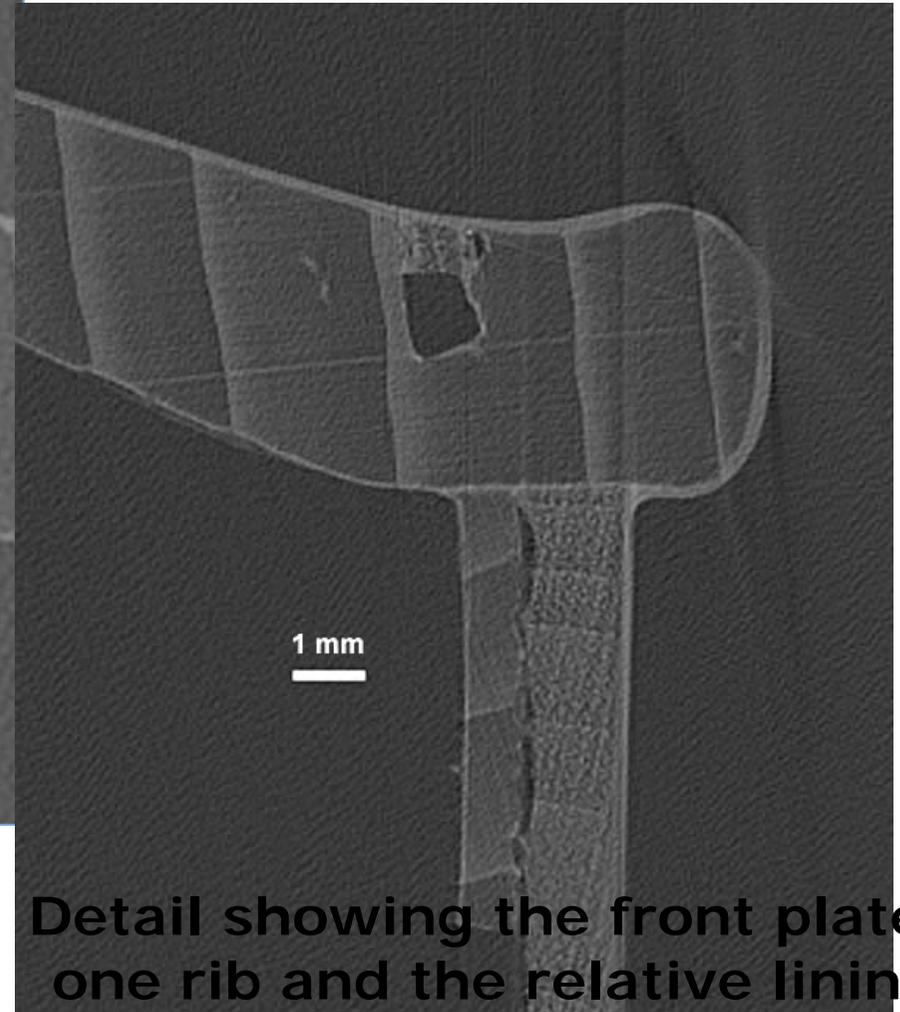


**$\mu$ CT acquired at SYRMEP  
(E = 23 keV)**

# *A violin tomographic study*



**Detail showing the bass bar and the glue used to attach it to the front plate.**



**Detail showing the front plate, one rib and the relative lining.**